

REV	DESCRIPTION	DATE	APPROVED
A	INITIAL RELEASE	03/31/2017	JAC
B	BETA	06/06/2017	JAC
B1	BETA	06/13/2017	JAC
C	PRODUCTION	09/08/2017	JAC

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TEXAS INSTRUMENTS INCORPORATED		
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: TITLE PAGE		
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REVISION STATUS OF SHEETS										
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REV	C	B1	C	C	C	C	C	C	C	C
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DATE	BY	DESCRIPTION
03/16/2017	J.A.C.	DWN
03/16/2017	T.W.K.	CHR
03/16/2017	J.A.C.	ENGR
03/16/2017	J.A.C.	ENGR-MGR
03/16/2017	C.M.D.	DR
03/16/2017	J.A.C.	MFG
03/16/2017	J.A.C.	RLSE

APPLICATION	USED ON
J.A.C.	03/16/2017

Board/Function	Device	Device Function	VAYUH	J6Plus-A	J6Plus-B	7b	8b
1 CPU	U8	DS90UB921-Q1	NA	i2c1	i2c3	0x0C	0x18
2 CPU	U115	DS90UB949	NA	i2c1	i2c3	0x1A	0x26
3 CPU	U38	O917A14	i2c1	i2c1	i2c1	0x12	0x24
4 CPU	U50	AIC3106	i2c1	i2c1	i2c1	0x19	0x32
5 CPU	U30	PCF8575	i2c1	i2c1	i2c1	0x20	0x40
6 CPU	U21	PCF8575	i2c1	i2c1	i2c1	0x21	0x42
7 CPU	U110	PCF8575	i2c2	i2c1	i2c1	0x26	0x4C
8 CPU	U53	TMP102	i2c1	i2c1	i2c1	0x48	0x90
9 CPU	U139	24WC256	i2c1	i2c1	i2c1	0x50	0xa0
10 CPU	U38	O917A14 - Power	i2c1	i2c1	i2c1	0x58	0xB0
11 CPU	U38	O917A14 - Interfaces	i2c1	i2c1	i2c1	0x59	0xB2
12 CPU	U38	O917A14 - Trimming	i2c1	i2c1	i2c1	0x5A	0xB4
13 CPU	U38	O917A14 - OTP	i2c1	i2c1	i2c1	0x5B	0xB6
14 CPU	U40	LP87565	NA	i2c1	i2c1	0x60	0xC0
15 CPU	U110	CDCE813-Q1	NA	i2c1	i2c1	0x65	0xCA
16 CPU	P5	MLB	i2c1	i2c1	i2c1		
17 CPU	P9	COMQ	i2c1	i2c1	i2c1		
18 CPU	P7	HDMI	i2c2	i2c2	i2c2	0x50	0xa0
19 CPU	J8	IMAGER	i2c2	i2c3	i2c5	0x10	0x20
20 CPU	J8	IMAGER	i2c2	i2c3	i2c5	0x37	0x6E
21							
22 1080P LCD		EEPROM	i2c1	i2c1	i2c3	0x57	0xAE
23 1080P LCD		PCF8575	i2c1	i2c1	i2c3	0x27	0x4E
24 1080P LCD		TC358778	i2c1	i2c1	i2c3	0x0E	0x1C
25 1080P LCD		TOUCH	i2c1	i2c1	i2c3	0x38	0x70
26 1080P LCD		TLC59108IPW	i2c1	i2c1	i2c3	0x40	0x80
27							
28 HDMI LCD		TFP410(EP)	NA		i2c3	0x38	0x70
29 HDMI LCD		PCF8575	NA		i2c3	0x27	0x4E
30 HDMI LCD		EEPROM	NA		i2c3	0x57	0xAE
31 HDMI LCD		EEDID	NA		i2c3	0x50	0xa0
32							
33 VISION	APTINA		i2c2	i2c3	i2c5	0x10	0x20
34 VISION	FBD-LINK	GPIO Expander 3	i2c2	i2c3	i2c5	0x25	0x4A
35 VISION	FBD-LINK	GPIO Expander 2	i2c2	i2c3	i2c5	0x21	0x42
36 VISION	FBD-LINK	GPIO Expander 1	i2c2	i2c3	i2c5	0x27	0x4E
37 VISION	FBD-LINK	INFO EEPROM	i2c2	i2c3	i2c5	0x50	0xA0
38 VISION	FBD-LINK	De-Serializer 1	i2c2	i2c3	i2c5	0x60	0xC0
39 VISION	FBD-LINK	De-Serializer 5	i2c2	i2c3	i2c5	0x61	0xC2
40 VISION	FBD-LINK	De-Serializer 2	i2c2	i2c3	i2c5	0x64	0xC8
41 VISION	FBD-LINK	De-Serializer 3	i2c2	i2c3	i2c5	0x68	0xD0
42 VISION	FBD-LINK	De-Serializer 6	i2c2	i2c3	i2c5	0x69	0xD2
43 VISION	FBD-LINK	De-Serializer 4	i2c2	i2c3	i2c5	0x6C	0xD8
44 VISION	LI IMAGER		i2c2	i2c3	i2c5	0x10	0x20
45 VISION	OV IMAGER		i2c2	i2c3	i2c5	0x30	0x60
46 HDMI	ADV7611	BASE	i2c2	i2c3	i2c5	0x4C	0x98
47 HDMI	ADV7611	CEC	i2c2	i2c3	i2c5	0x40	0x80
48 HDMI	ADV7611	INFOFRAME	i2c2	i2c3	i2c5	0x3E	0x7C
49 HDMI	ADV7611	DPPL	i2c2	i2c3	i2c5	0x55	0xAA
50 HDMI	ADV7611	KSV	i2c2	i2c3	i2c5	0x56	0xAB
51 HDMI	ADV7611	EDID	i2c2	i2c3	i2c5	0x57	0xAC
52 HDMI	ADV7611	HDMI	i2c2	i2c3	i2c5	0x34	0x68
53 HDMI	ADV7611	CP	i2c2	i2c3	i2c5	0x22	0x44
54							
55 JAMR3	u21	24c256	i2c1	i2c1	i2c1	0x51	0xA2
56 JAMR3	U26	AIC3106	i2c2	i2c3	i2c5	0x18	0x30
57 JAMR3	U25	AIC3106	i2c2	i2c3	i2c5	0x19	0x32
58 JAMR3	U24	AIC3106	i2c2	i2c3	i2c5	0x1A	0x34
59 JAMR3	U5	DS90UH926Q	i2c2	i2c3	i2c5	0x2C	0x58
60 JAMR3	U10	TVP5158	i2c2	i2c3	i2c5	0x58	0xB0
61 JAMR3	J15		i2c3	i2c3	i2c3	???	
62 JAMR3	P5	APPLE AUTH	i2c3	i2c3	i2c3	0x10	0x20
63 JAMR3	P2		i2c3	i2c3	i2c3	???	
64 JAMR3	J17		i2c3	i2c3	i2c3	???	
65 JAMR3	U14	PCF8578	i2c4	i2c4	i2c4	0x22	0x44
66 JAMR3	U9	AFE8310	i2c4	i2c4	i2c4	0x48	0x90
67 JAMR3	U8	AFE8310	i2c4	i2c4	i2c4	0x49	0x92
68 JAMR3	U7	AFE8310	i2c4	i2c4	i2c4	0x4A	0x94
69 JAMR3	U6	AFE8310	i2c4	i2c4	i2c4	0x4B	0x96
70							
71							
72 AUO FPD		Display DS90UB924-Q1	NA	i2c1	i2c3	0x2C	
73 AUO FPD		Display PCF8575	NA	i2c1	i2c3	Alias-tbd	
74 AUO FPD		Display TLC59108IPW	NA	i2c1	i2c3	Alias-tbd	
75 AUO FPD		Display TLC59108IPW ALL CALL	NA	i2c1	i2c3	Alias-tbd	
76 AUO FPD		Display EEPROM	NA	i2c1	i2c3	Alias-tbd	
77 AUO FPD		Display Touch Controller	NA	i2c1	i2c3	Alias-tbd	
78 AUO FPD		RF430CL330H	NA	i2c1	i2c3	Alias-tbd	
79							
80							
81 ADAS FUSION		DS90UB960TRGCRQ1-U1	NA	i2c3	i2c5	0x30	0x60
82 ADAS FUSION		DS90UB960TRGCRQ1-U2	NA	i2c3	i2c5	0x3D	0x7A
83 ADAS FUSION		Alias IDs Camera/Radar???	NA	i2c3	i2c5		
84 ADAS FUSION		ID EEPROM	NA	i2c3	i2c5	0x50	0xA0
85							

								Sense R
86								
87 INA226-PM1	U86	VDD_MPU_AVS	NA	i2c2	i2c2	0x40	0x80	R249
88 INA226-PM1	U85	VDD_GPU_AVS	NA	i2c2	i2c2	0x41	0x82	R191
89 INA226-PM1	U84	VDD_DSPEVE_AVS	NA	i2c2	i2c2	0x42	0x84	R208
90 INA226-PM1	U83	VDD_CORE_AVS	NA	i2c2	i2c2	0x43	0x86	R189
91 INA226-PM1	U82	VDD_IVA_AVS	NA	i2c2	i2c2	0x44	0x88	R179
92 INA226-PM1	U81	VDDSHV_3V3	NA	i2c2	i2c2	0x45	0x8A	R514
93 INA226-PM1	U80	VDDR_MEM_1V35	NA	i2c2	i2c2	0x46	0x8C	R703
94 INA226-PM1	U79	VDDR_SOC_1V35	NA	i2c2	i2c2	0x47	0x8E	R642
95 INA226-PM1	U71	VIO_1V8	NA	i2c2	i2c2	0x48	0x90	R220
96 INA226-PM1	U70	VDDS_1V8	NA	i2c2	i2c2	0x49	0x92	R219
97 INA226-PM1	U69	VDD_SDIO_DV	NA	i2c2	i2c2	0x4A	0x94	R196
98 INA226-PM1	U68	VDDA_USB_3V3	NA	i2c2	i2c2	0x4B	0x96	R192
99 INA226-PM1	U67	VDDA_PLL_1V8	NA	i2c2	i2c2	0x4C	0x98	R204
100 INA226-PM1	U65	VDDA_PHY2_1V8	NA	i2c2	i2c2	0x4D	0x9A	R182
101 INA226-PM1	U66	VDDA_PHY1_1V8	NA	i2c2	i2c2	0x4E	0x9C	R183
102								
103 INA226-PM2	U90	VSYS_12V0	NA	i2c2	i2c2	0x40	0x80	R32
104 INA226-PM2	U89	VSYS_5V0	NA	i2c2	i2c2	0x41	0x82	R162
105 INA226-PM2	U88	VSYS_3V3	NA	i2c2	i2c2	0x42	0x84	R160
106 INA226-PM2	U87	VIO_3V3	NA	i2c2	i2c2	0x43	0x86	R513
107 INA226-PM2	U78	VPIN_B01_3V3	NA	i2c2	i2c2	0x44	0x88	R225
108 INA226-PM2	U77	VPIN_B23_3V3	NA	i2c2	i2c2	0x45	0x8A	R205
109 INA226-PM2	U76	VPIN_S12_3V3	NA	i2c2	i2c2	0x46	0x8C	R549
110 INA226-PM2	U75	VPIN_S3_3V3	NA	i2c2	i2c2	0x47	0x8E	R548
111 INA226-PM2	U74	VPIN_S4_3V3	NA	i2c2	i2c2	0x48	0x90	R533
112 INA226-PM2	U73	VPIN_S5_3V3	NA	i2c2	i2c2	0x49	0x92	R575
113 INA226-PM2	U72	VPIN_LDO_3V3	NA	i2c2	i2c2	0x4A	0x94	R537
114 INA226-PM2	U91	VPIN_LDO_5V0	NA	i2c2	i2c2	0x4B	0x96	R194

SCHEMATIC SIGNAL	GPIO	EXTERNAL	INTERNAL	T-POINT	NOTE
H_NMIN		PU-10K	PD		NU
H_WKUP_0	GPIO1_0	PU-10K	OFF	TP74	LP87xx INT
H_WKUP_1	GPIO1_1	PU-10K	OFF	TP69	PMIC INT
H_GP1[2] TOUCH EVT		PD-10K	OFF	TP73	TOUCH
H_GP1[3]/H_PCF8575_INT		PU-1K	OFF	TP72	EXP
H_ENET_INTSn	GPIO6_16		PU		ENET
H_GP6[17]			PD		EXP
H_GP6[20]			PD		EXP
H_GP6[28]			PD		MLB
H_GP2[27]			PU		EXP
H_GP5[17]			PD		EXP
H_POWERHOLD_CLK	GPIO3_30	PD-1K	PU	TP56	
H_MMC_PWR_ON	GPIO4_21	PU-1K	PD	TP57	
H_GP5[9]			PD		MLB
H_GP5[8]			PD		COM8
H_GP5[7]			PD		COM8
H_GP5[6]			PD		COM8
H_GP5[5]			PD		COM8
H_GP5[4]			PD		COM8
H_GP5[1]			PD		EXP
H_GP5[0]			PD		EXP/AUTOMATION
H_GP2[22]			PU	TP55	NU
CON_LCD_PWR_DN	GPIO3_1	PU-1K	PD		
HDMI_CT_HPD	GPIO7_30	PU-1K	PD		
HDMI_LS_OE	GPIO7_31	PU-1K	PD		

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Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: NOTES

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ECN Number	518450-E002
Date Requested	9/8/2017
Requester	Tony C.
Approvals	Tony C.
Assembly Number	518450-0001R
Current Assembly Rev	B
New Assembly Rev	C
Implementation notes	

Item#	Init Date	Priority	Status	Description
1				ASSY, PWB, LOGIC Re B TO C
2				EEPROM Rev 1.1 to 1.2
DR-2				Sheet 33: Add in 3.3v/1.8V LDO for VDD_SDIO_DV support. ADD Q19 104958-0001R R753 101370-1001R R754 102145-1003R R755 102145-1003R U148 105156-0001R
DR-3				Sheet 22: Change U124 (TXS0108EPW) OE to pull high vs pull low to enable.
DR-4				Update SOC Symbol
ER-5				Sheet 4, 7, 15, 39 add "MCAN" to DCAN1 and DCAN2 signals. No logic changes. Change J20/J21 silkscreen to CAN1, CAN2.
ER-6				Sheet 18,19: Add 4 user GPIO switches with access from I/O expander, SW10 and Automation header. ADD R745 103158-1003R R746 103158-1003R R747 103158-1003R R748 103158-1003R R749 103158-1002R R750 103158-1002R R751 103158-1002R R752 103158-1002R SW10 101184-0004R
DR-7				Sheet 21: RJ3/RJ5 population change to enable I2C access to CDCE813. From 1-2 (101370-4702R, 4.7k) to 2-3 (101370-2200R, 22 ohm)
DR-8				MLB probe points, J4, J5, J6 spacing to match J6 Entry. Change footprint from 2mm to 2.54mm.
ER-9				Sheet 32, 34, 35: Add undervoltage circuit from J6 LCARD for better controlled shutdown. ADD C711 103885-1220R C712 101782-1153R C713 C0402-NOPOP D24 NO-POP Q18 104958-0001R RJ17 101370-0001R R742 102145-2744R R743 102145-1004R R744 102145-1004R U147 NO-POP R756 102145-2003R TP98 TP-30RD13-NO-POP Relabel TP96 PGD_STAGE1_3V3_5V0 Label TP98 PGD_UV_DETECT
ER-10				Update SOC Symbol
DR-11				Evaluate SOC thermal and apply heatsink and fan if needed.
DR-12				Sheet 38: Add automation header note.
DR-13				Sheet 22: Add R-mux between VCC_1V1USB and H_USB2_DRV_VBUS to enable the USB HUB. H_USB2_DRV_VBUS Postion 2-3 default. Add RJ16, 102145-2003R
DR-14				Fusion power connector silkscreen outline and text needs to be corrected so it is not under the connector.
ER-15				Sheet 18: Update the micro SD card footprint to Molex 502774-0891. Current micro SD is giong EOL. No logic change but the footprints are slightly different. P14 From 103053-0001R To 105161-0001R
ER-16				Sheet 32: Add smt gnd TPs near center of the board on top and bottom. Add TP99, TP100 104178-0001R
ER-17				Sheet 33: Update PMIC OTP part# to O917A154TRGZRQ1/ PO917A154TRGZRQ1 U38 From 105046-0001R-TI To105046-0002R-TI 105046-0002R-TI O917A154TRGZRQ1/ PO917A154TRGZRQ1

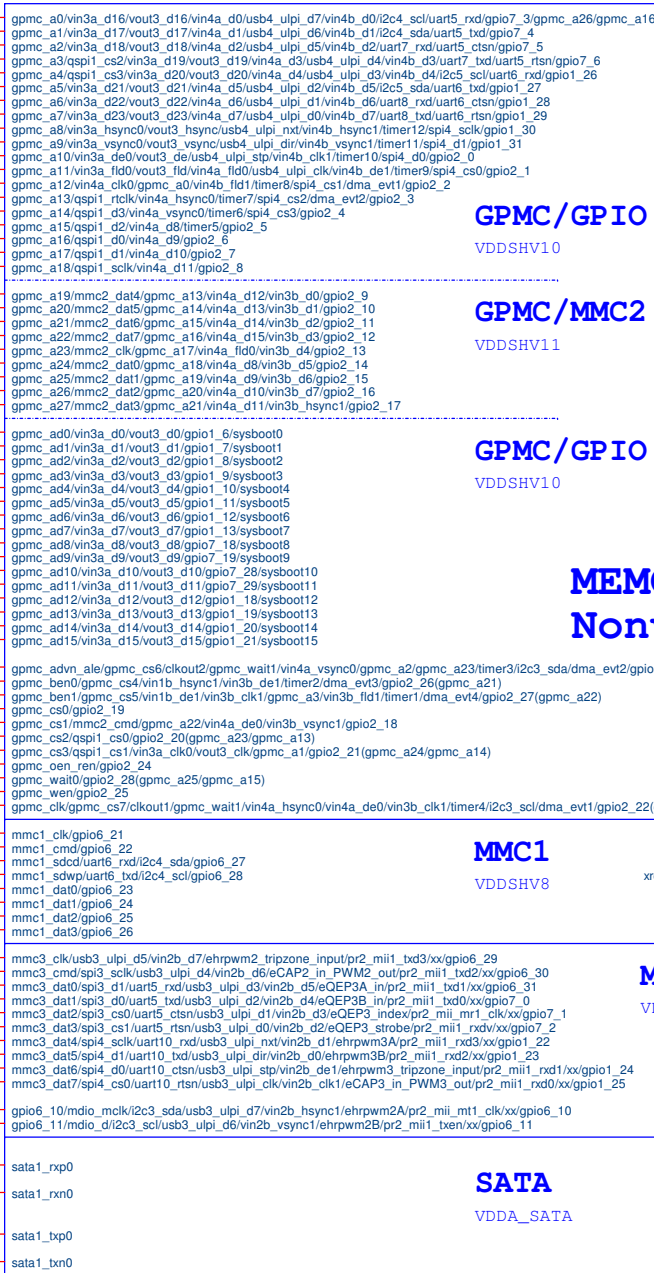
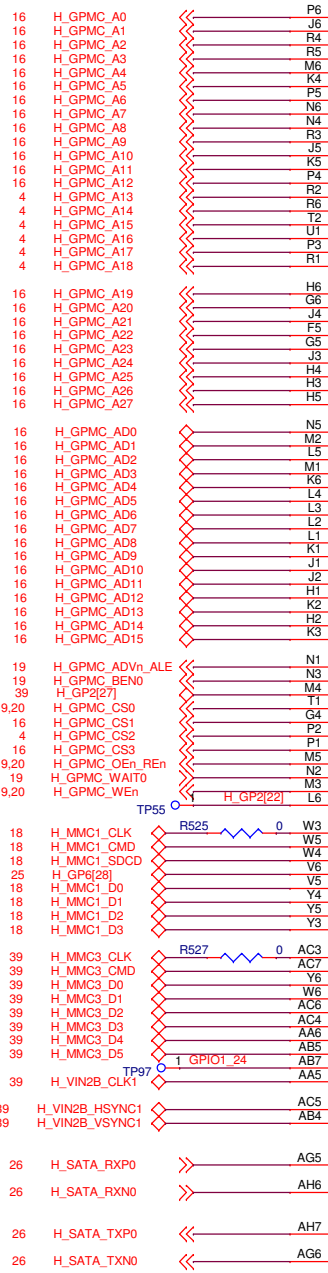
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

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DRA77xP / DRA76xP / TDA2Px

Data Manual: SPRS993A July 2017
 Package: ACD, 23x23mm, 784 PBGA, 0.8mm Pitch
 PCB Footprint: bga784_28x28_0p8mm
 SCH Symbol: IC_J6Plus_ACD_23mm_784BGA_v1.0

CONTROL

SYSTEM

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

MEMORY-Nonvolatile

CONTROL

RTC

GPIO

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS

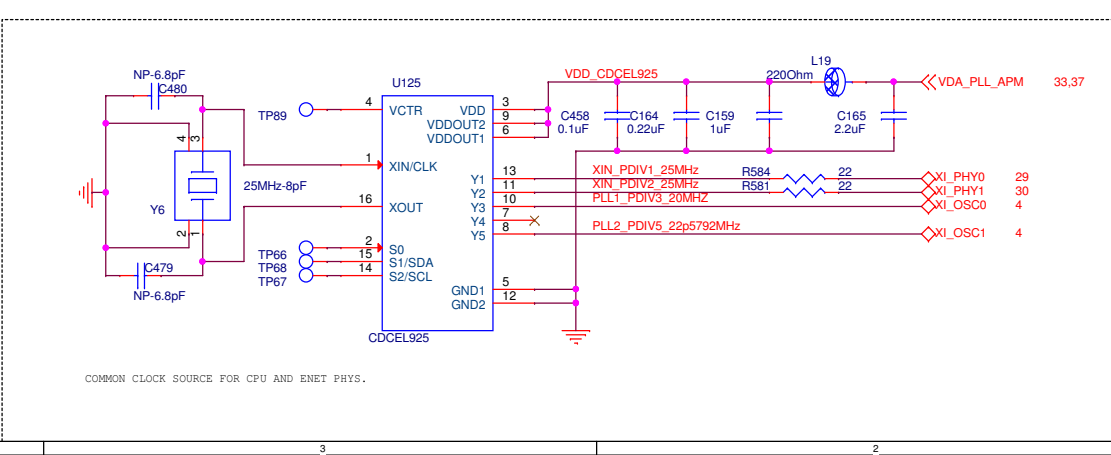
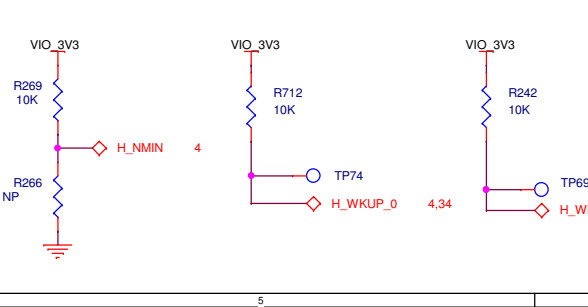
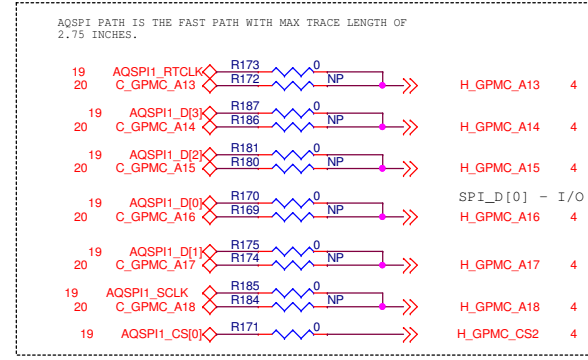
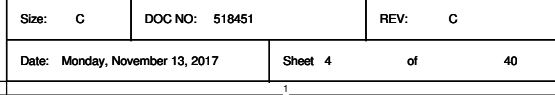
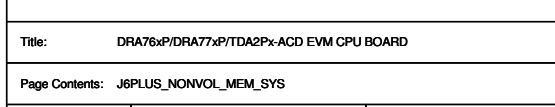
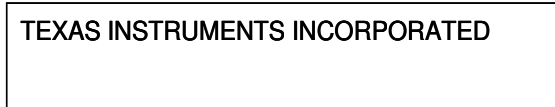
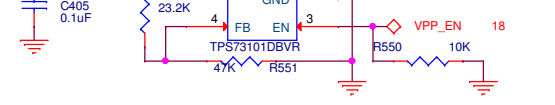
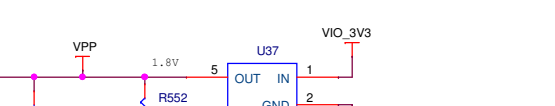
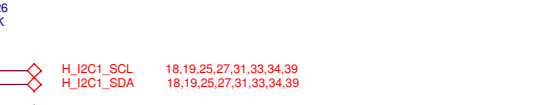
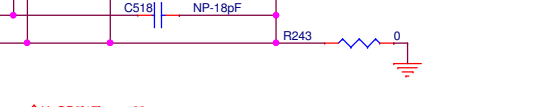
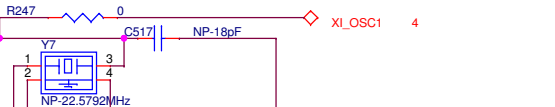
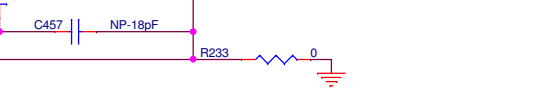
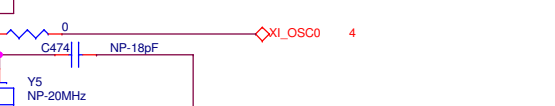
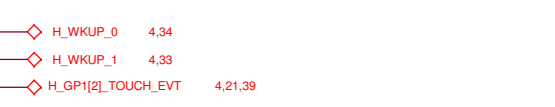
CLOCKS

CLOCKS

CLOCKS

CLOCKS

CLOCKS



TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: J6PLUS_NONVOL_MEM_SYS

Size: C DOC NO: 518451 REV: C

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U42B

DRA77xP / DRA76xP / TDA2Px

Data Manual: SPRS993A_July_2017
Package: ACD, 23x23mm, 784 PBGA, 0.8mm Pitch
PCB Footprint: bga784_28x28_0p8mm
SCH Symbol: IC_J6Plus_ACD_23mm_784BGA_v1.0

VOLATILE MEMORY

EMIF1

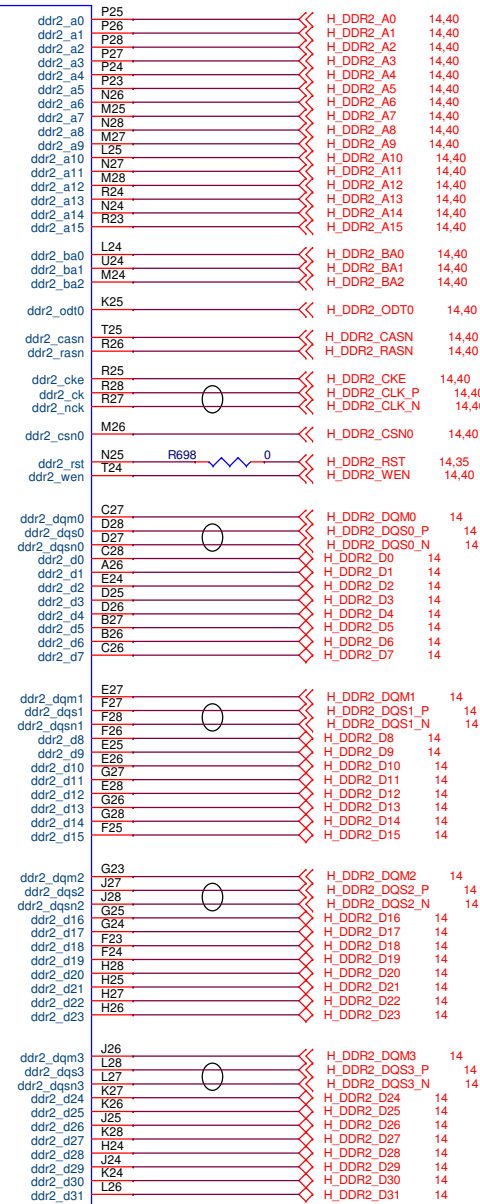
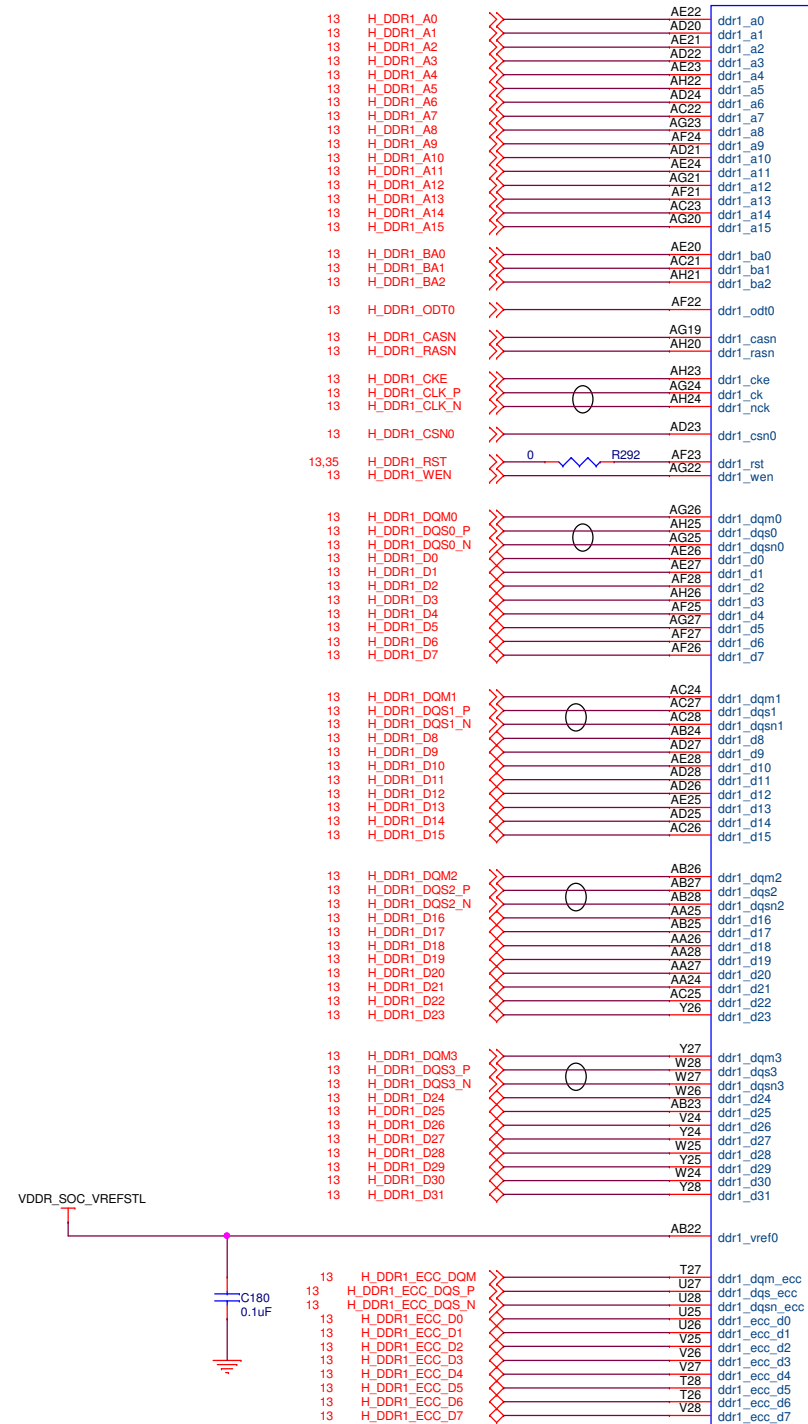
EMIF2

VDDS_DDR1

VDDS_DDR2

ECC

VDDS_DDR1



TEXAS INSTRUMENTS INCORPORATED

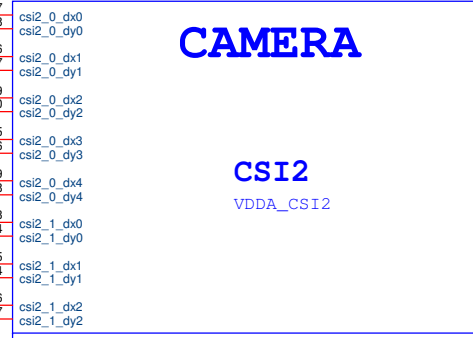
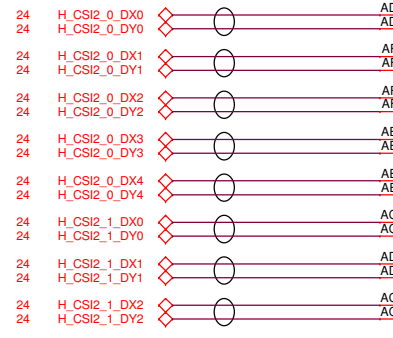
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: J6PLUS_VOL_MEM

Size: C DOC NO: 518451 REV: C

Date: Monday, November 13, 2017 Sheet 5 of 40

DIFF-PAIR-100-OHM



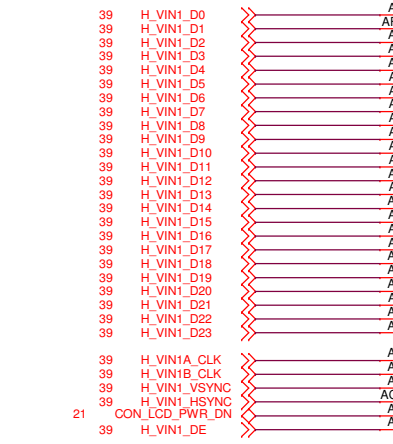
CAMERA

DRA77xP / DRA76xP / TDA2Px
Data Manual: SPRS993A_July_2017
Package: ACD, 23x23mm, 784 PBGA, 0.8mm Pitch
PCB Footprint: bga784_28x28_0p8mm
SCH Symbol: IC_J6Plus_ACD_23mm_784BGA_v1.0

CSI2

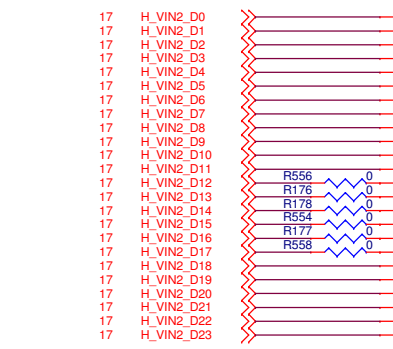
VDDA_CSI2

VIDEO INPUT



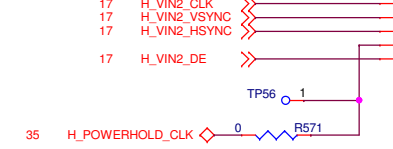
VIP1

VDDSHV6



VIP2

VDDSHV1

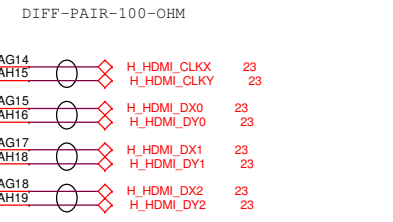


U42F

DISPLAY

HDMI

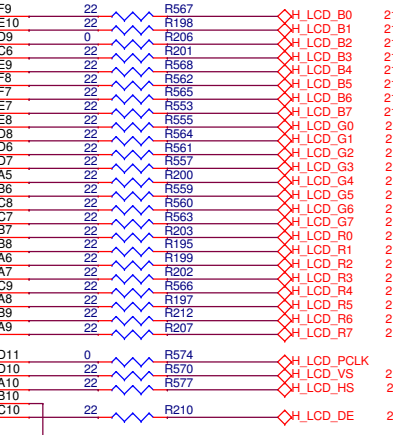
VDDA_HDMI



VIDEO OUTPUT



22 OHM OK FOR LCD AS IT IS NOT GOING THROUGH MUXES, EXCEPT FOR THE CLOCK PINS
LCD_B2 = EMU2 TRACE CLOCK



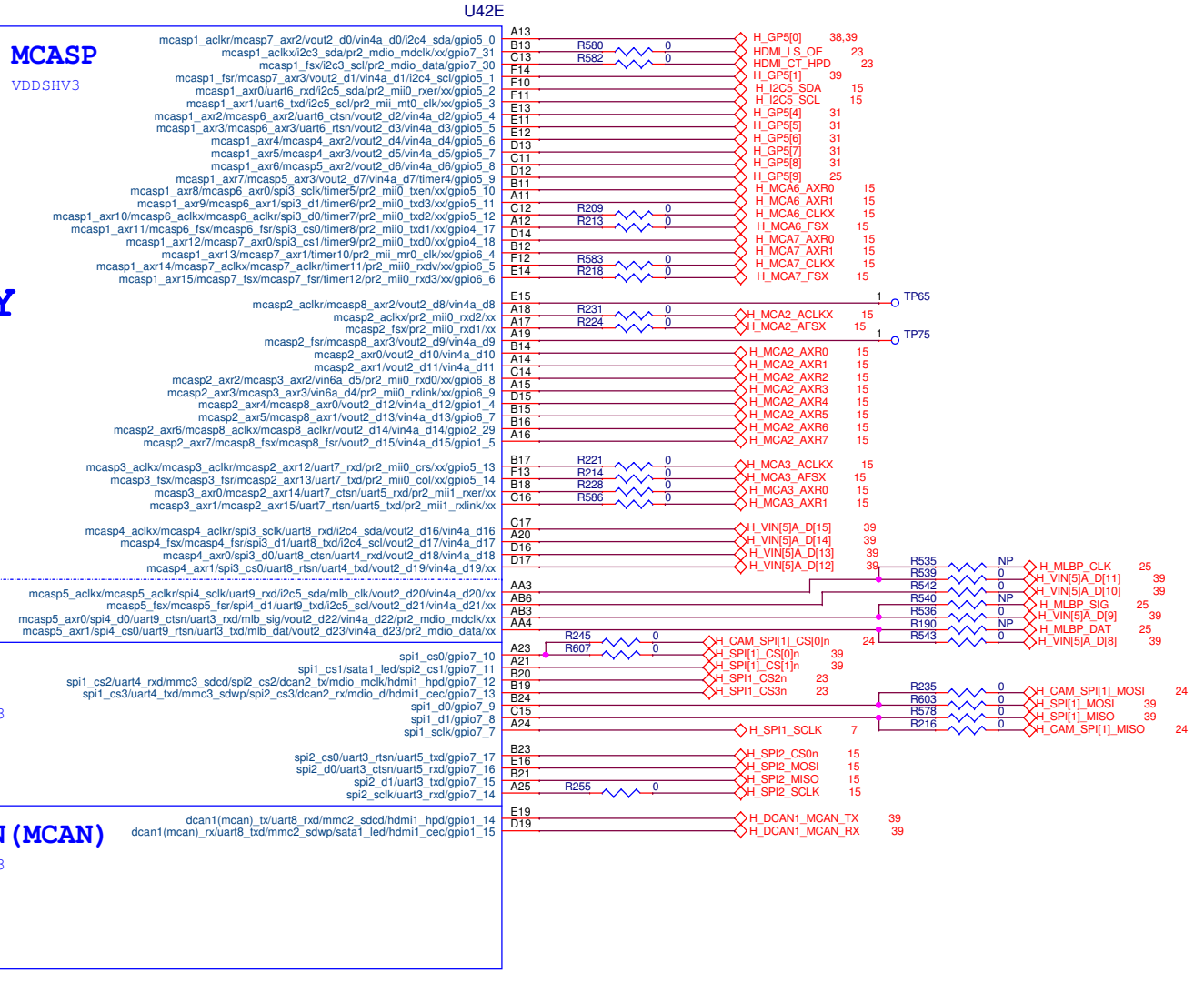
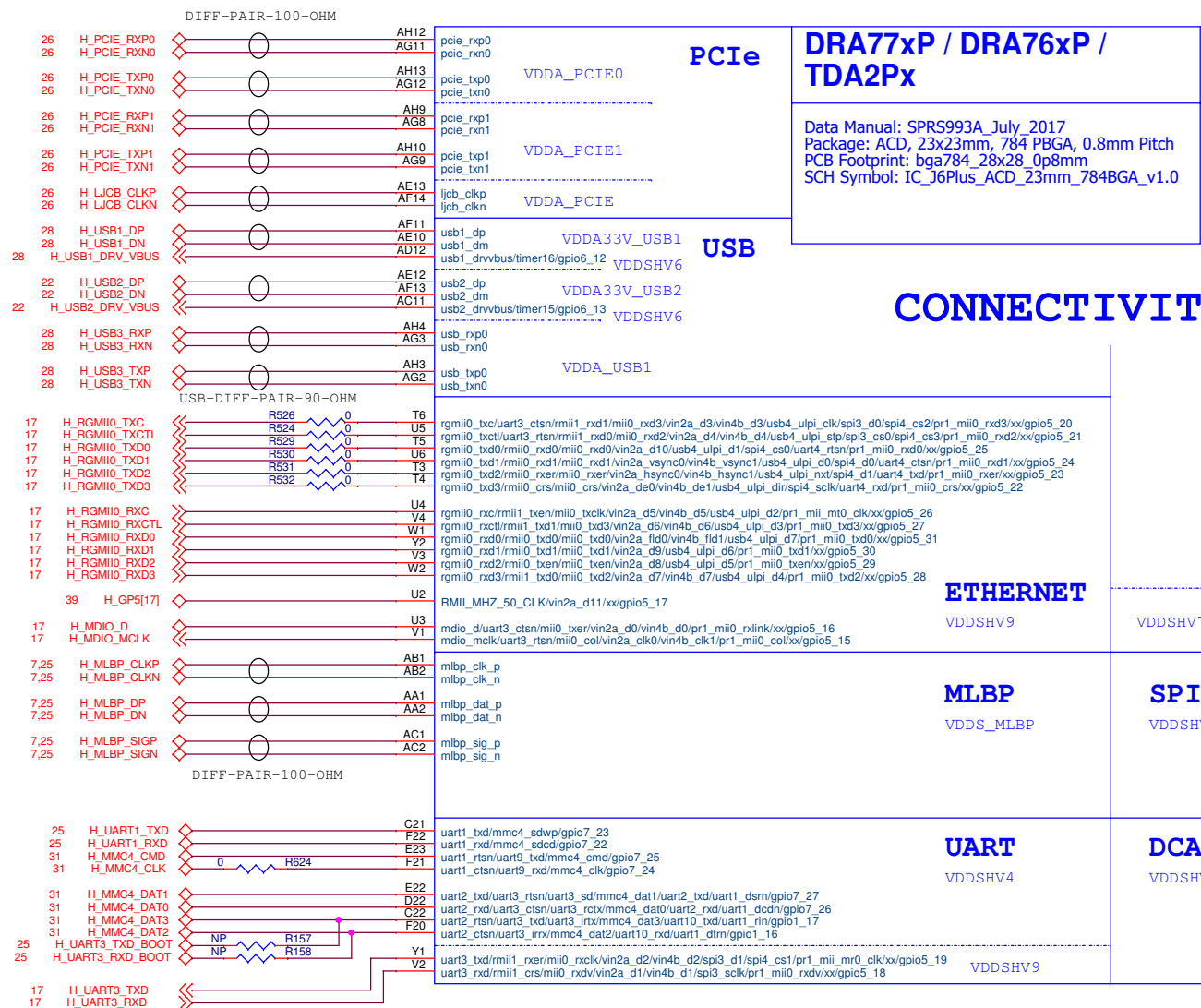
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

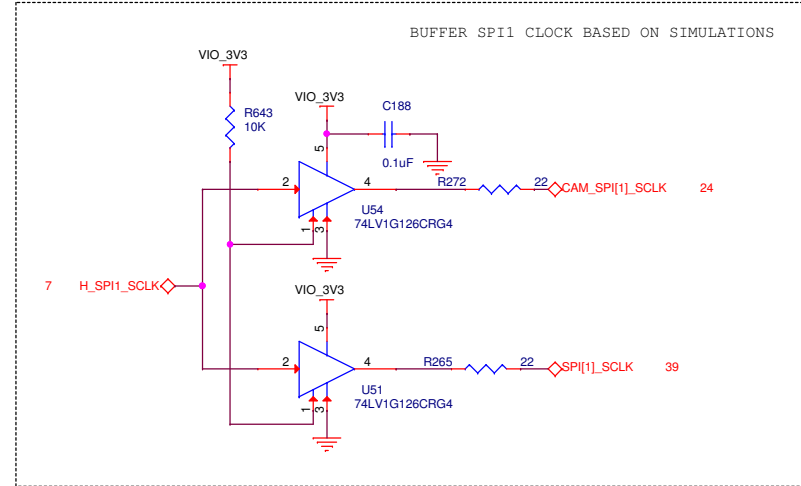
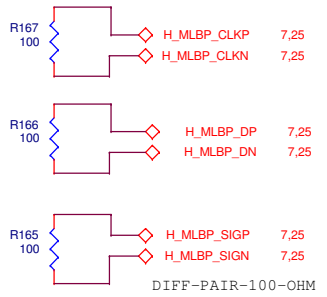
Page Contents: J6PLUS_CAM_DISPLAY_VIDEO

Size: C DOC NO: 518451 REV: C

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PLACE 100 OHM RESISTORS AT CPU

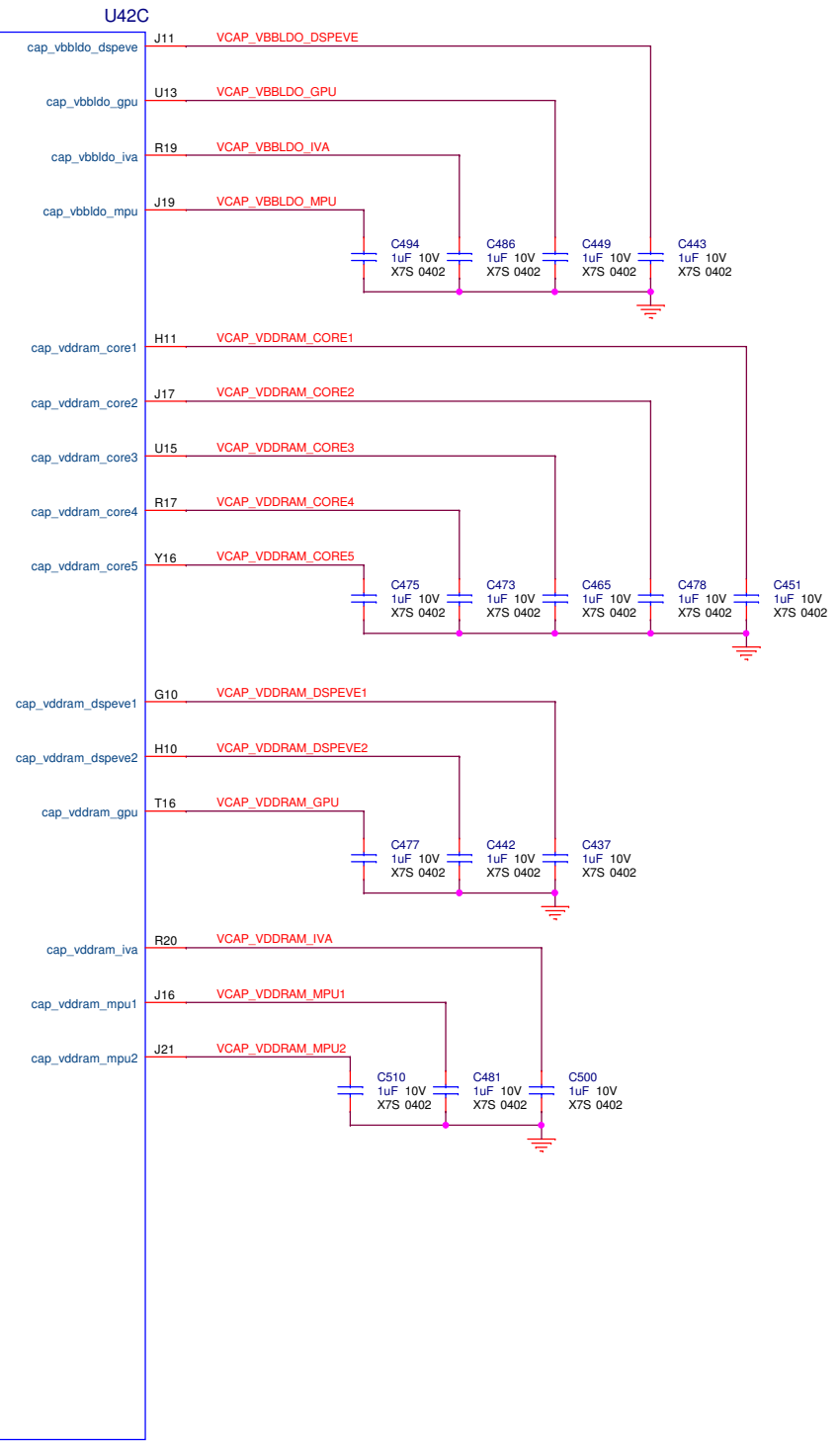
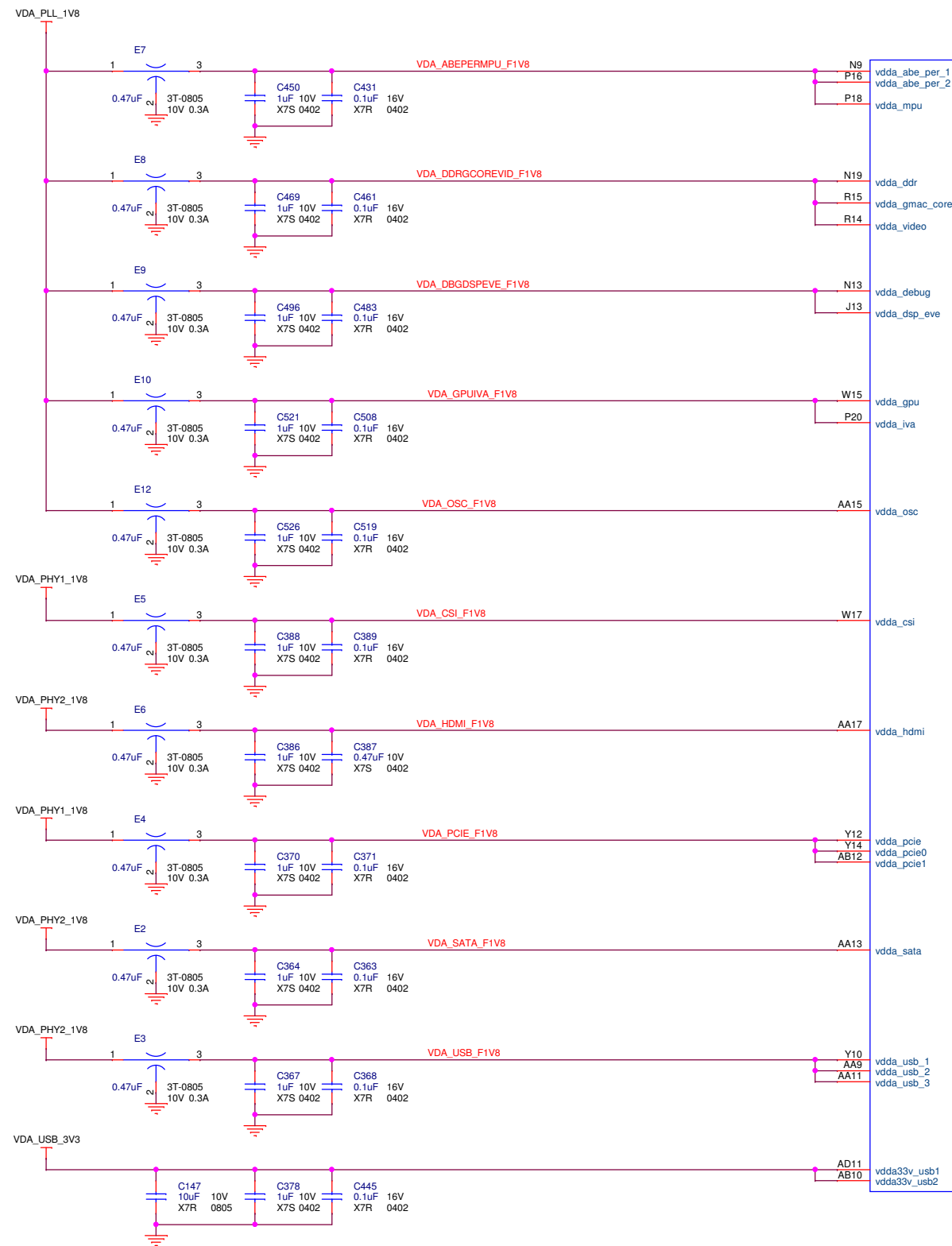


TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: J6PLUS_CONVNITY			
Size: C	DOC NO: 518451	REV: C	
Date: Monday, November 13, 2017	Sheet 7	of	40

DRA77xP / DRA76xP / TDA2Px

Data Manual: SPRS993A_July_2017
Package: ACD, 23x23mm, 784 PBGA, 0.8mm Pitch
PCB Footprint: bga784_28x28_0p8mm
SCH Symbol: IC_J6Plus_ACD_23mm_784BGA_v1.0

POWER ANALOG SUPPLIES INTERNAL LDOS



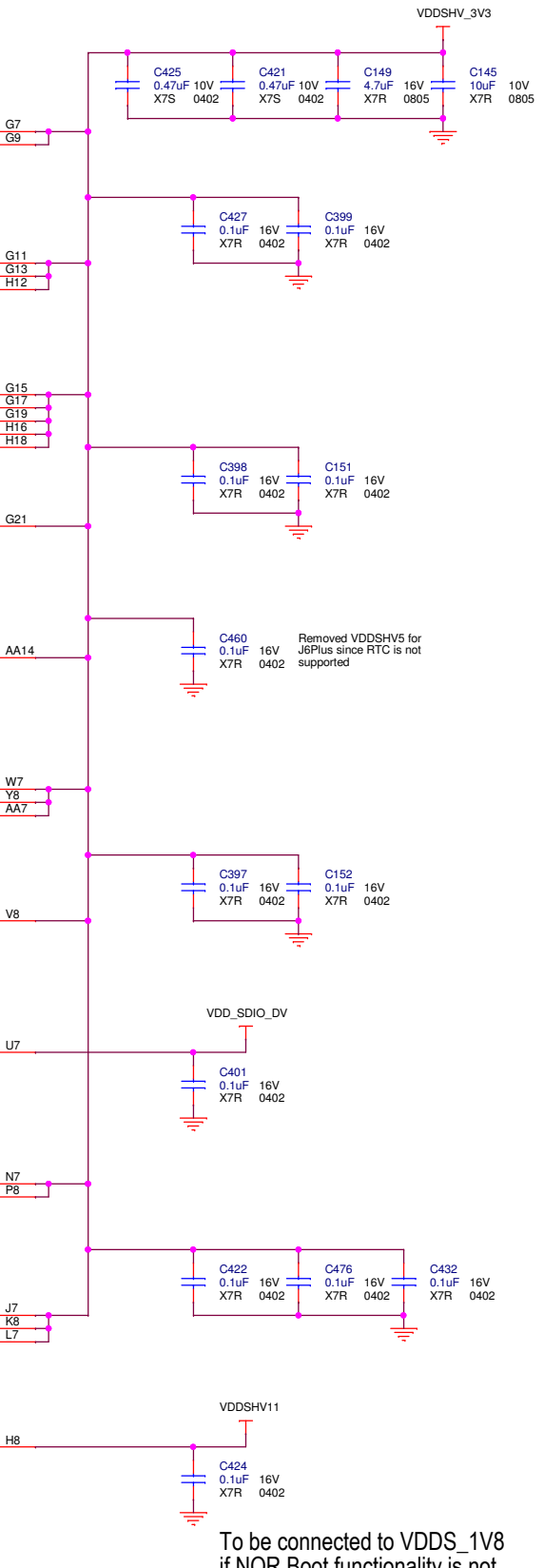
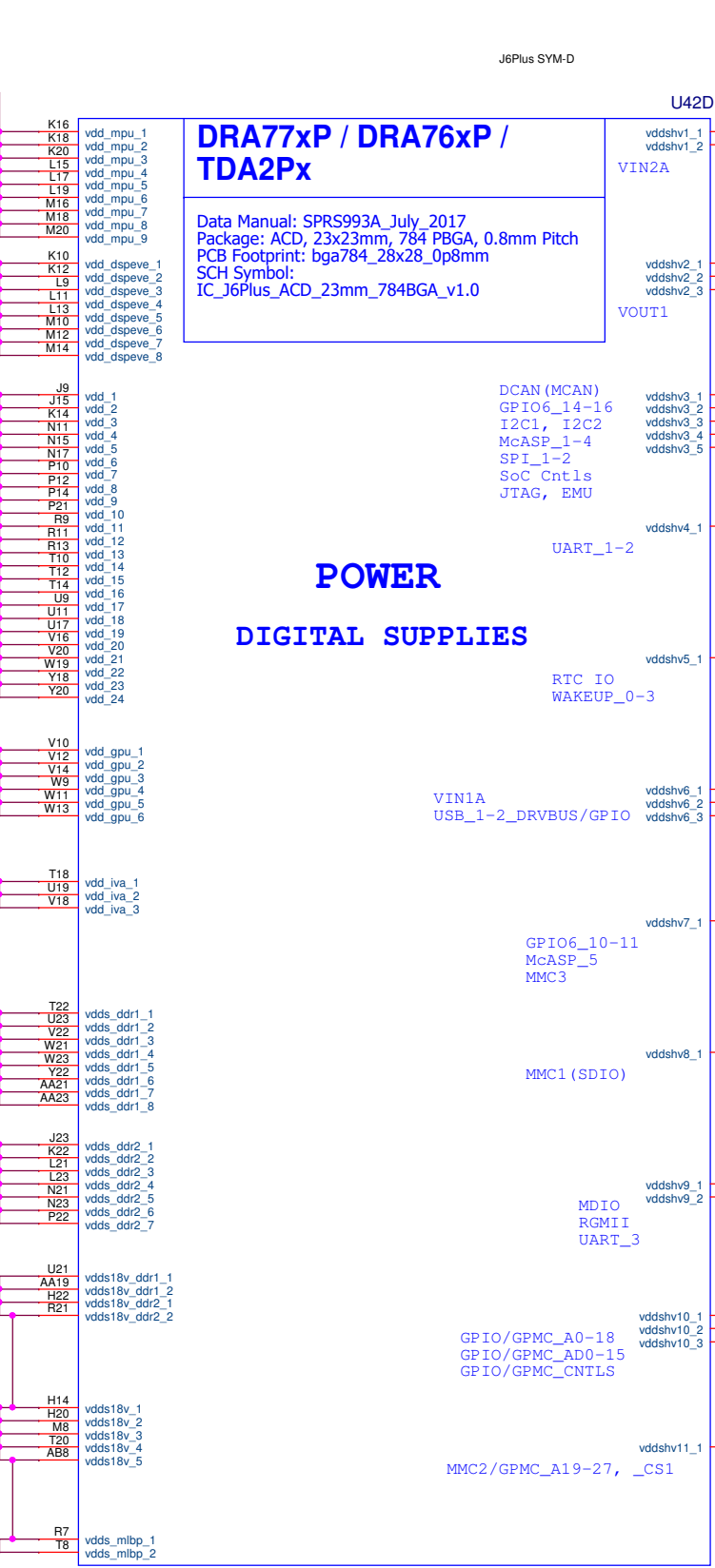
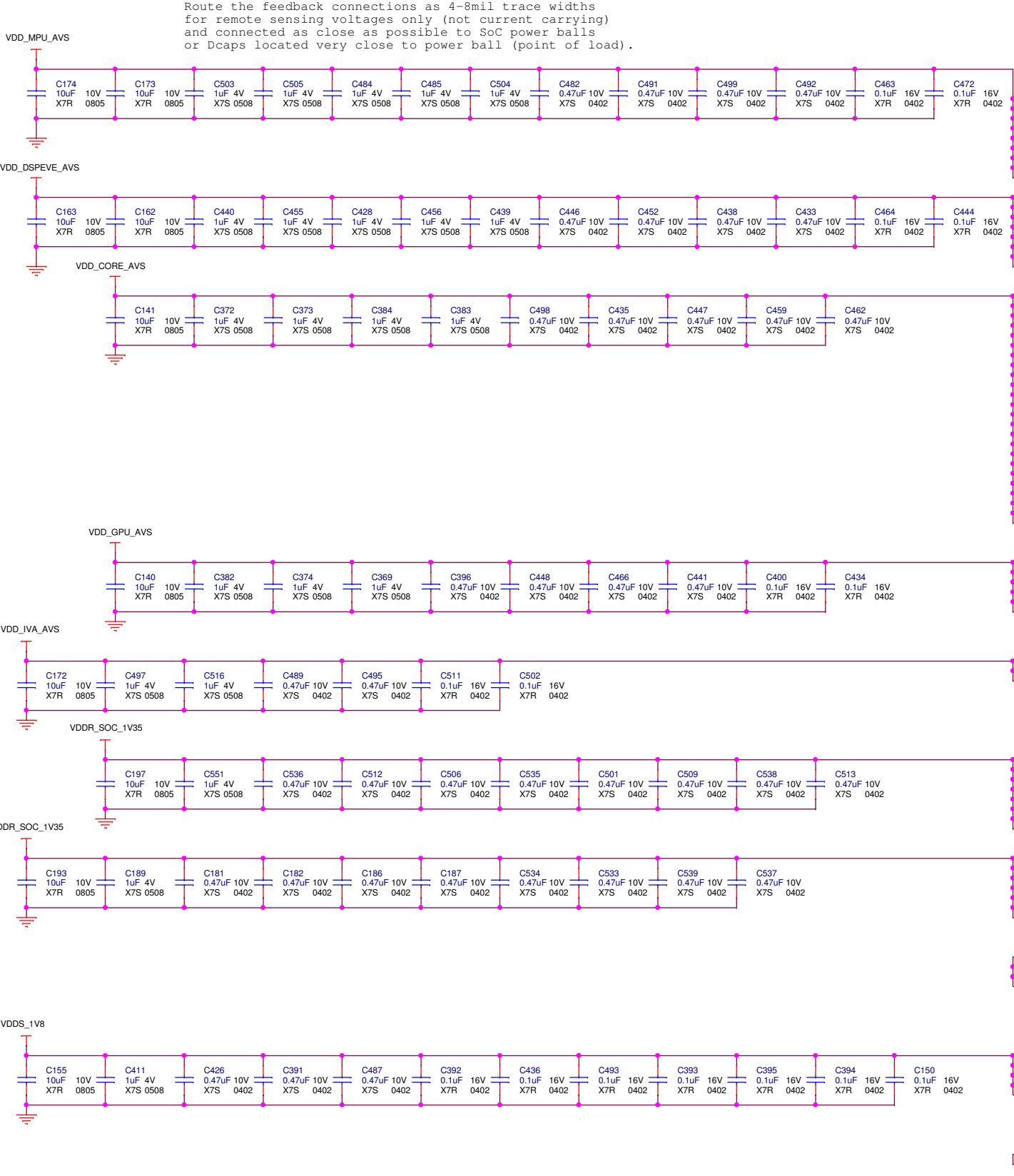
TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: J6PLUS_ANA_PWR			
Size: C	DOC NO: 518451	REV: C	
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Route the feedback connections as 4-8mil trace widths for remote sensing voltages only (not current carrying) and connected as close as possible to SoC power balls or Dcaps located very close to power ball (point of load).

DRA77xP / DRA76xP / TDA2Px

Data Manual: SPRS993A July 2017
 Package: ACD, 23x23mm, 784 PBGA, 0.8mm Pitch
 PCB Footprint: bga784_28x28_0p8mm
 SCH Symbol: IC_J6Plus_ACD_23mm_784BGA_v1.0

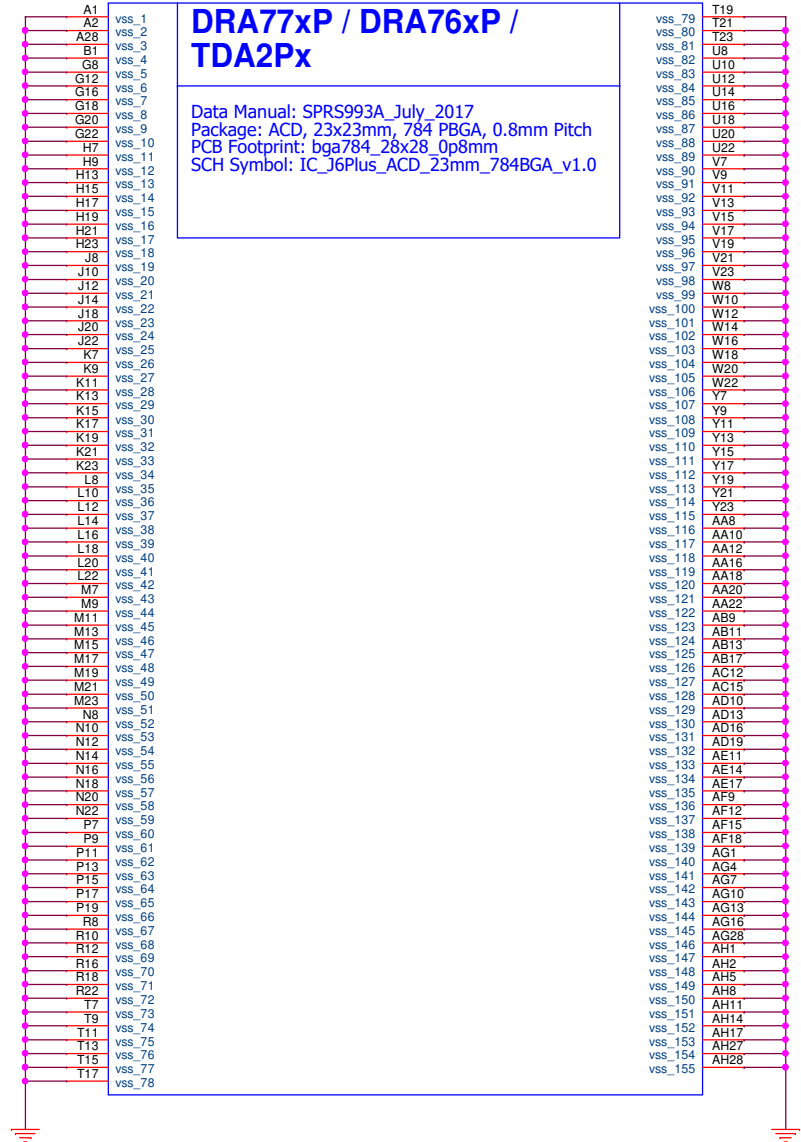
POWER DIGITAL SUPPLIES



To be connected to VDDS_1V8 if NOR Boot functionality is not required on J6Plus.

TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: J6PLUS_DIG_PWR			
Size: C	DOC NO: 518451	REV: C	
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U42G



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TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: BLANK

Size: C DOC NO: 518451 REV: A

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BLANK

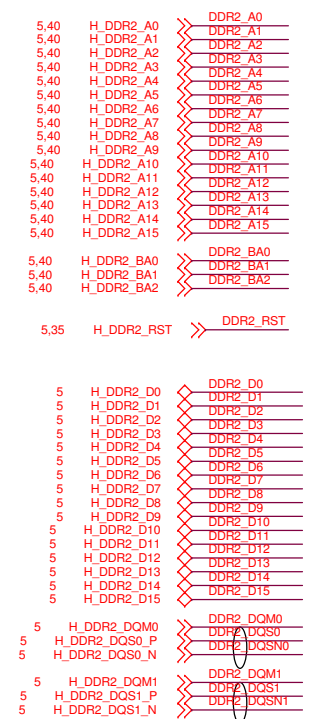
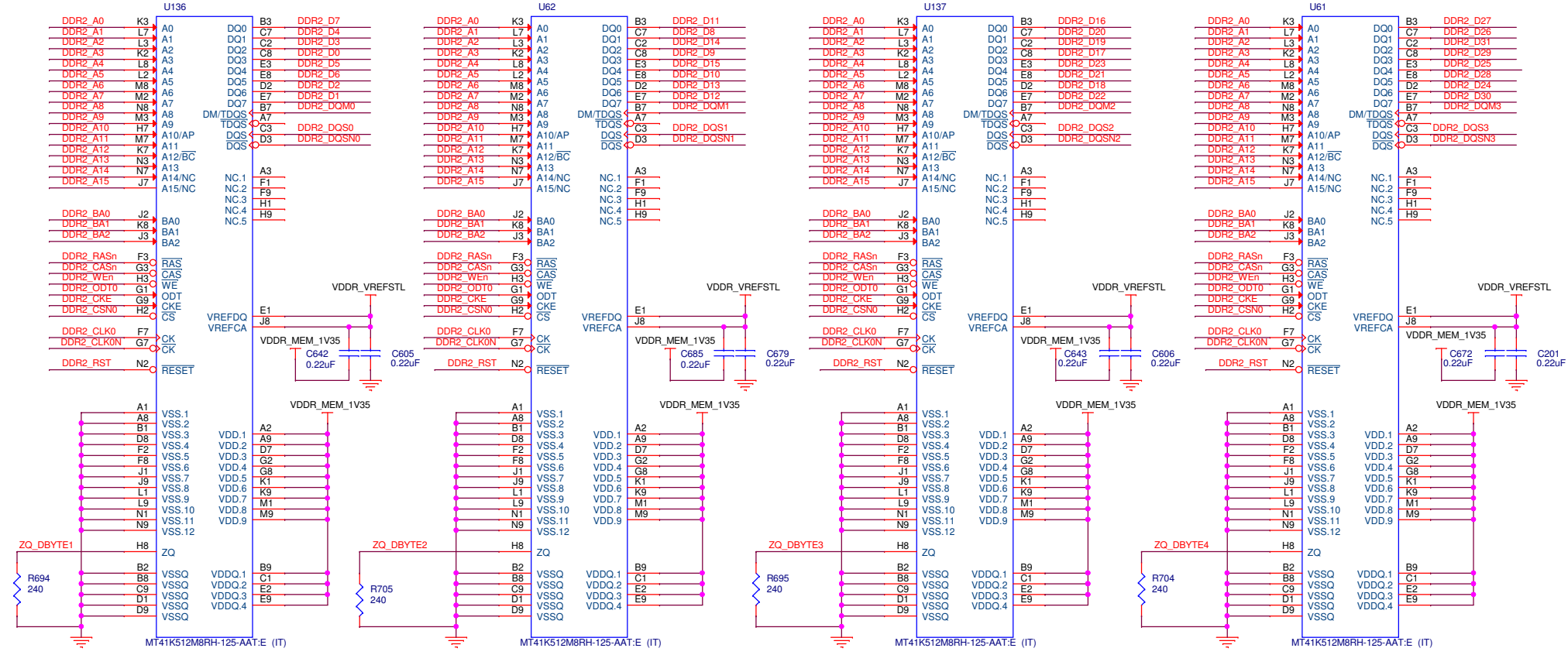
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

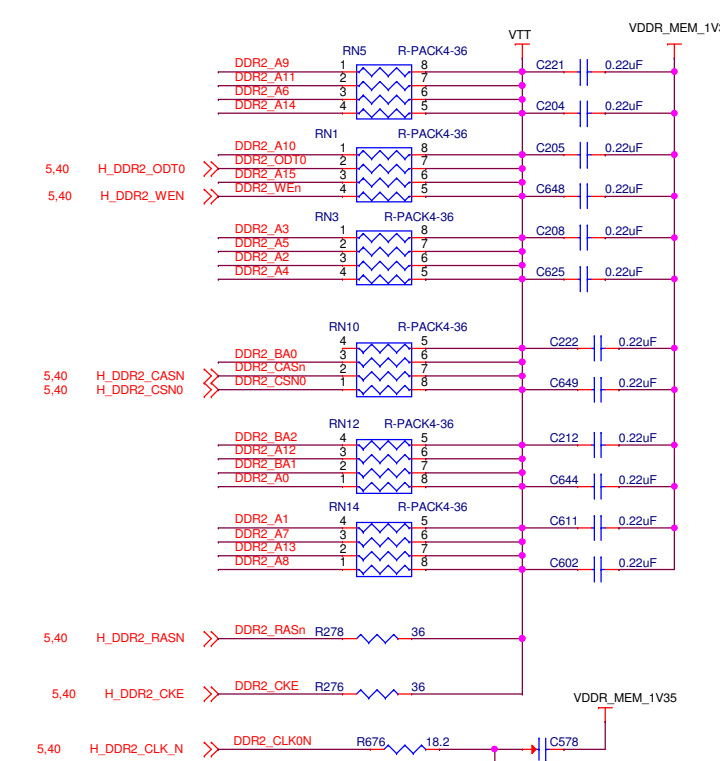
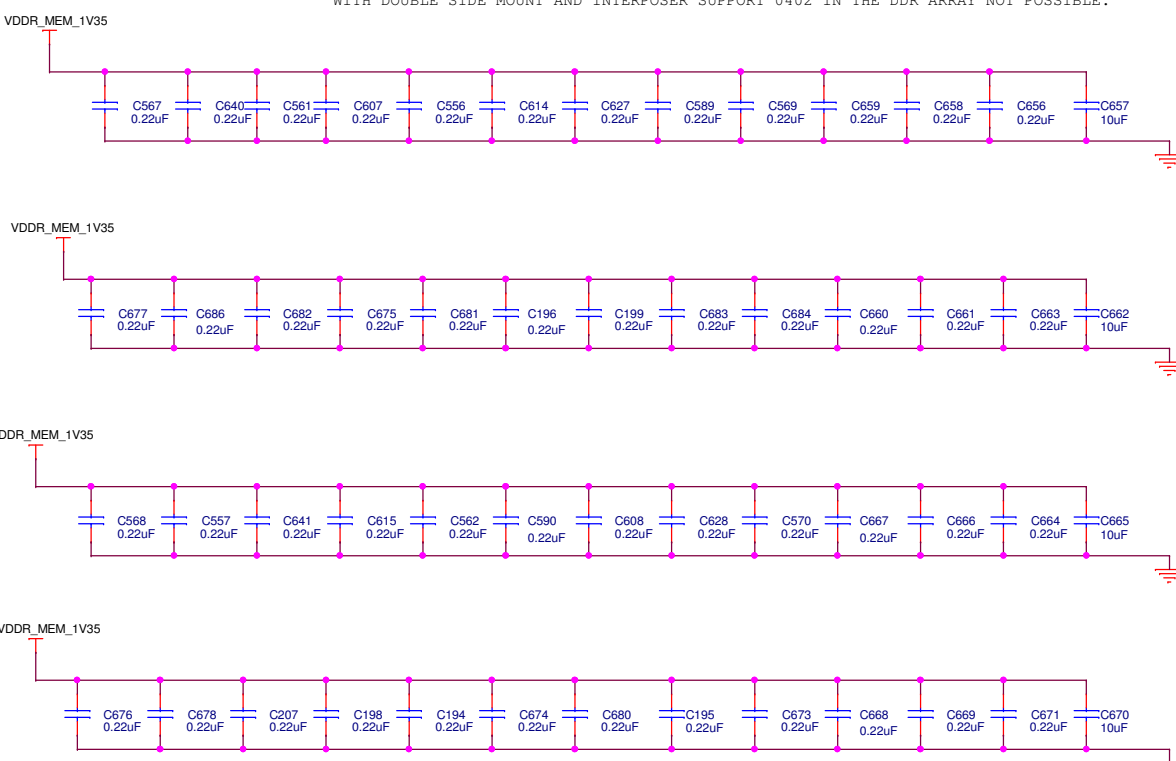
Page Contents: BLANK

Size: C DOC NO: 518451 REV: A

Date: Monday, November 13, 2017 Sheet 12 of 40

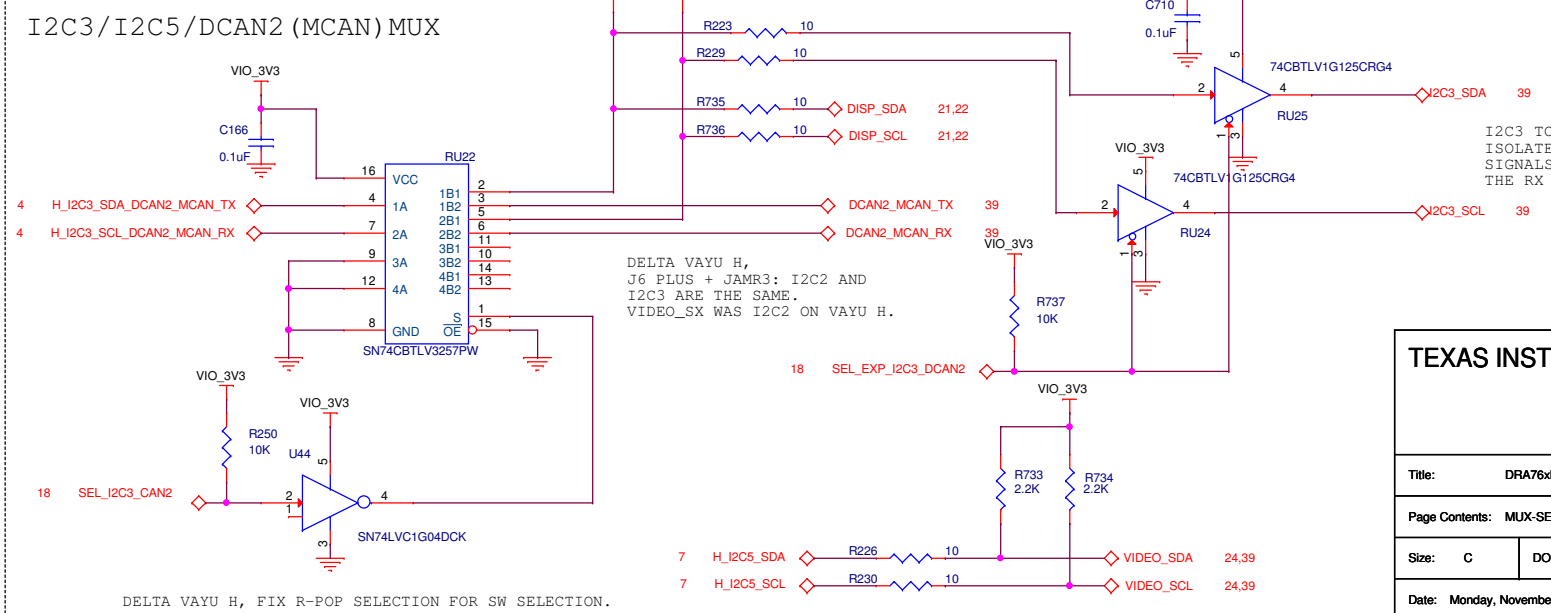
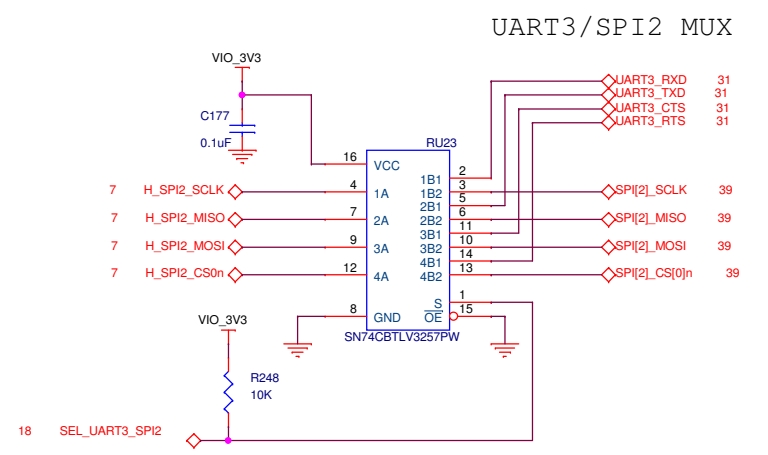
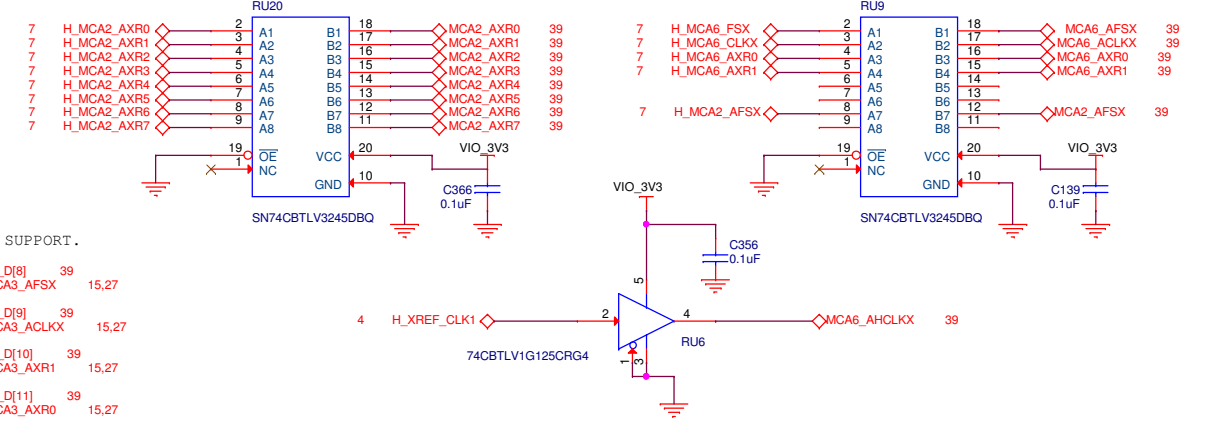
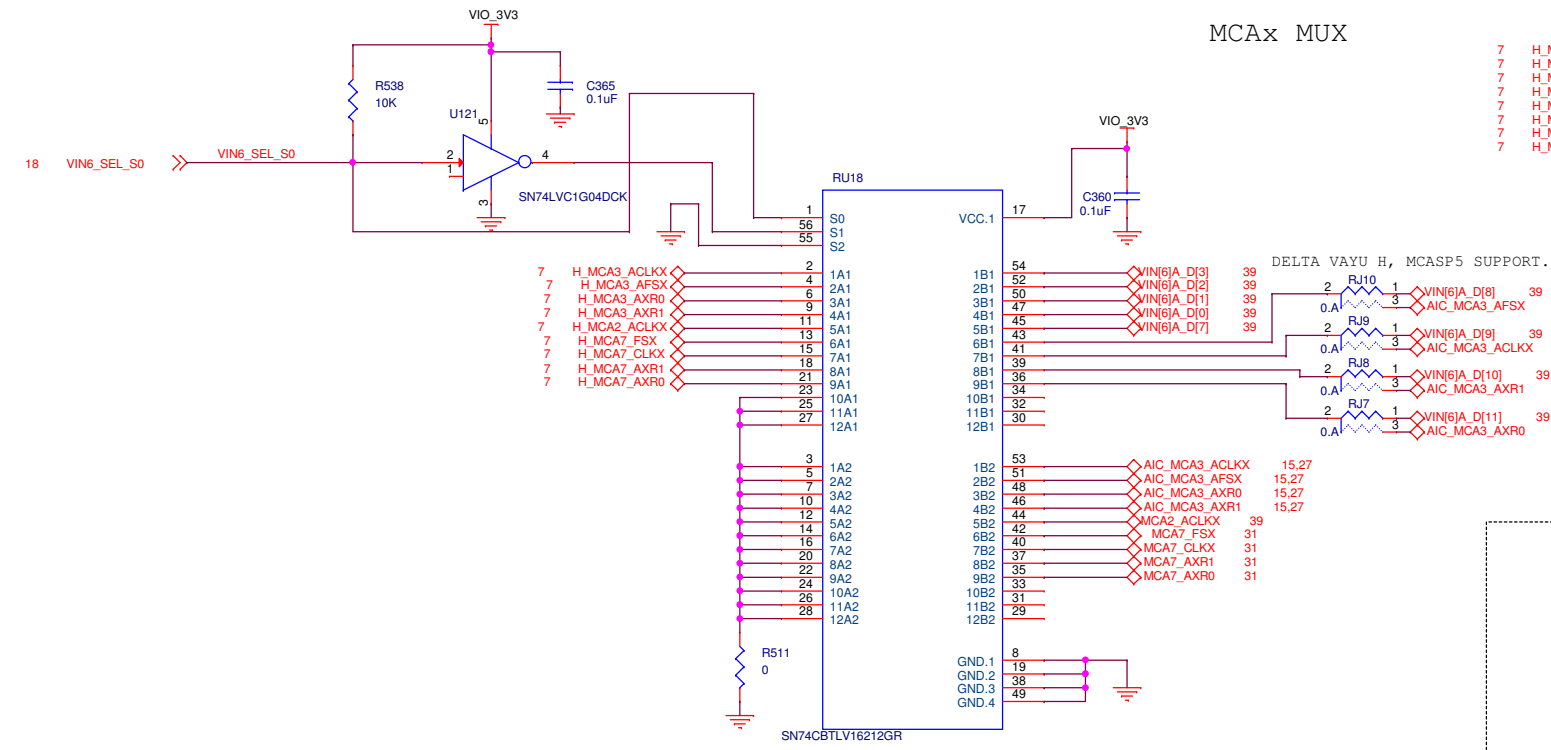


DELTA VAYU H, CHANGE OF CAPS TO 0201 AUTOMOTIVE IS TBD.
 WITH DOUBLE SIDE MOUNT AND INTERPOSER SUPPORT 0402 IN THE DDR ARRAY NOT POSSIBLE.

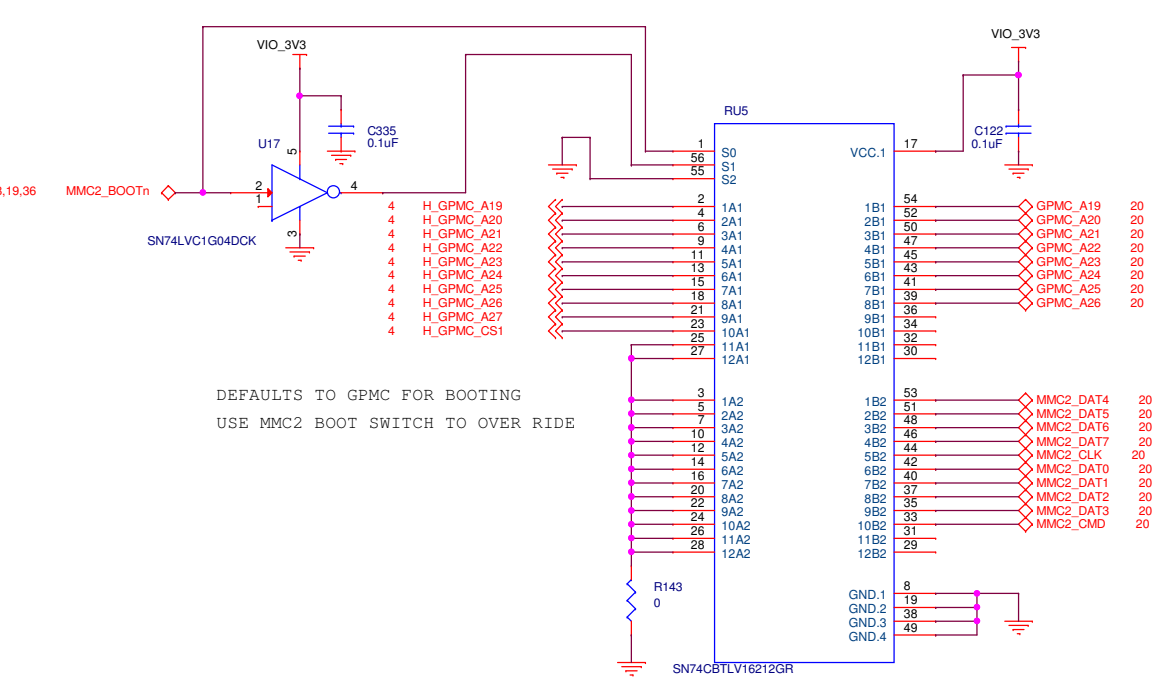
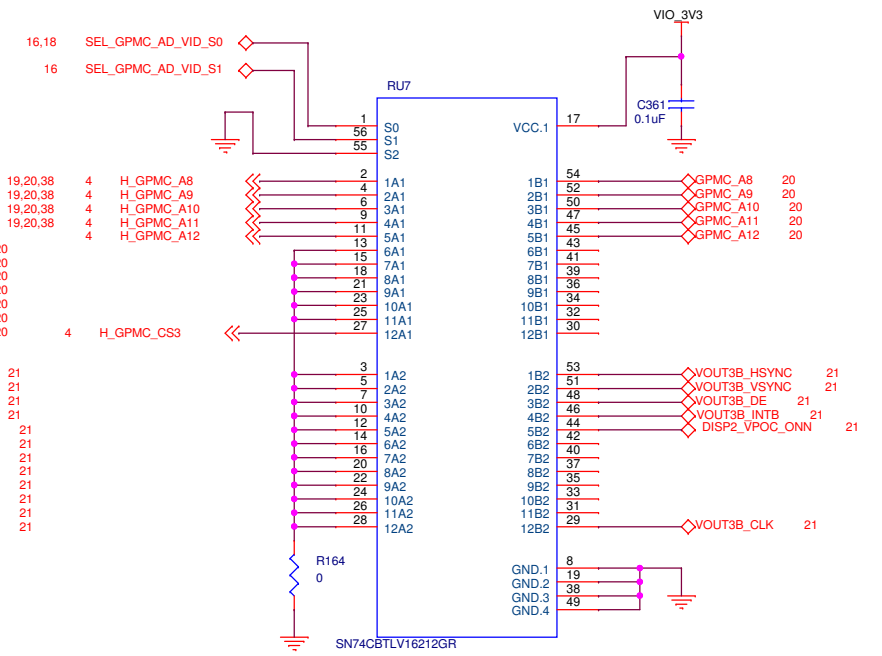
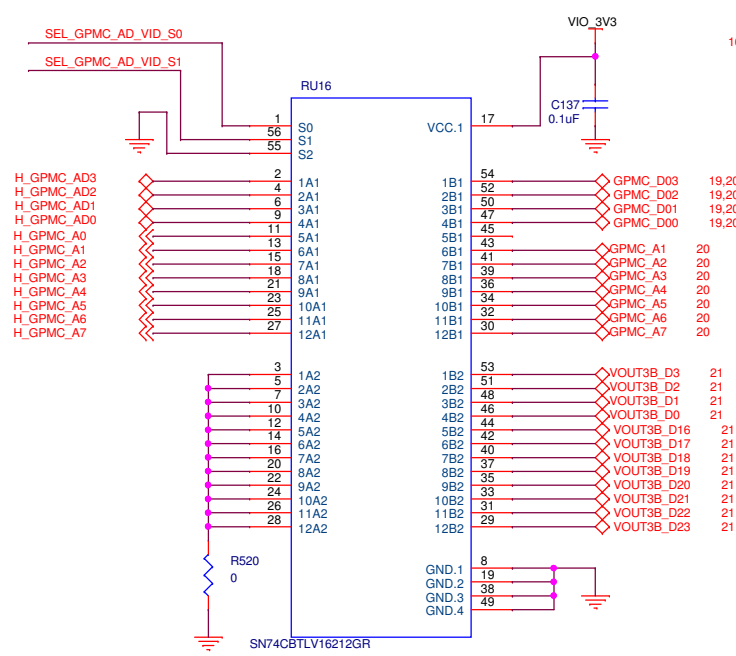
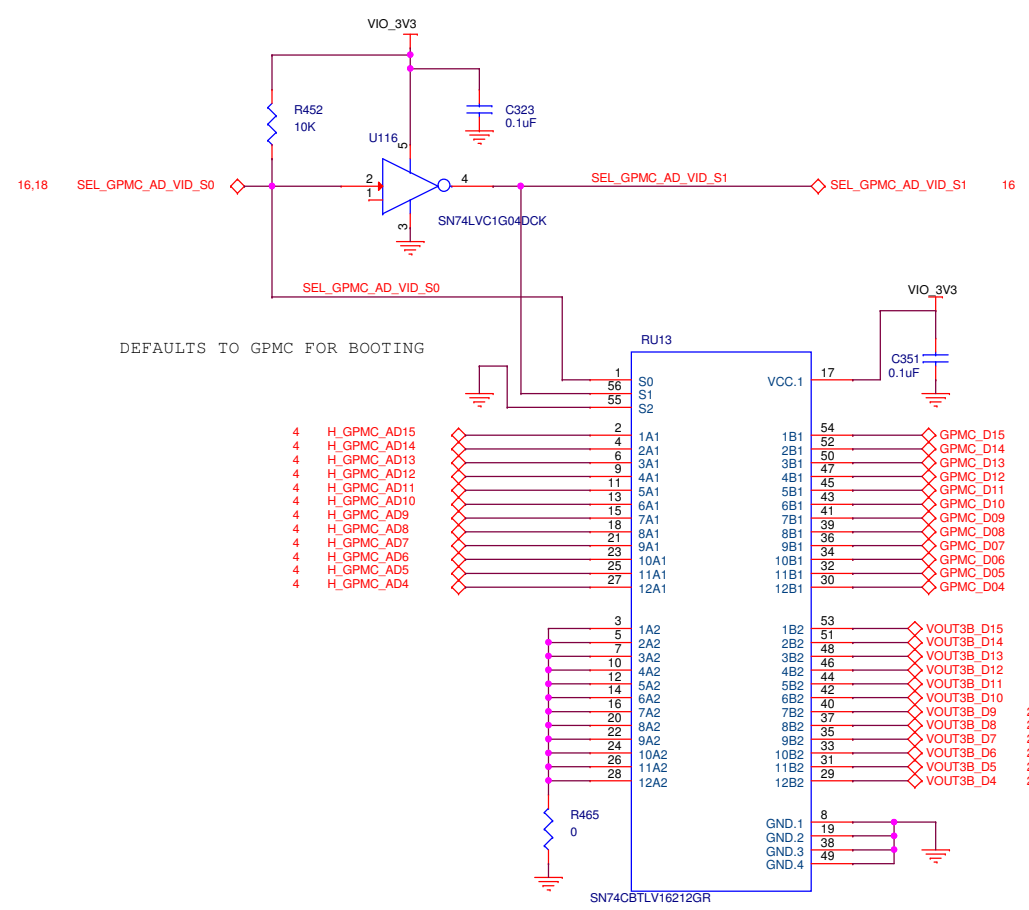


TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TTA22Px-ACD EVM CPU BOARD		
Page Contents: DDR BANK2		
Size: C	DOC NO: 518451	REV: A
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TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: MUX-SERIAL/EMAC			
Size: C	DOC NO: 518451	REV: B	
Date: Monday, November 13, 2017	Sheet 15	of	40



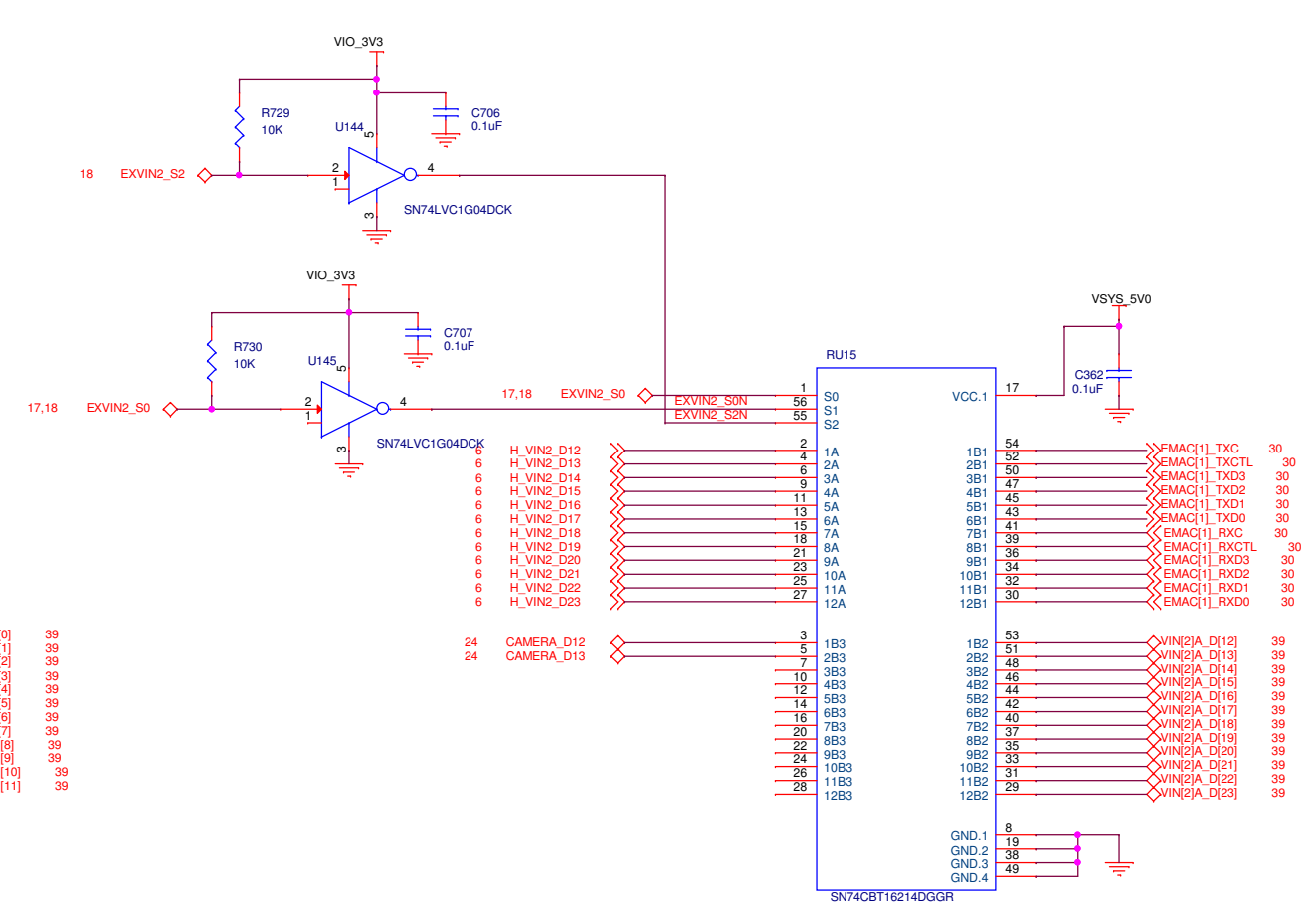
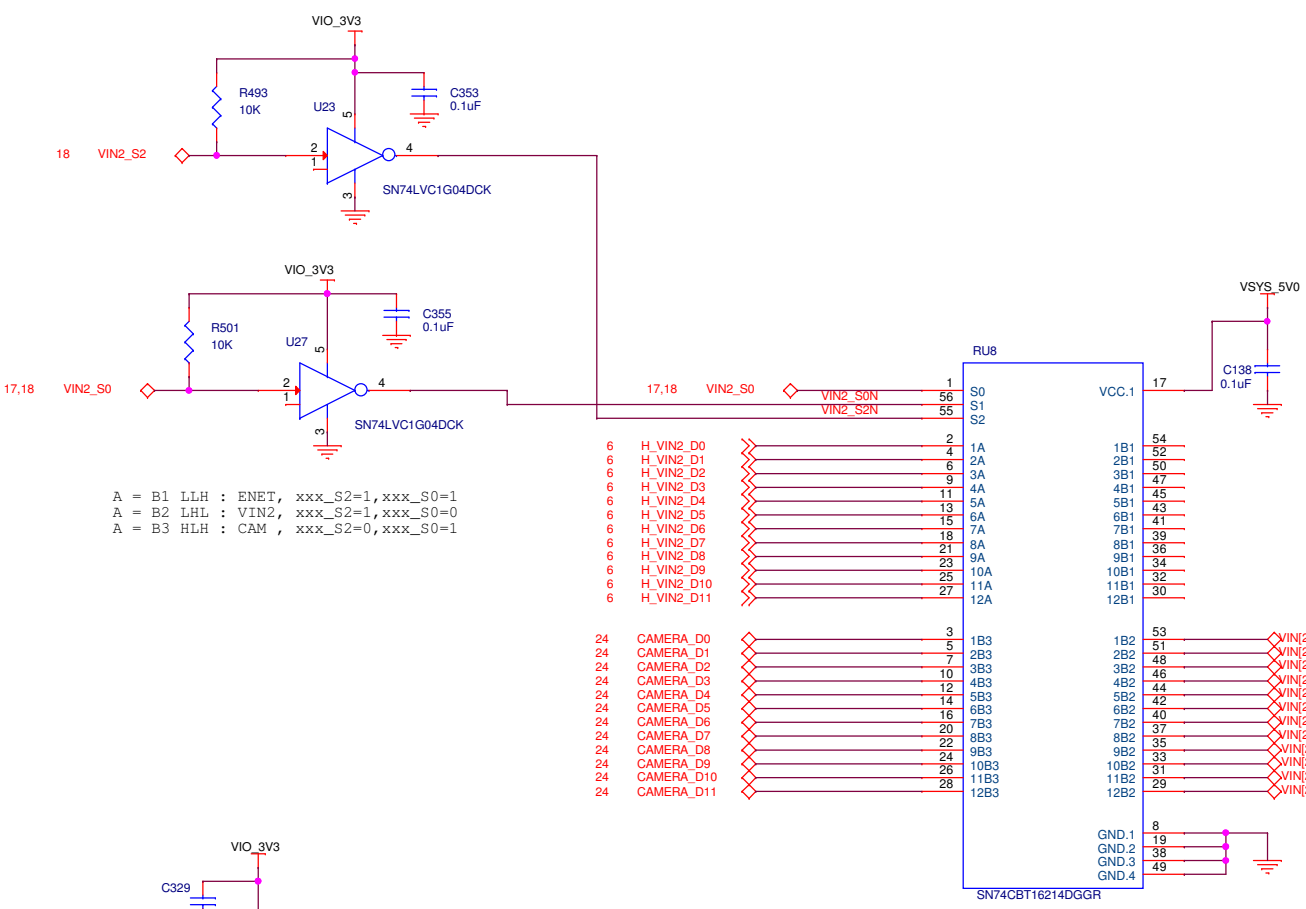
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: MUX-GPMC

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A = B1 LLH : ENET, xxx_S2=1, xxx_S0=1
 A = B2 LHL : VIN2, xxx_S2=1, xxx_S0=0
 A = B3 HLH : CAM, xxx_S2=0, xxx_S0=1

- 6 H_VIN2_D0
- 6 H_VIN2_D1
- 6 H_VIN2_D2
- 6 H_VIN2_D3
- 6 H_VIN2_D4
- 6 H_VIN2_D5
- 6 H_VIN2_D6
- 6 H_VIN2_D7
- 6 H_VIN2_D8
- 6 H_VIN2_D9
- 6 H_VIN2_D10
- 6 H_VIN2_D11

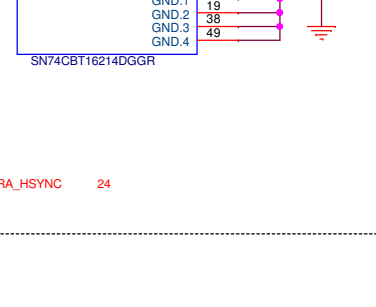
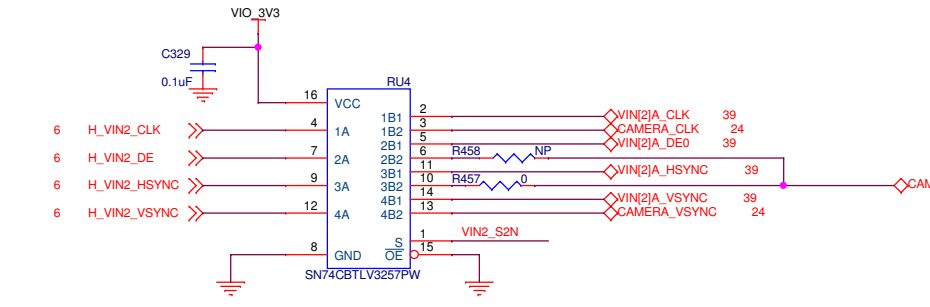
- 1A
- 2A
- 3A
- 4A
- 5A
- 6A
- 7A
- 8A
- 9A
- 10A
- 11A
- 12A

- 1B1
- 2B1
- 3B1
- 4B1
- 5B1
- 6B1
- 7B1
- 8B1
- 9B1
- 10B1
- 11B1
- 12B1

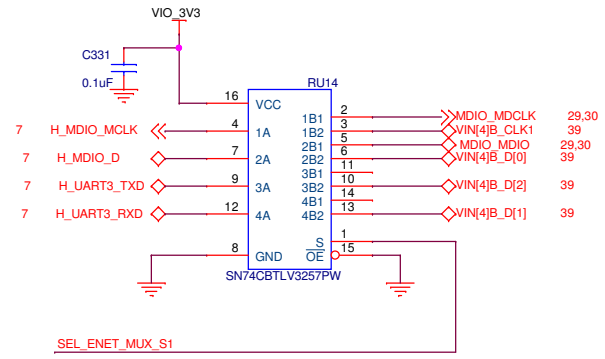
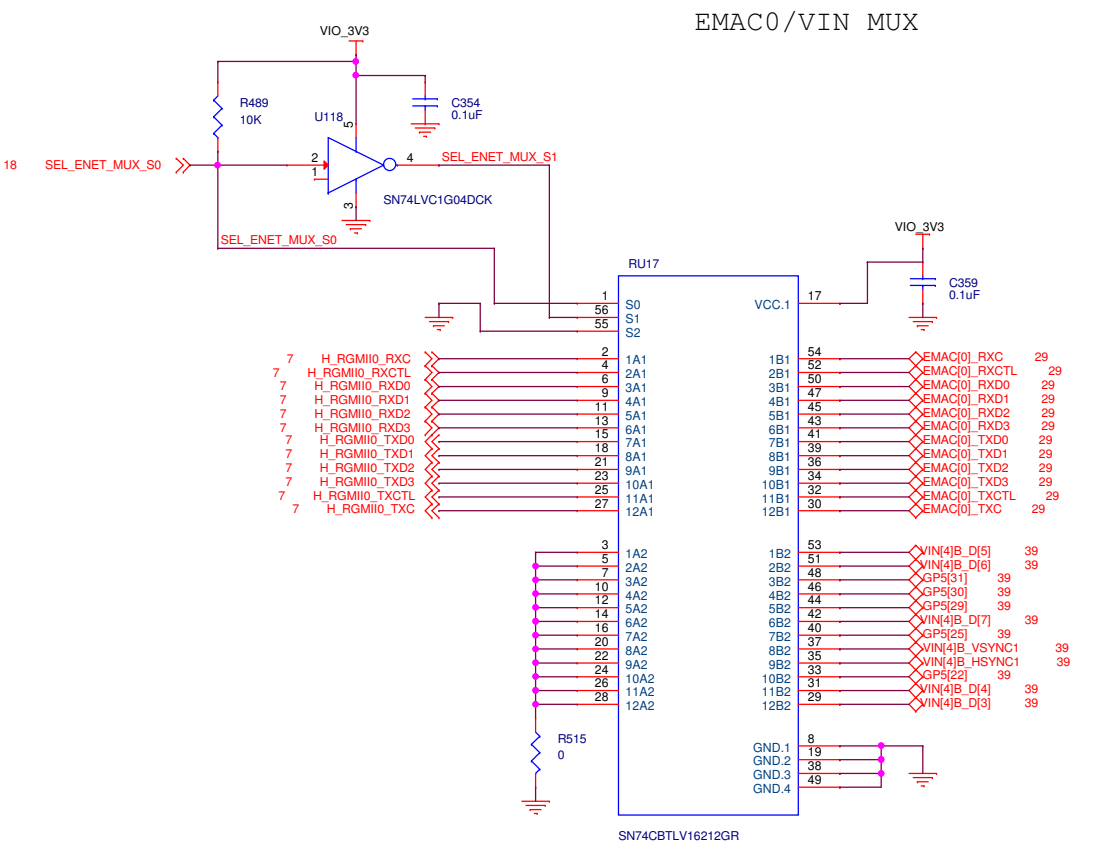
- 2 H_VIN2_D12
- 2 H_VIN2_D13
- 2 H_VIN2_D14
- 2 H_VIN2_D15
- 2 H_VIN2_D16
- 2 H_VIN2_D17
- 2 H_VIN2_D18
- 2 H_VIN2_D19
- 2 H_VIN2_D20
- 2 H_VIN2_D21
- 2 H_VIN2_D22
- 2 H_VIN2_D23

- 1A
- 2A
- 3A
- 4A
- 5A
- 6A
- 7A
- 8A
- 9A
- 10A
- 11A
- 12A

- 1B1
- 2B1
- 3B1
- 4B1
- 5B1
- 6B1
- 7B1
- 8B1
- 9B1
- 10B1
- 11B1
- 12B1



DELTA VAYU H, MOVE CAMERA TO VIN2.



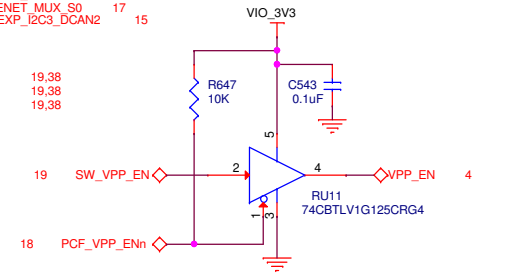
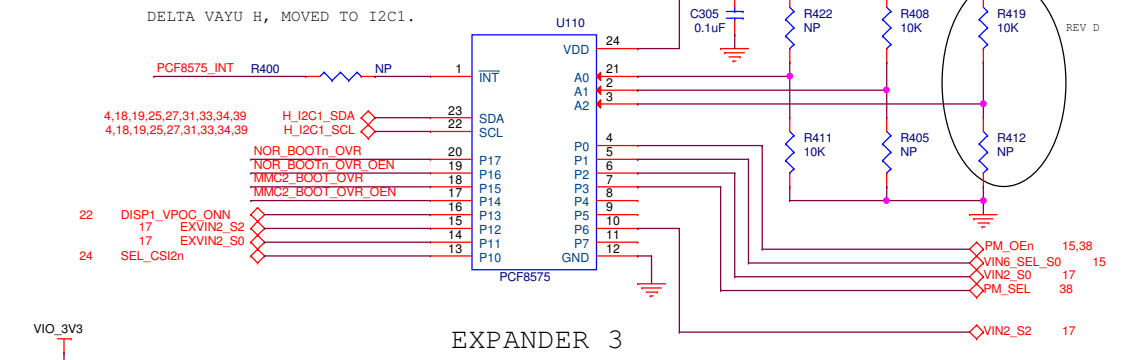
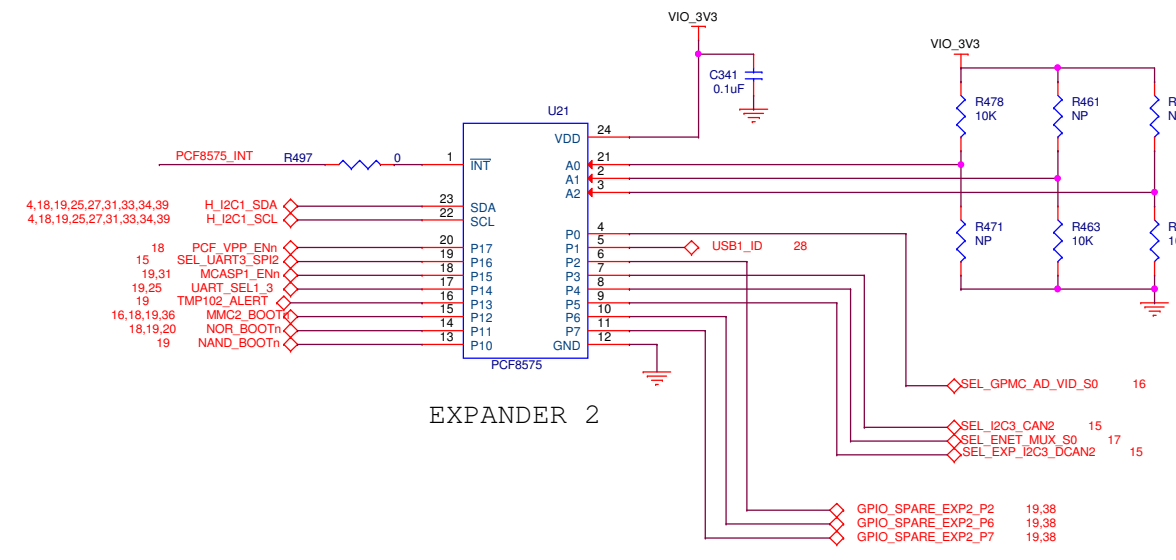
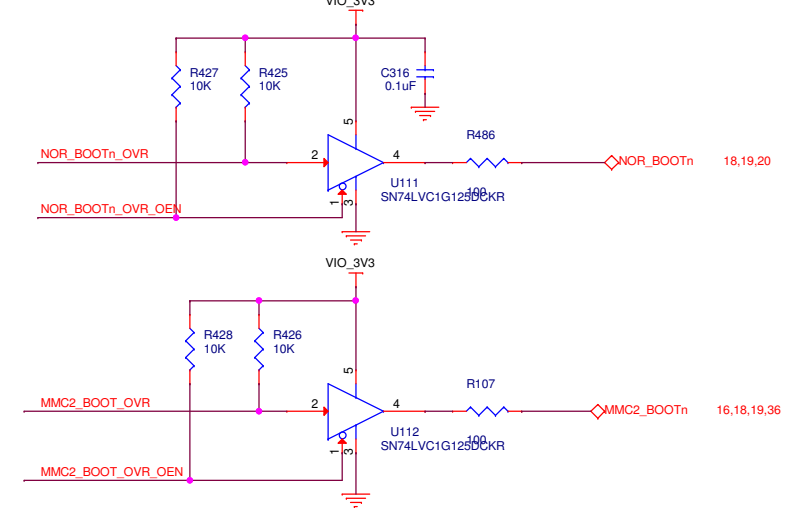
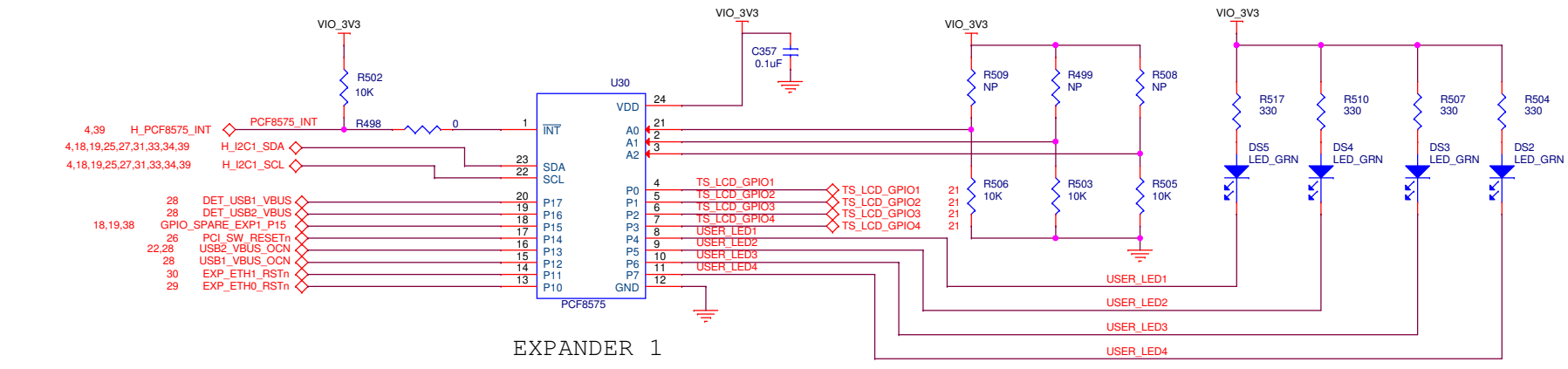
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

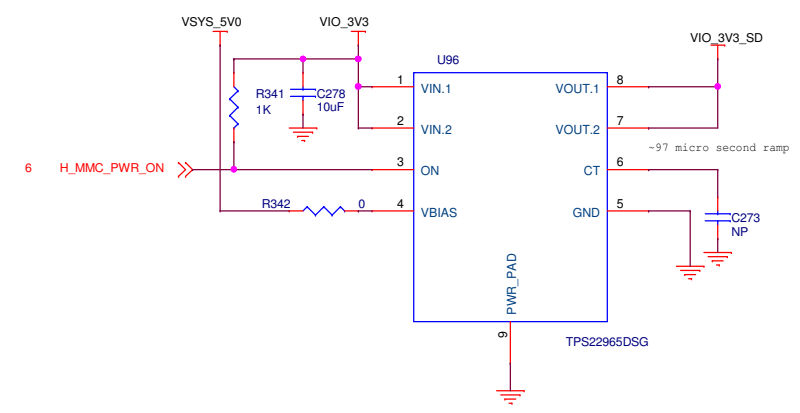
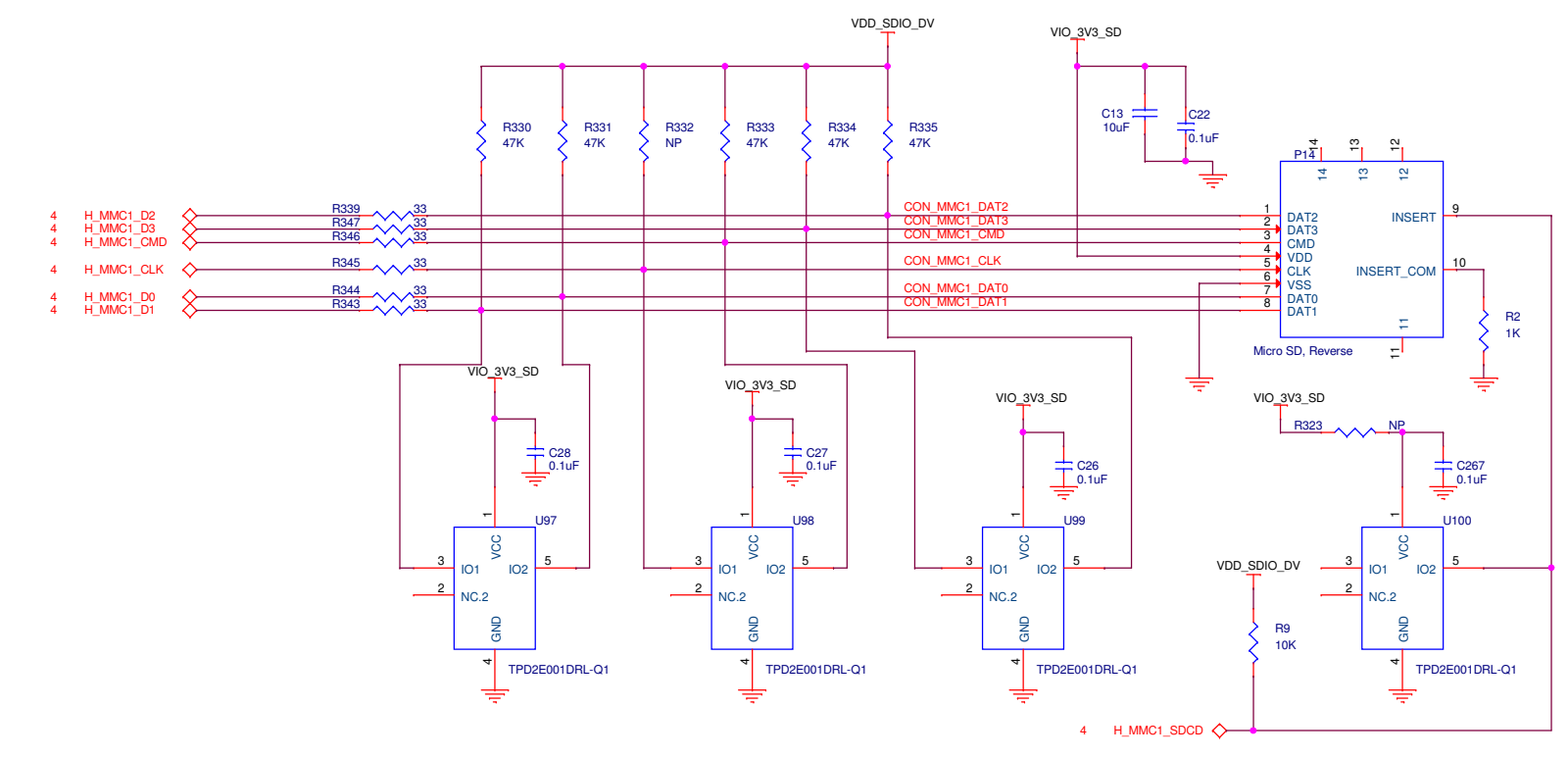
Page Contents: MUX-VIDEO

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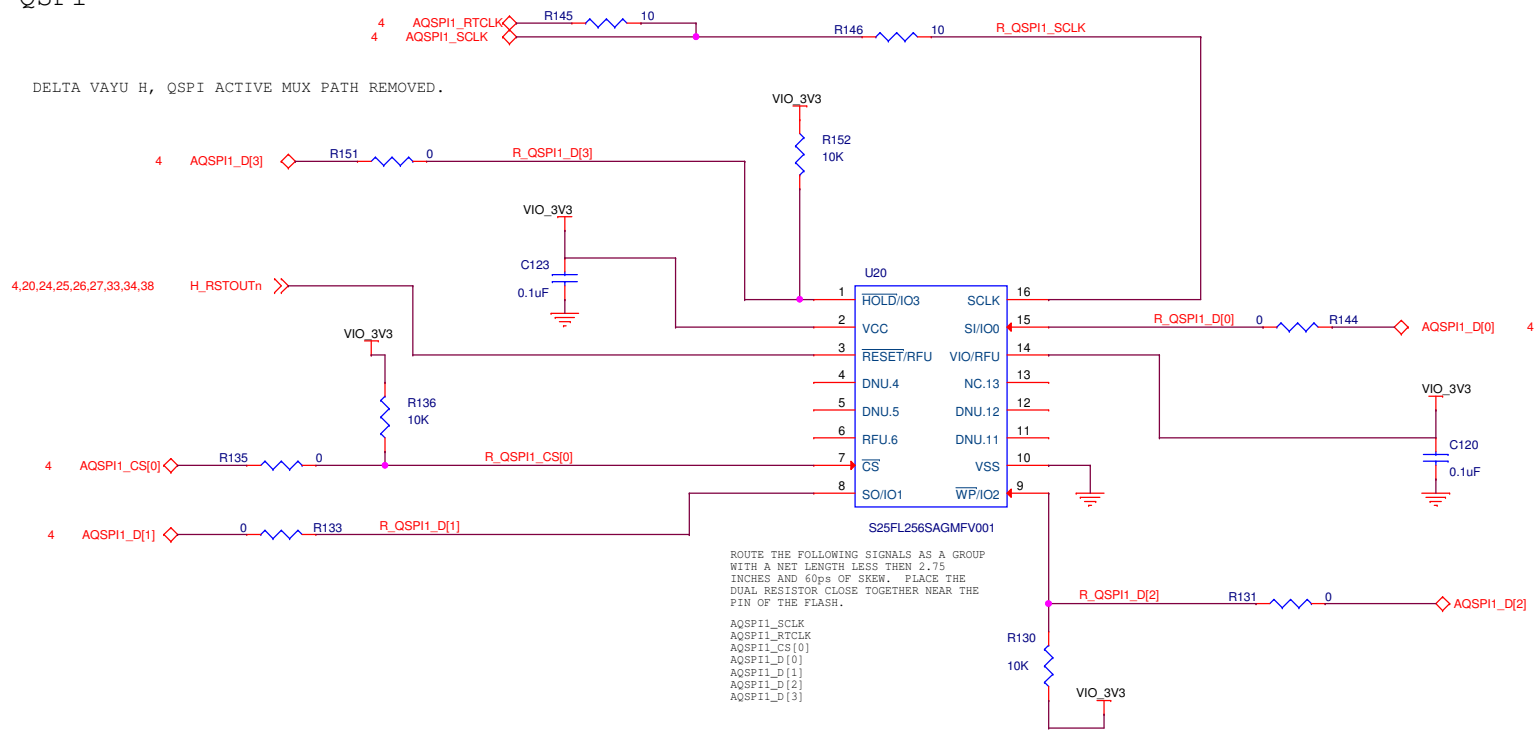
SD CARD



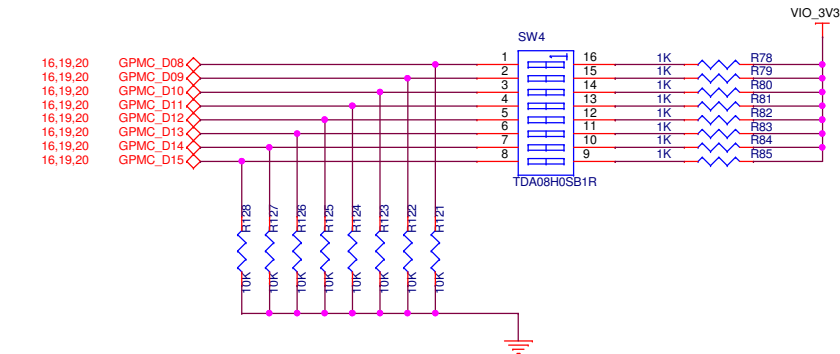
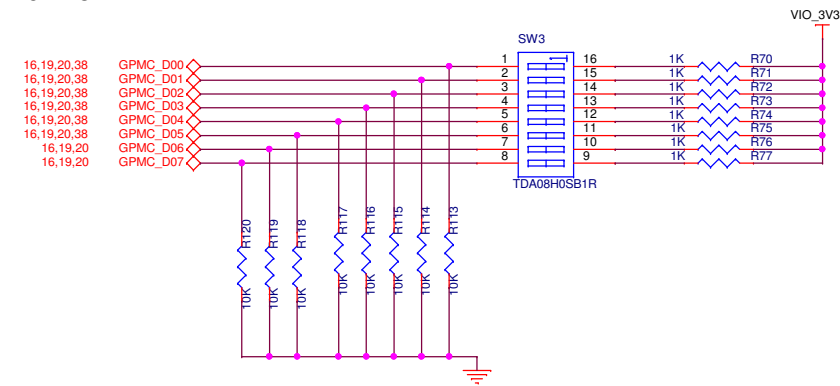
TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: IOEXPANDER/SDCARD			
Size: C	DOC NO: 518451	REV: C	
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QSPI

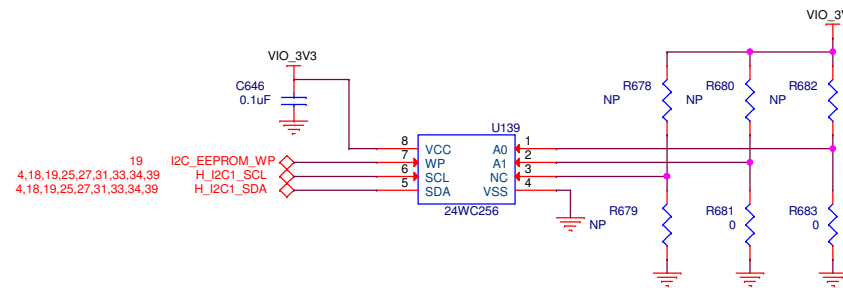
DELTA VAYU H, QSPI ACTIVE MUX PATH REMOVED.



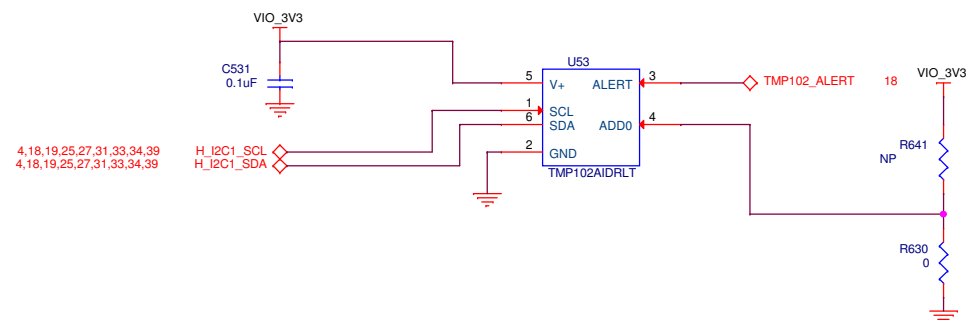
BOOT SWITCHES



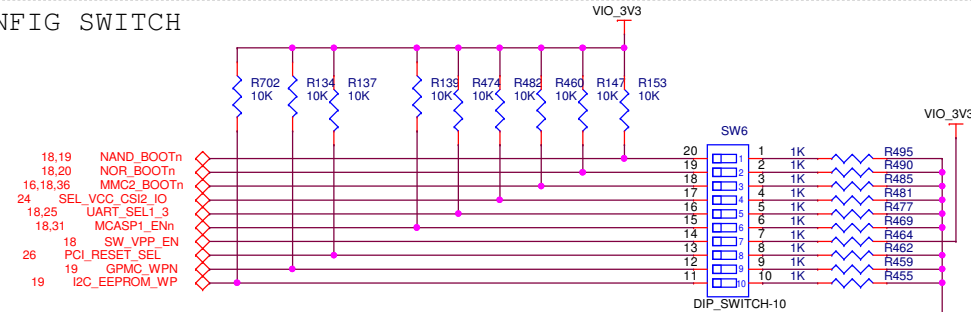
CONFIG EEPROM



TEMP SENSOR

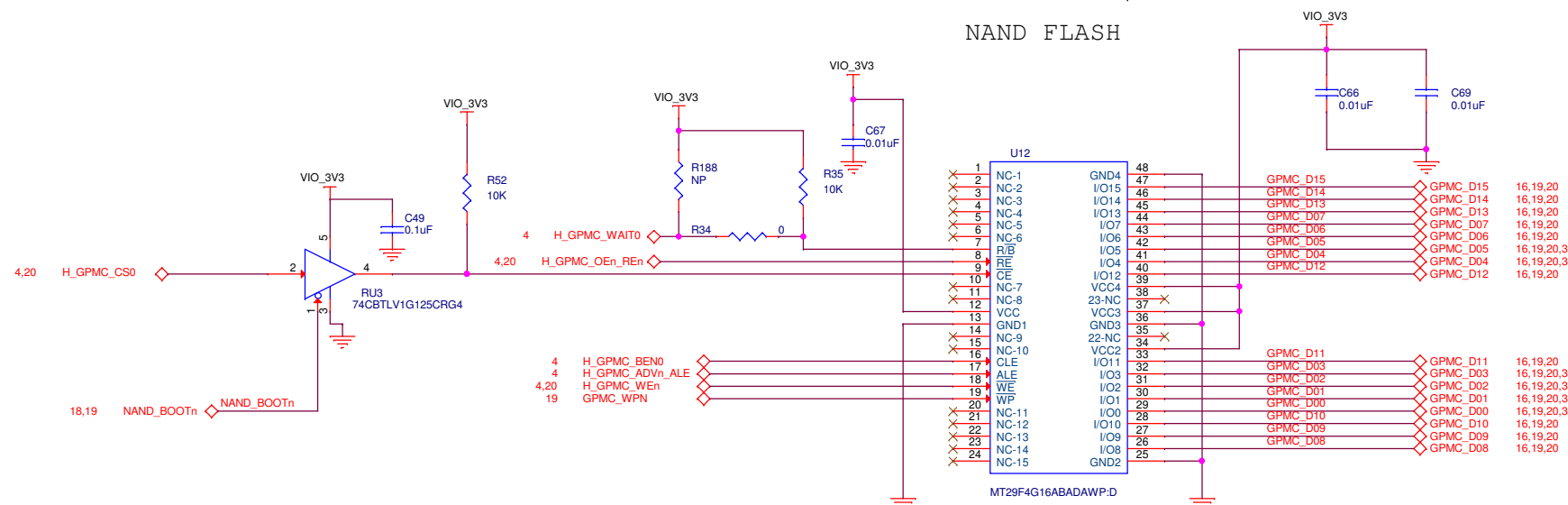


USER CONFIG SWITCH



CONTROL VIA SWITCH, EXPANDER, AND AUTOMATION HEADER.

NAND FLASH



TEXAS INSTRUMENTS INCORPORATED

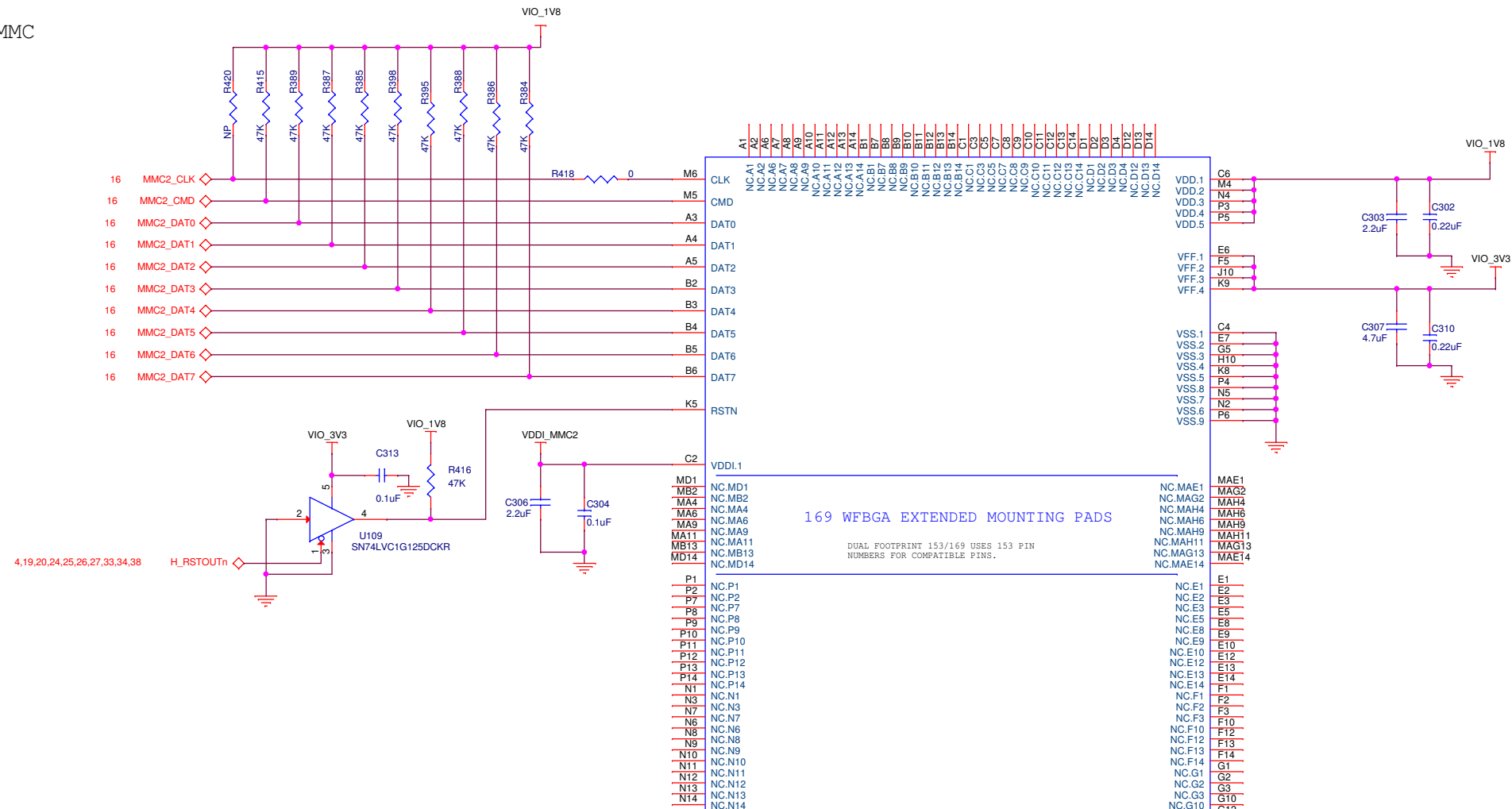
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: QSPI/NAND/BOOT/EEPR/TMP

Size: C DOC NO: 518451 REV: C

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eMMC

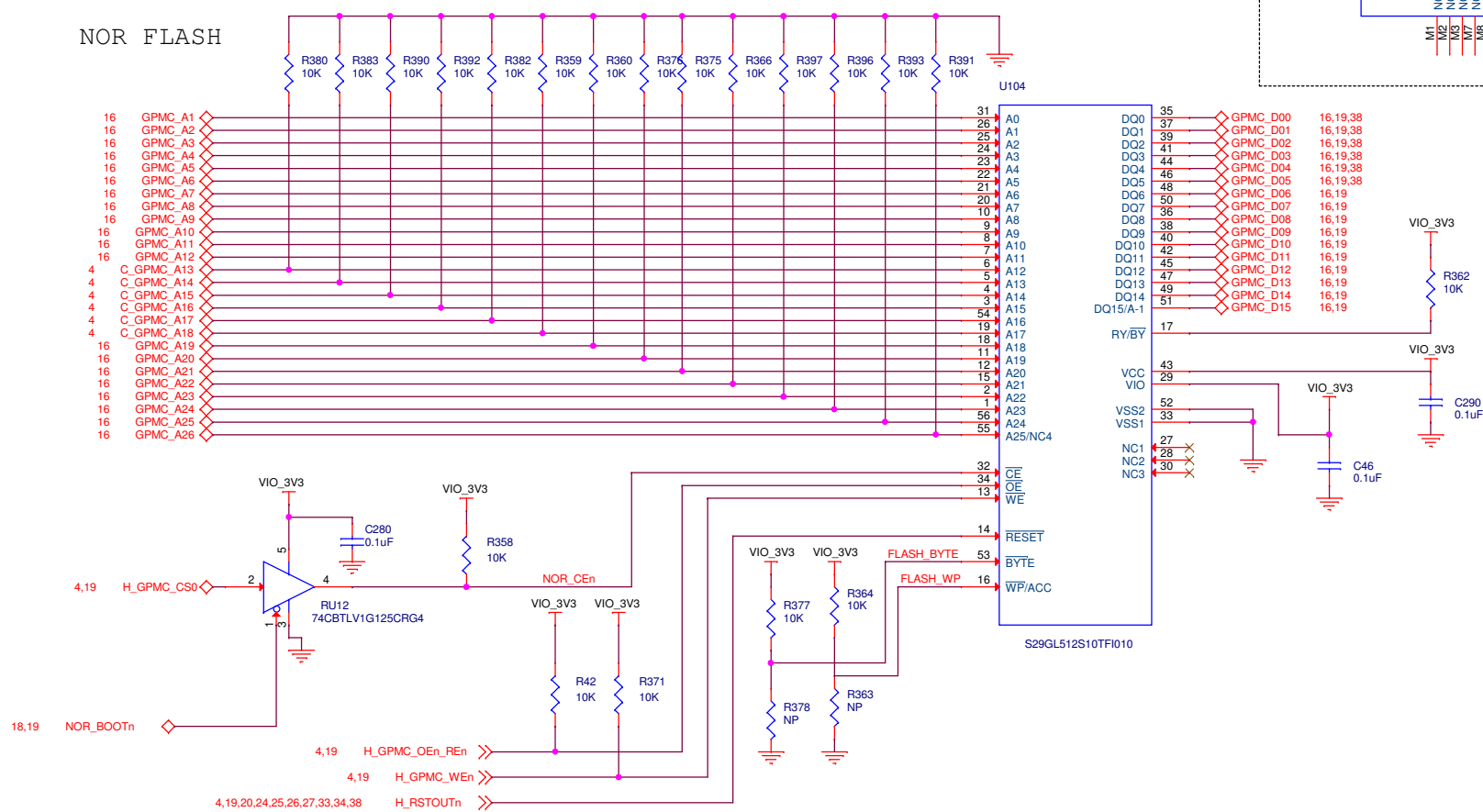


169 WFBGA EXTENDED MOUNTING PADS

DUAL FOOTPRINT 153/169 USES 153 PIN NUMBERS FOR COMPATIBLE PINS.

DELTA VAYU H, QSPI ACTIVE MUX PATH REMOVED.

NOR FLASH



TEXAS INSTRUMENTS INCORPORATED

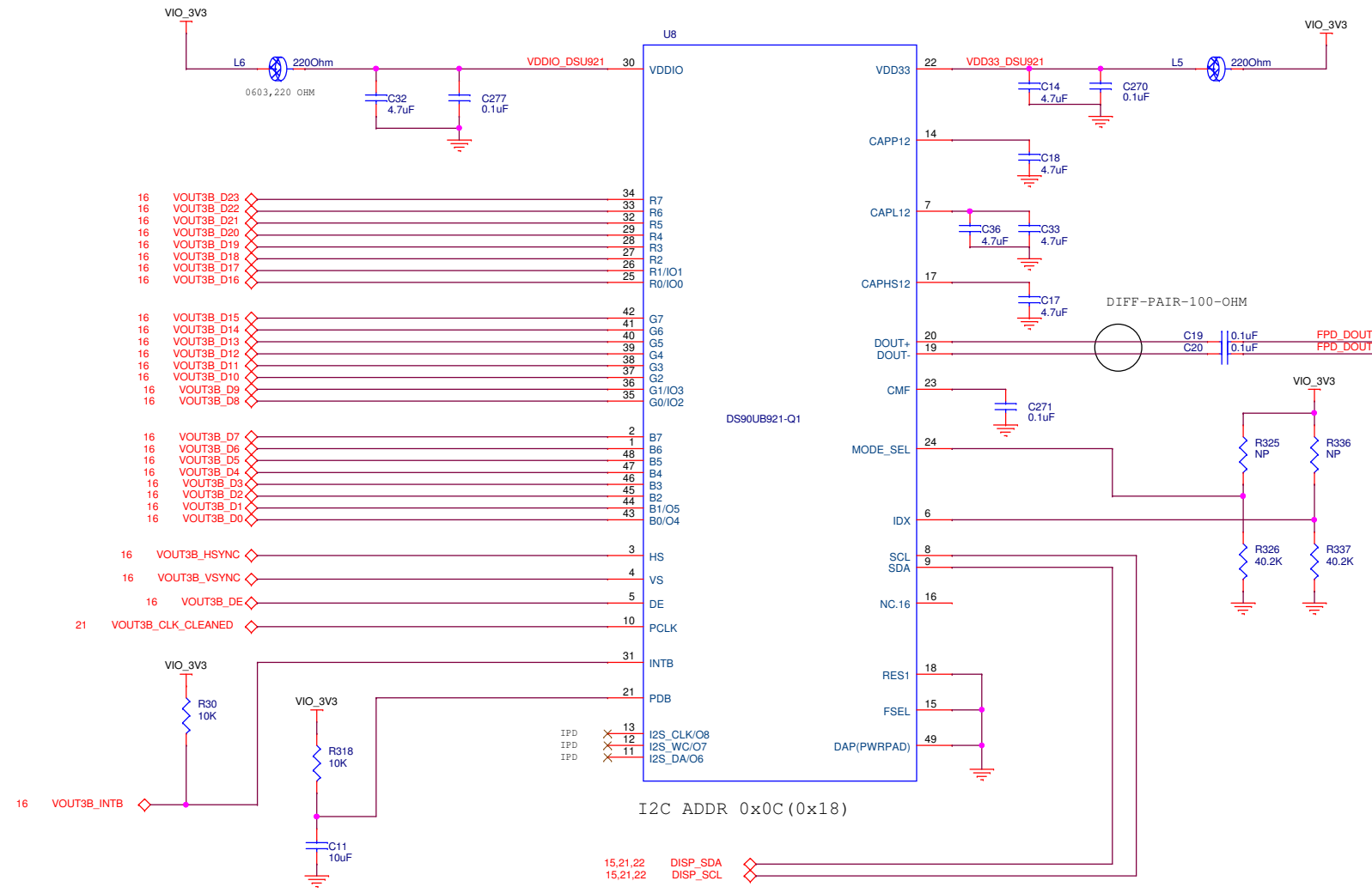
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: EMMC/NORFLASH

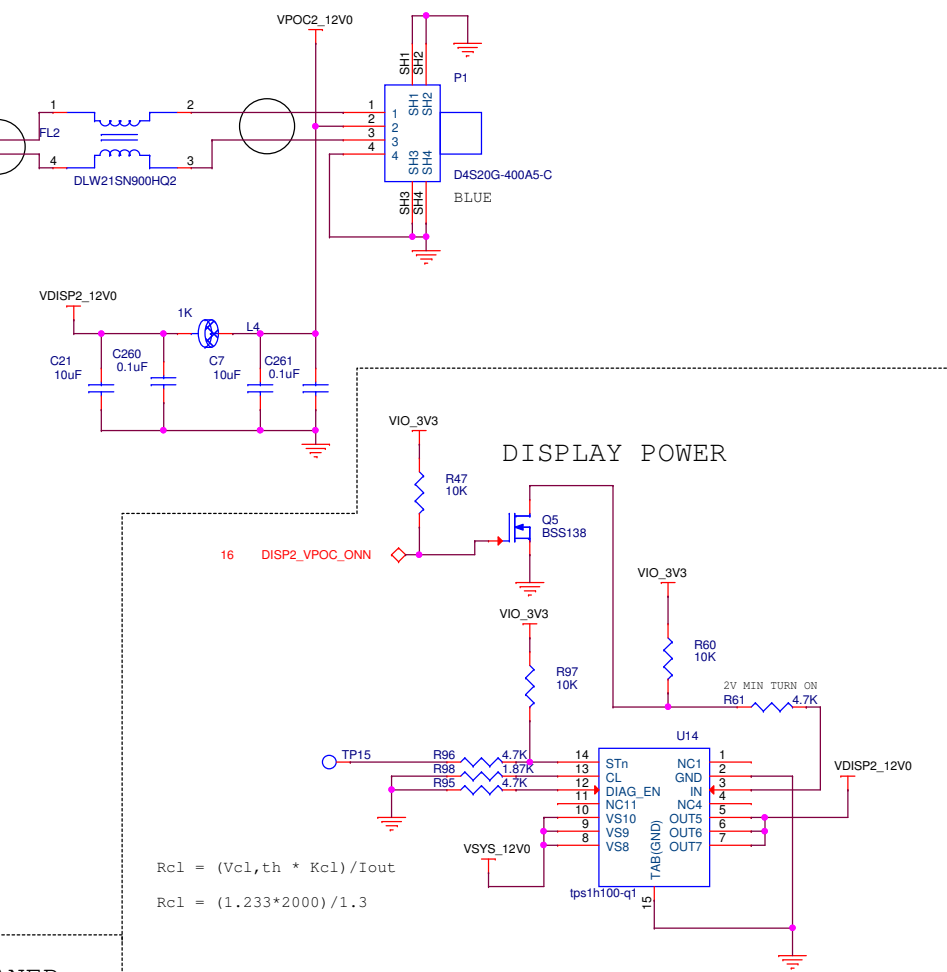
Size: C DOC NO: 518451 REV: A

Date: Monday, November 13, 2017 Sheet 20 of 40

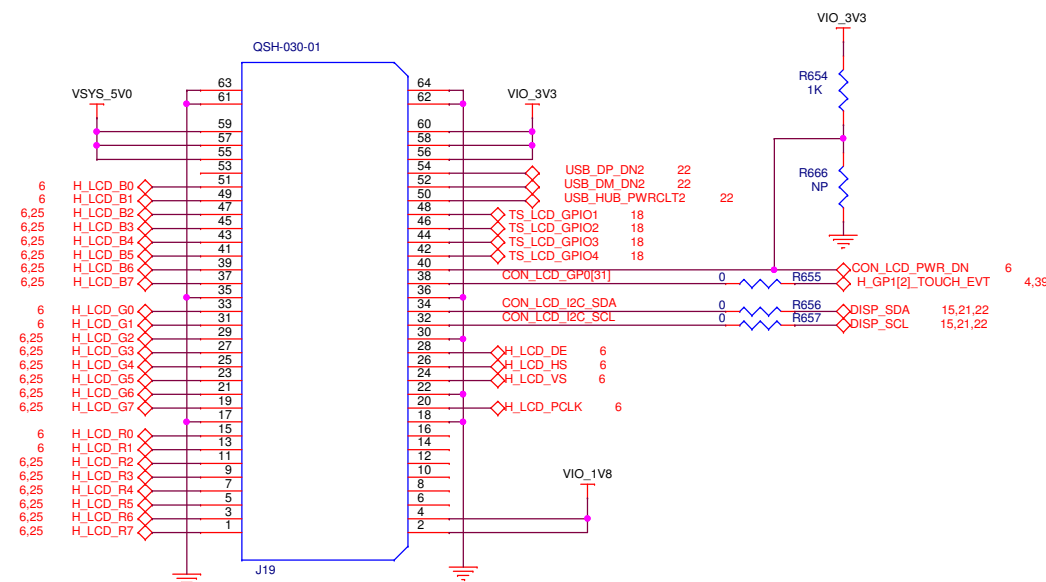
FPD-LINK DISPLAY/TOUCH



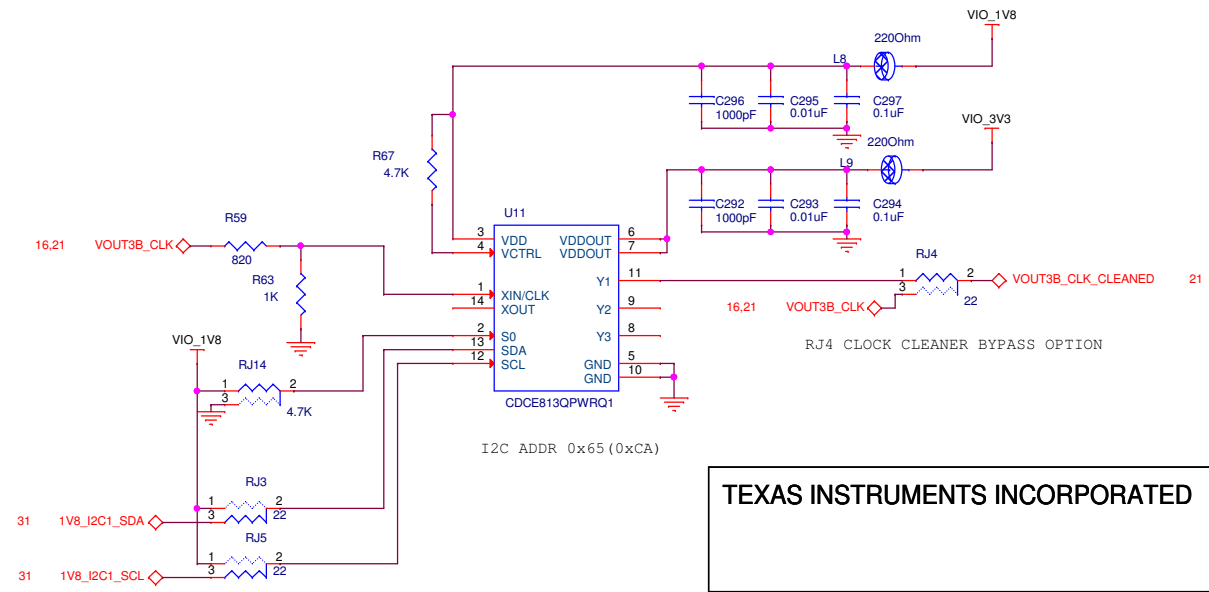
ECU HOST	ECU SLAVE (DISPLAY)
1 TPA+	DISPLAY GROUND
2 DISPLAY POWER	TPA-
3 TPA-	DISPLAY POWER
4 DISPLAY GROUND	TPA+



LCD/TOUCH INTERFACE



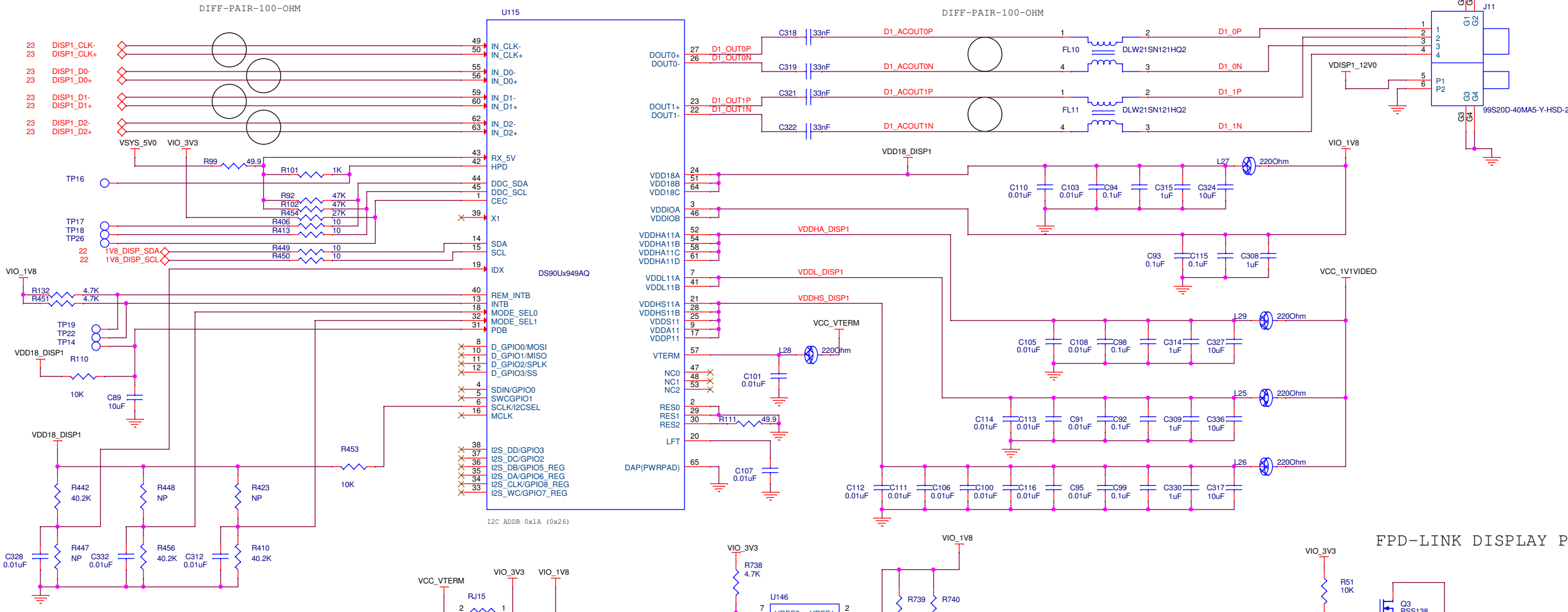
FPD-LINK CLOCK CLEANER



TEXAS INSTRUMENTS INCORPORATED

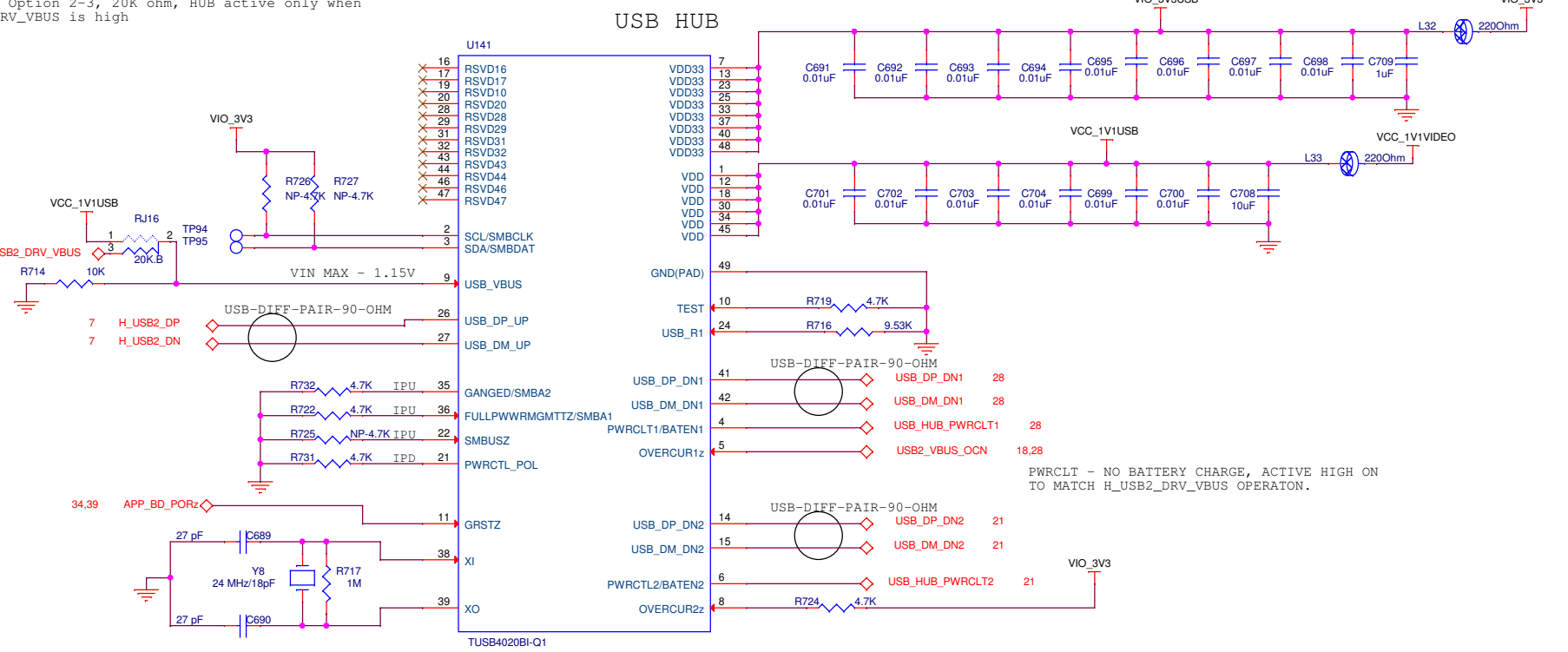
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: FPD-LINK/LCD			
Size: C	DOC NO: 518451	REV: C	
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HDMI TO FPD-LINK DISPLAY

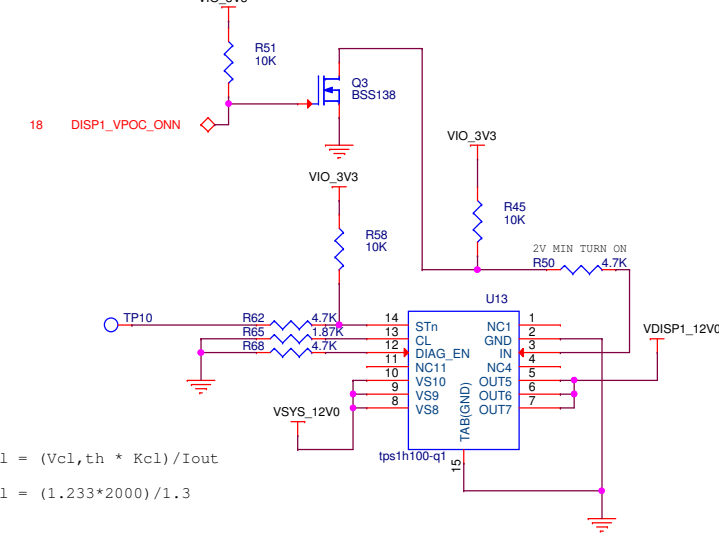


USB_VBUS on HUB pin 9 must be high for the HUB to show up on the USB bus as this simulates up-stream power. However a high on USB_VBUS does NOT turn on down-stream power via PWRCTL. PWRCTL to downstream ports is controlled via the USB power control SW stack. Each down-stream power port is controlled individually.

RJ16 - Option 1-2, 0-ohm, HUB always active
RJ16 - Option 2-3, 20K ohm, HUB active only when USB2_DRV_VBUS is high



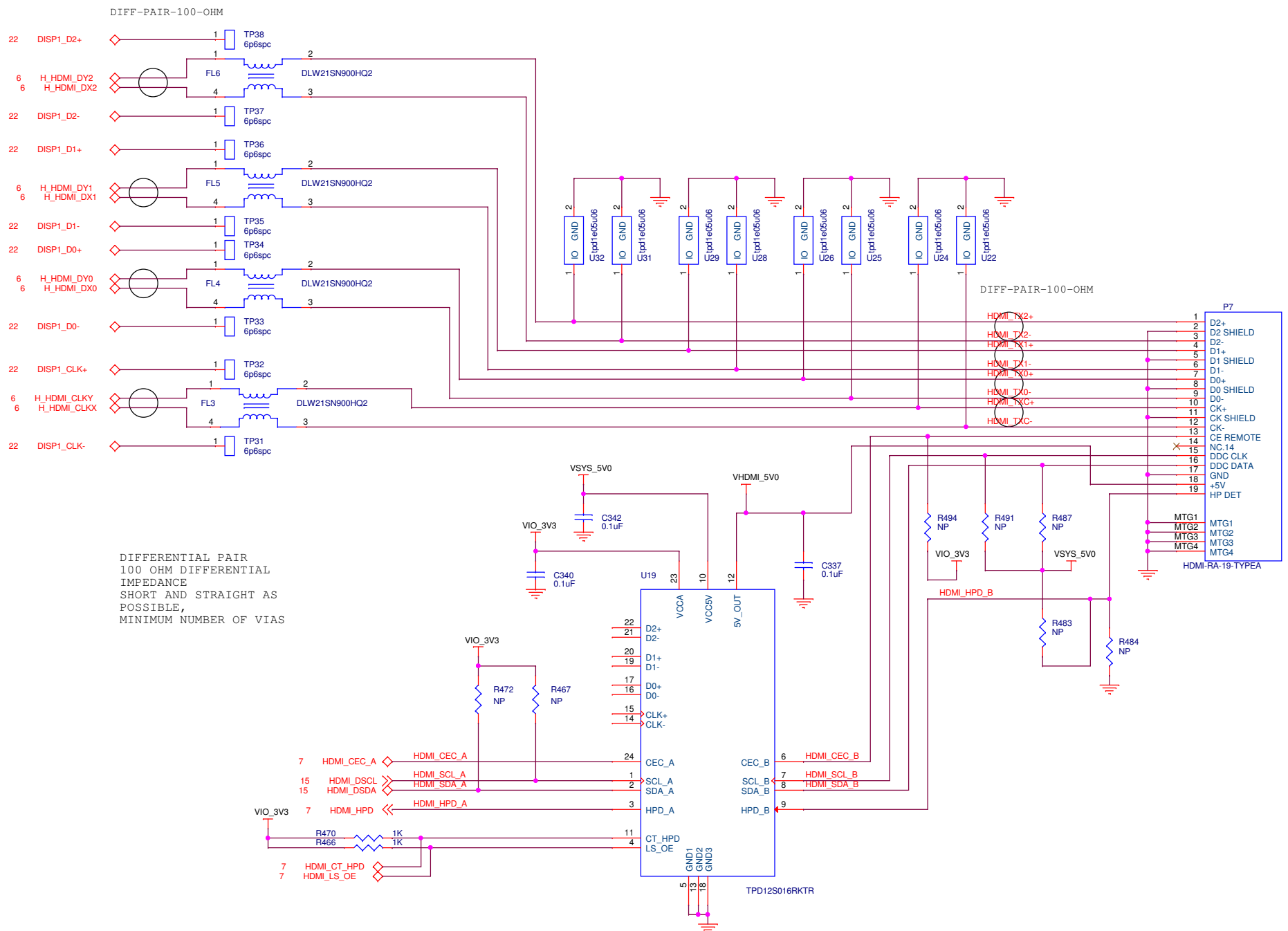
FPD-LINK DISPLAY POWER



$$R_{cl} = (V_{cl,th} * K_{cl}) / I_{out}$$
$$R_{cl} = (1.233 * 2000) / 1.3$$

TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77P/TDA2Px-ACD EVM CPU BOARD		
Page Contents: HDMI-FPDLINK		
Size: C	DOC NO: 518451	REV: C
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TEXAS INSTRUMENTS INCORPORATED

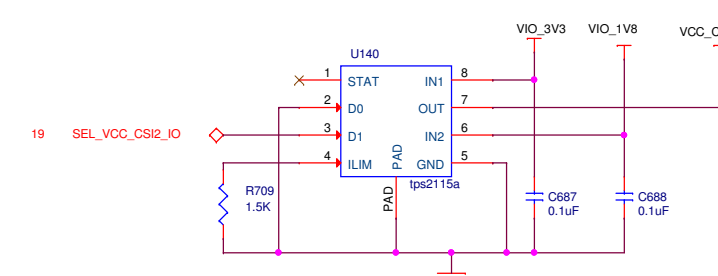
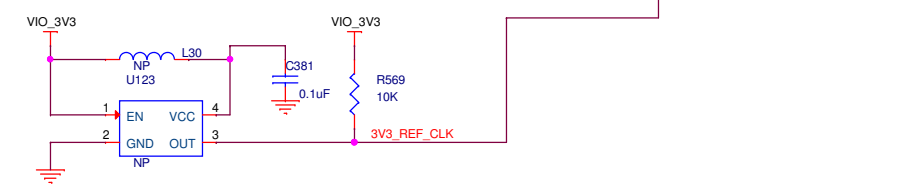
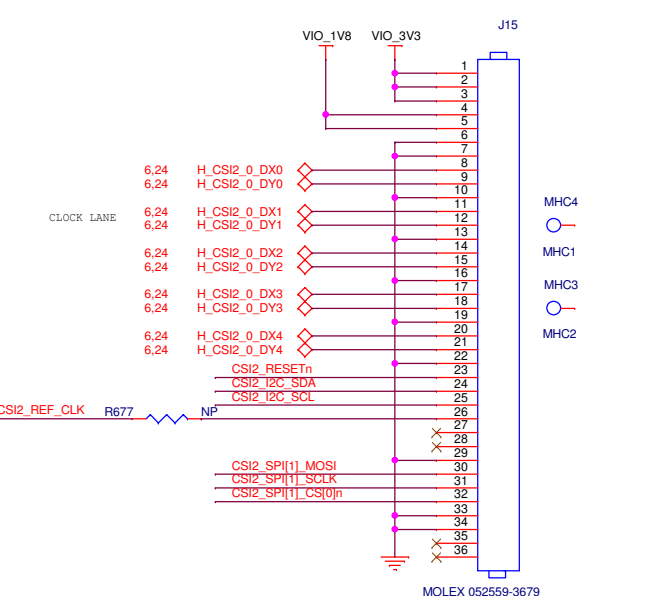
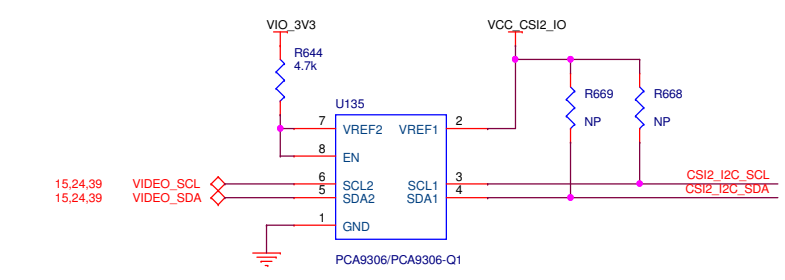
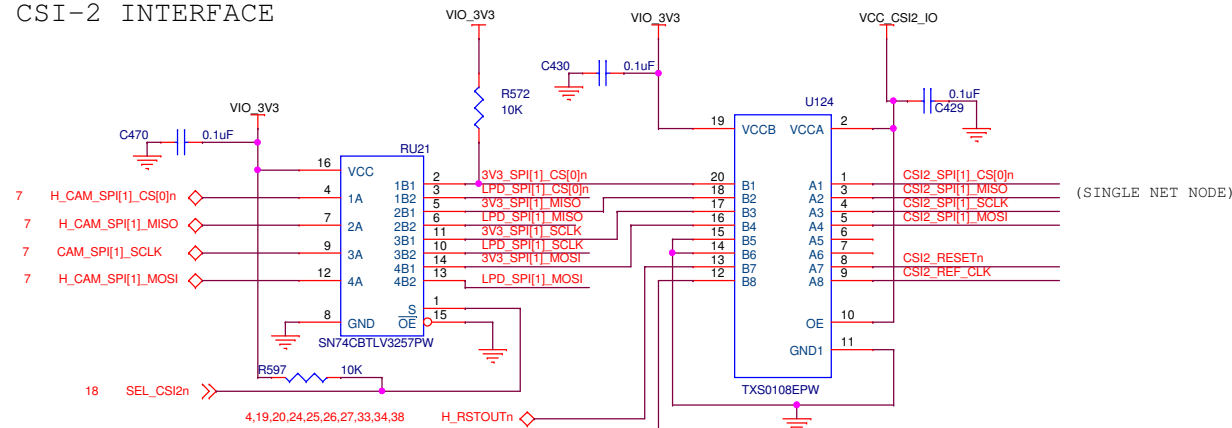
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: HDMI

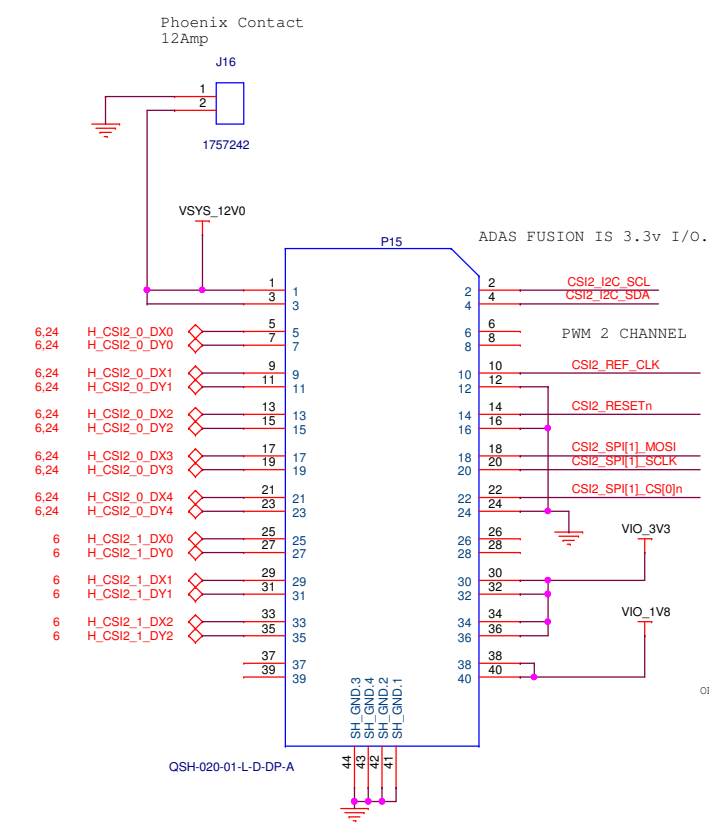
Size: C DOC NO: 518451 REV: A

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CSI-2 INTERFACE



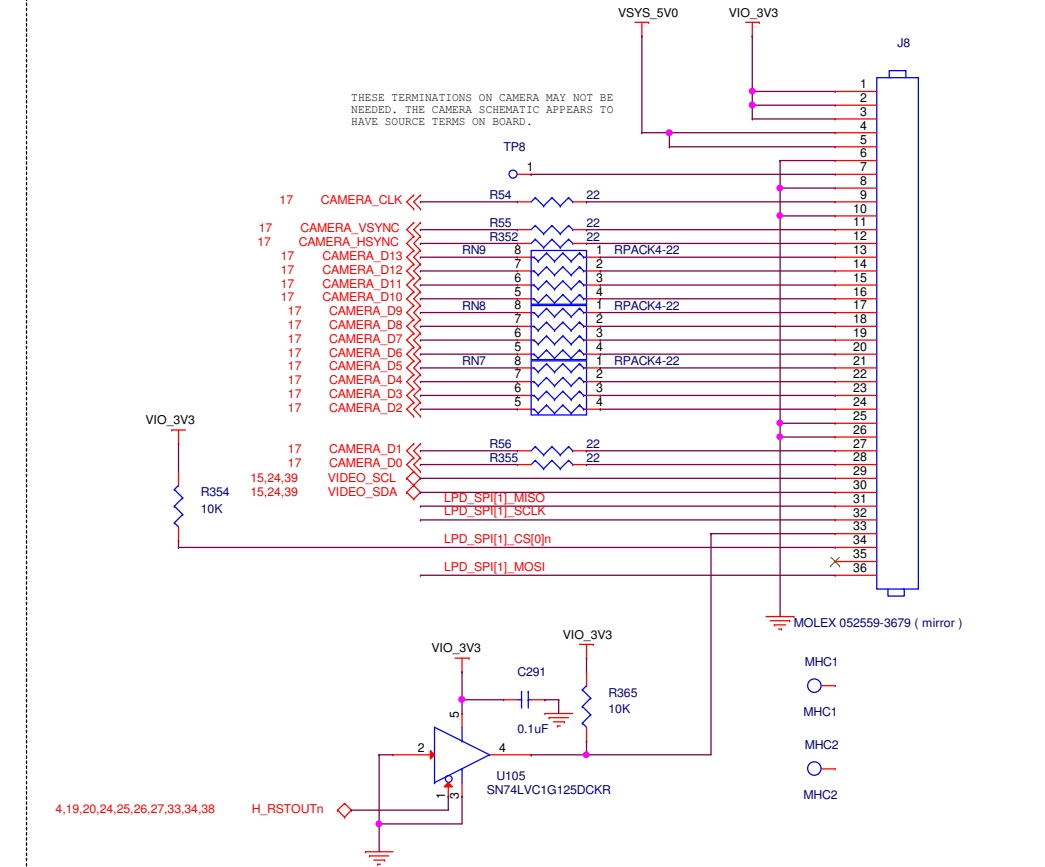
D1=1, IN1 VIO_3V3
 D1=0, IN2 VIO_1V8
 SWITCHES DEFAULT AS PULLUPS. SWITCH CLOSED TO PULL DOWN.
 THE SWITCH SHOULD ONLY BE CHANGED WHILE EVN IS POWERED DOWN.



SPI1_CS0n - GPIO7_10
 SPI1_SCLK - GPIO7_7 (OUTPUT ONLY)
 SPI1_MOSI - GPIO7_9
 SPI1_MISO - GPIO7_8

OPTIONAL

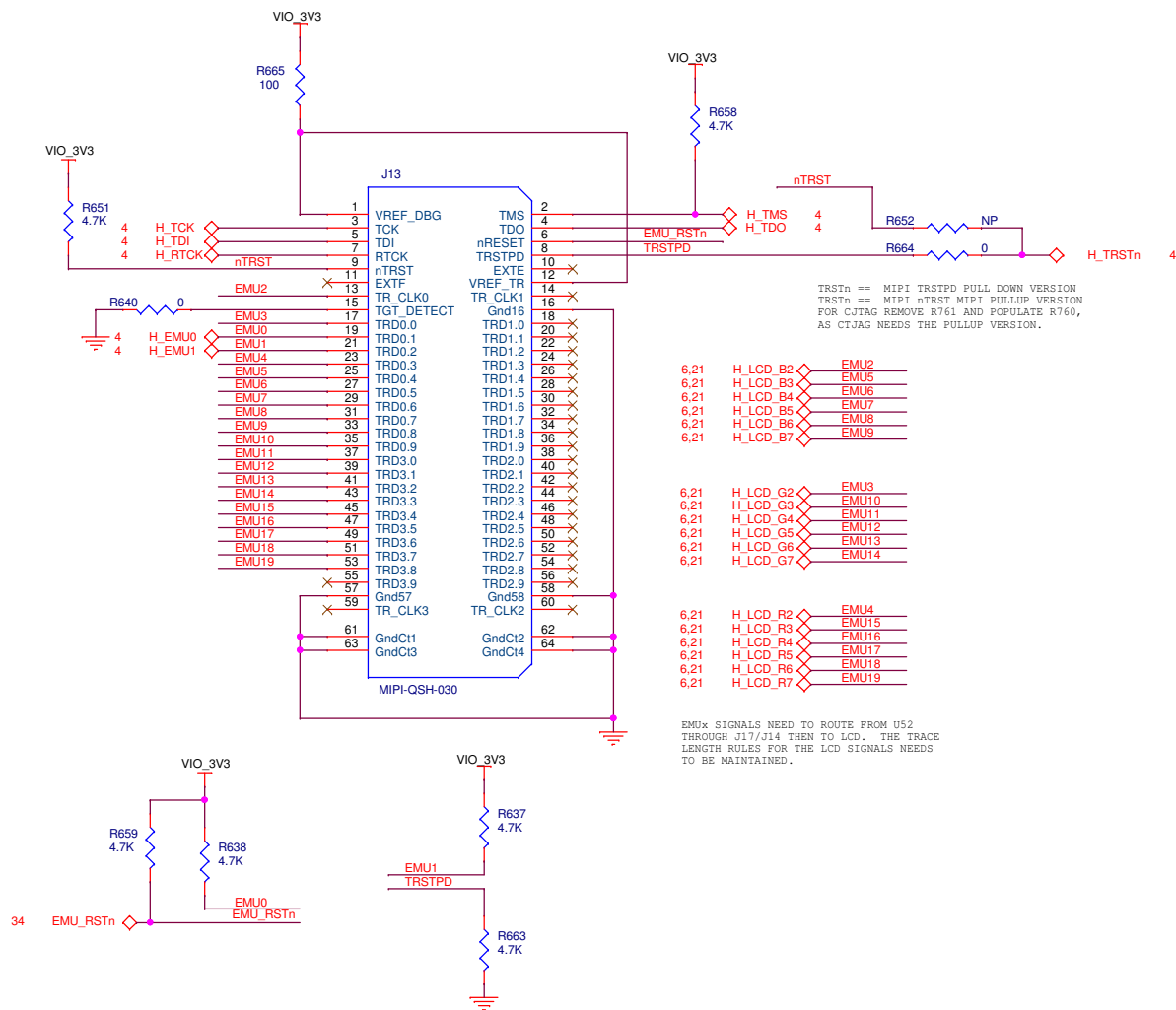
LEOPARD IMAGING INTERFACE



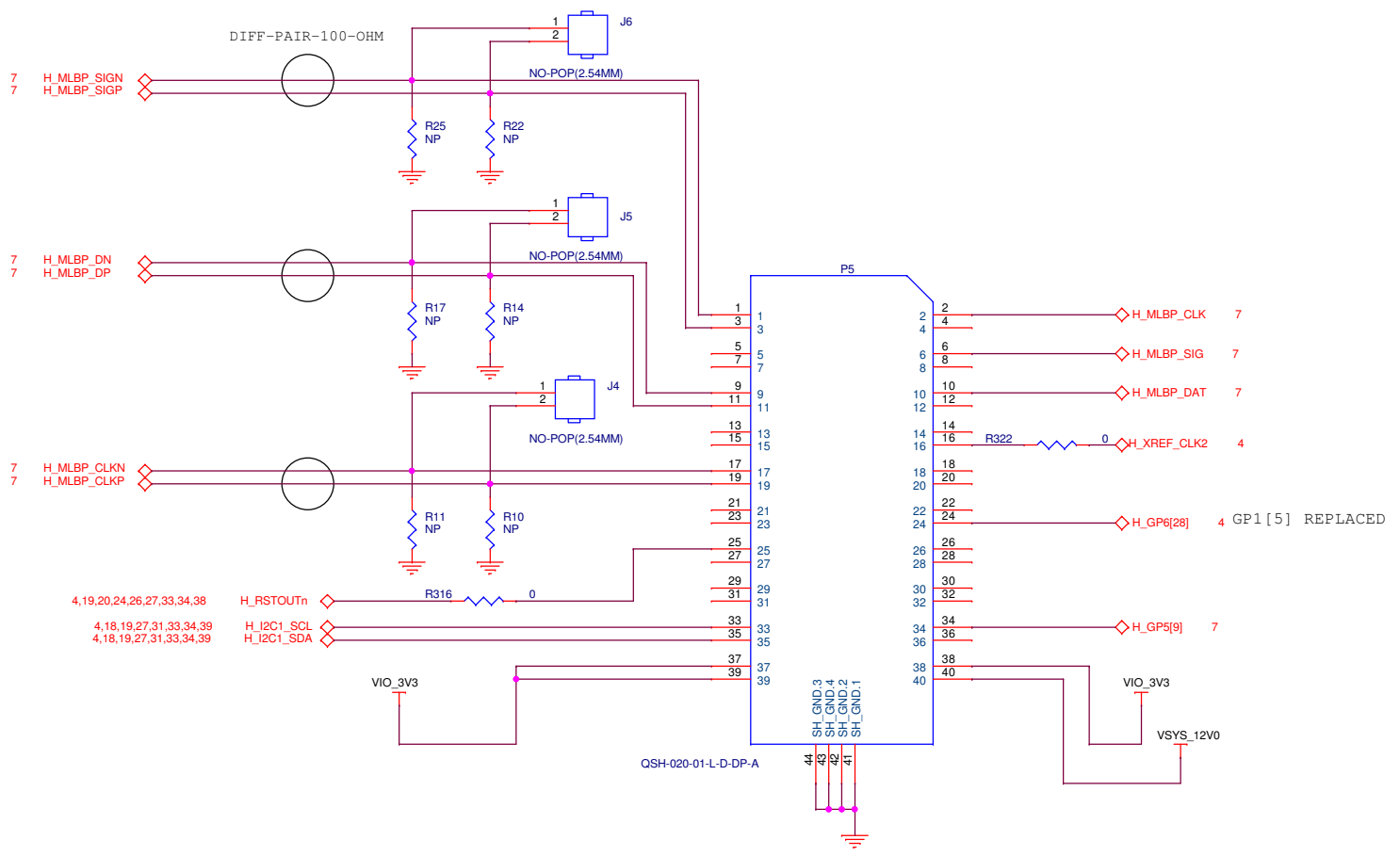
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: CAMERA/CSI2		
Size: C	DOC NO: 518451	REV: C
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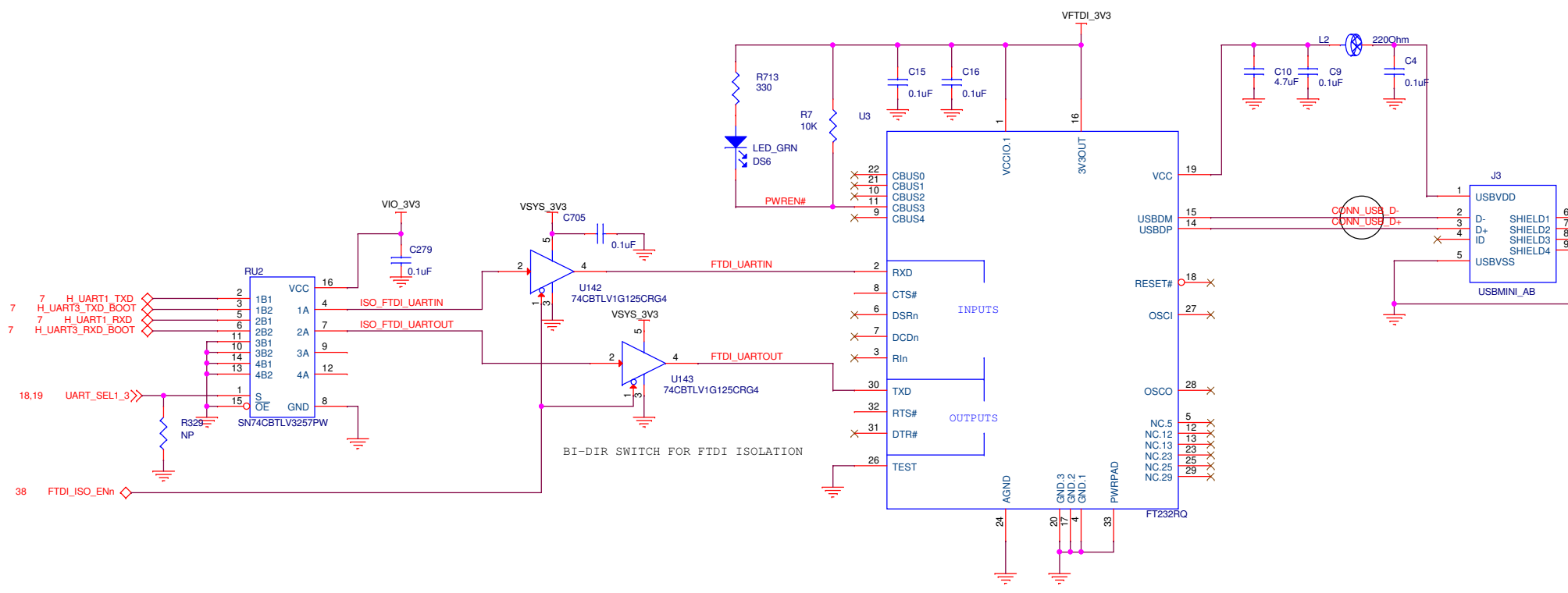
JTAG HEADER



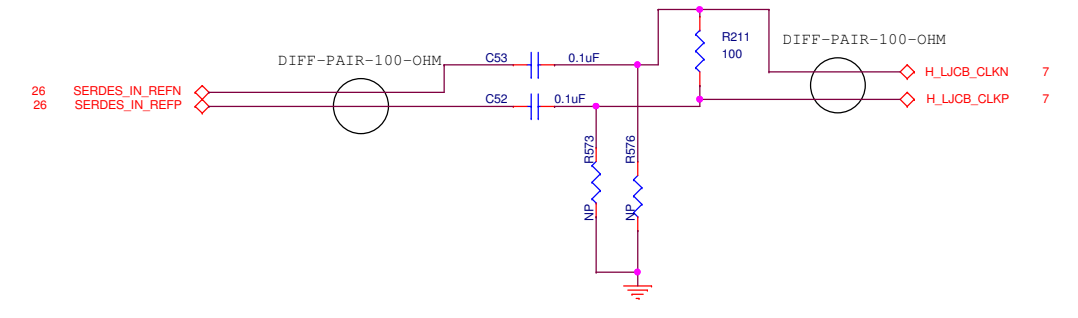
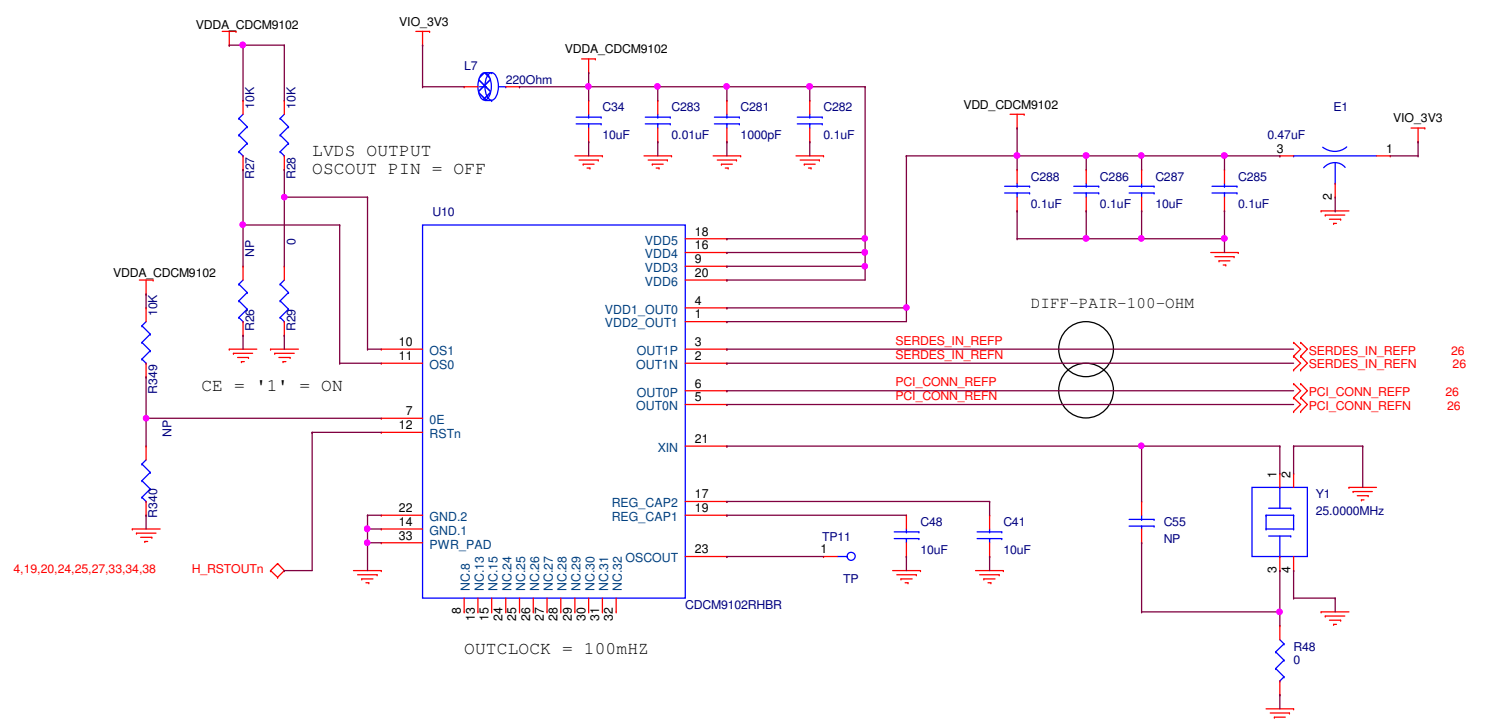
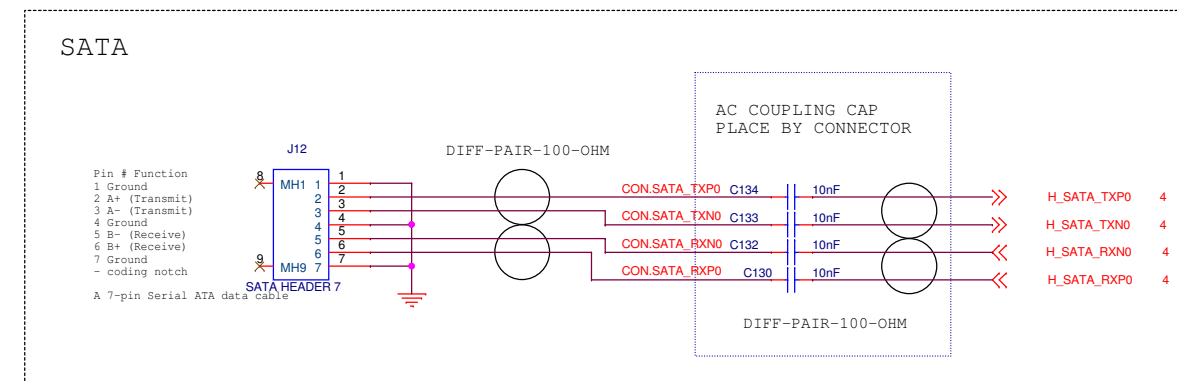
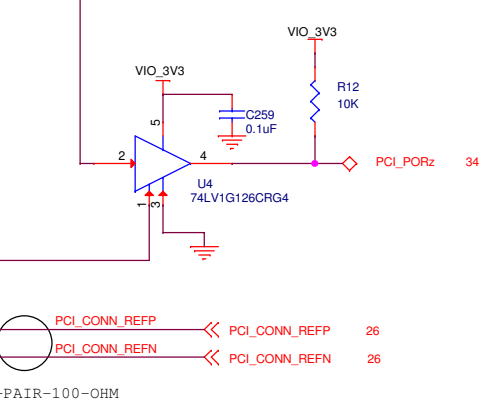
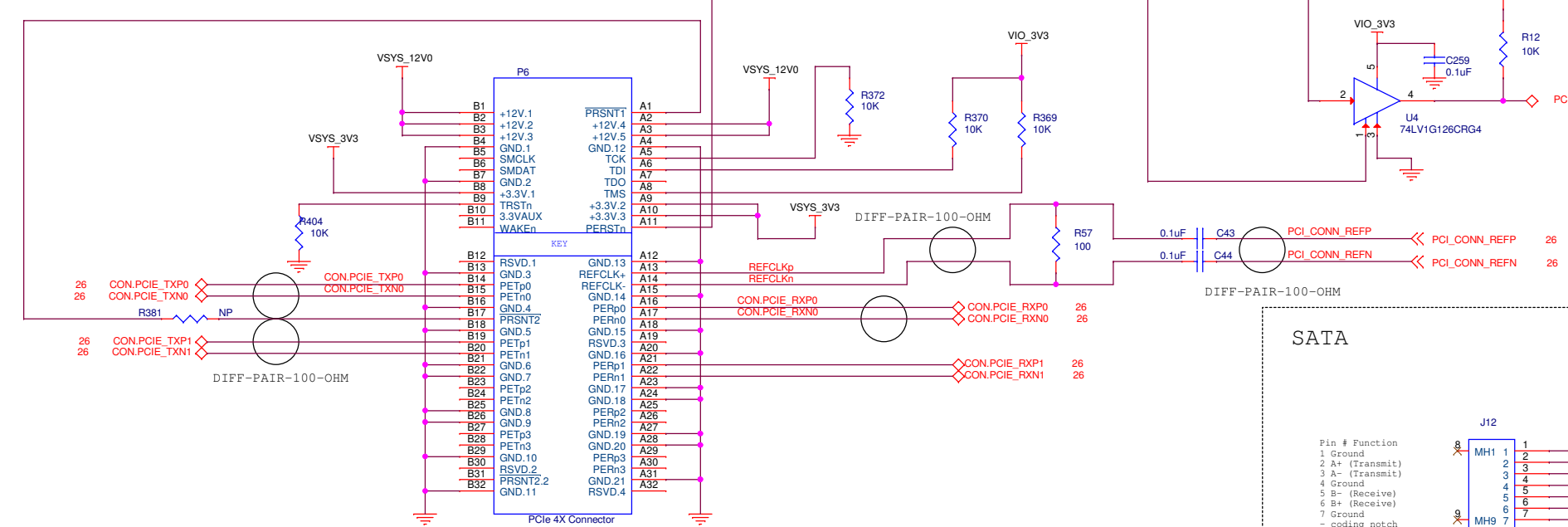
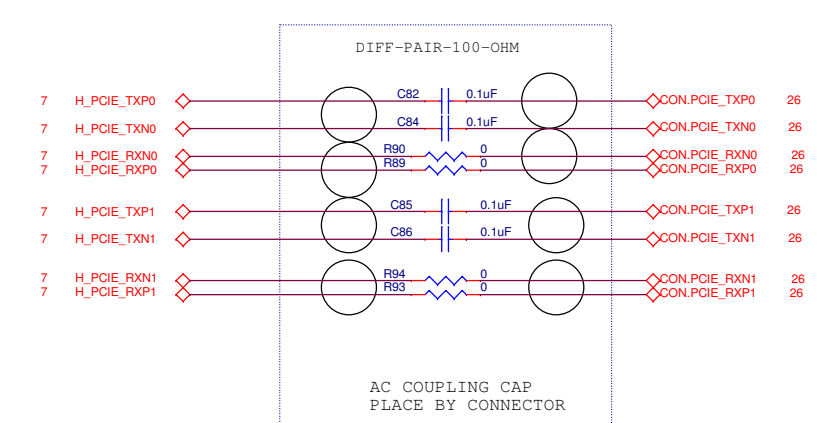
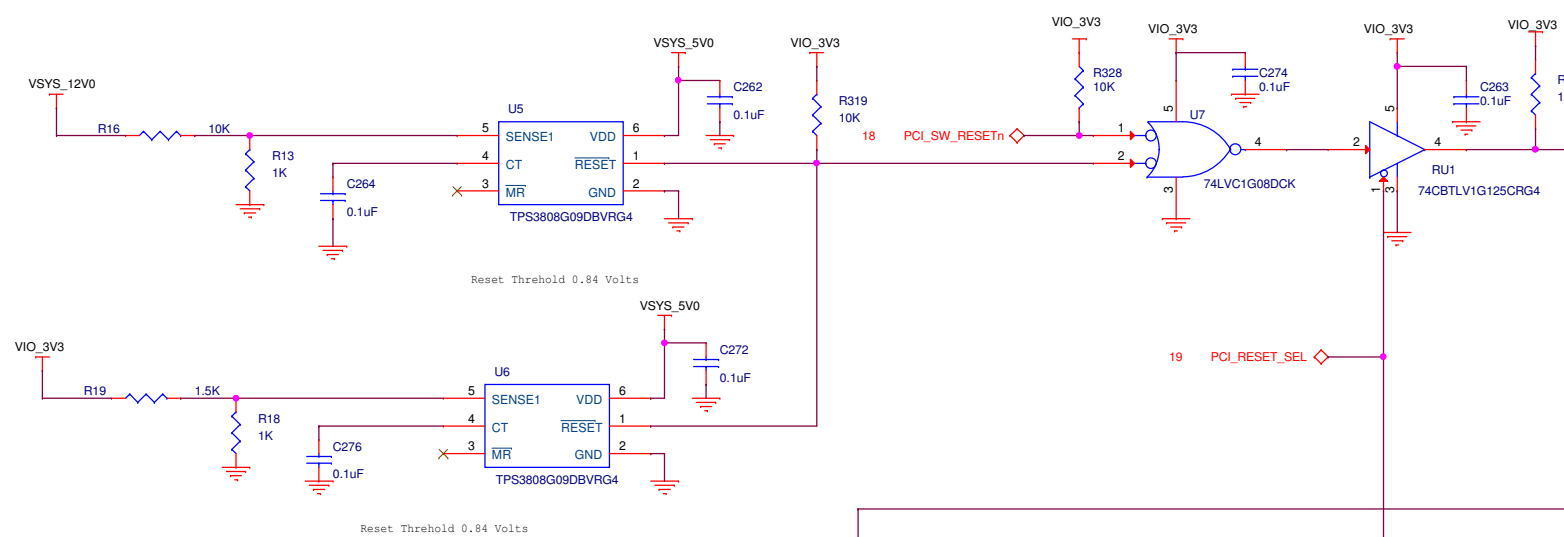
MLB HEADER



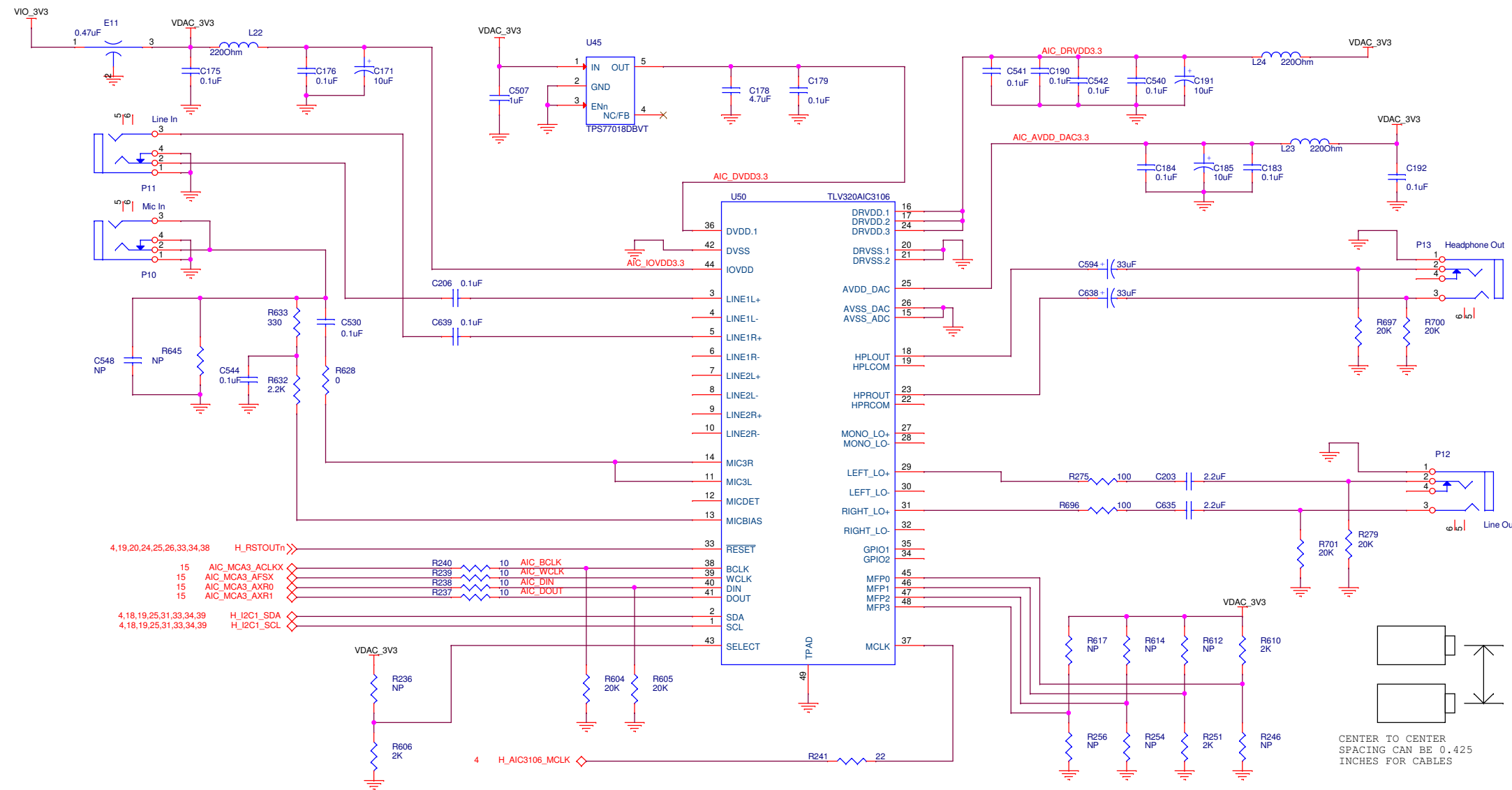
FTDI USB/UART CONSOLE WITH ISOLATION



TEXAS INSTRUMENTS INCORPORATED		
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: JTAG/MLB/FTDI		
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TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: PCIe			
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CENTER TO CENTER SPACING CAN BE 0.425 INCHES FOR CABLES

TEXAS INSTRUMENTS INCORPORATED

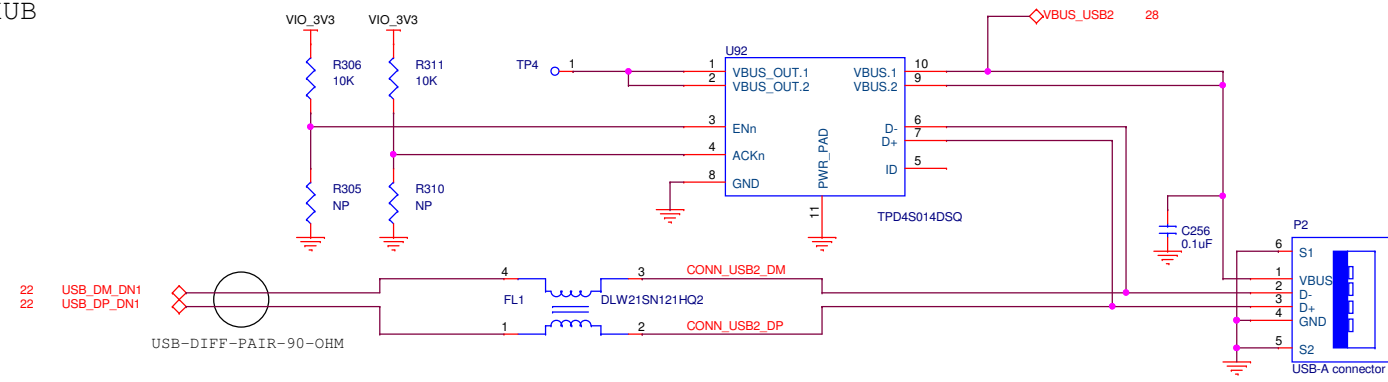
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: AIC3106

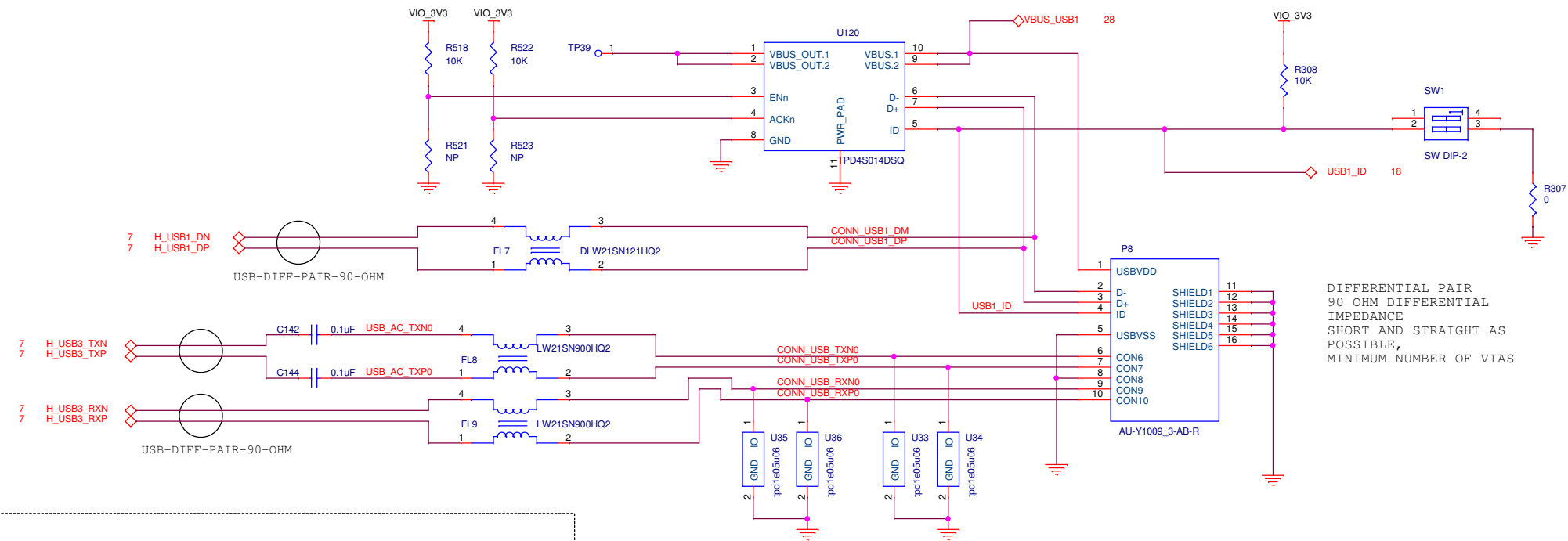
Size: C DOC NO: 518451 REV: A

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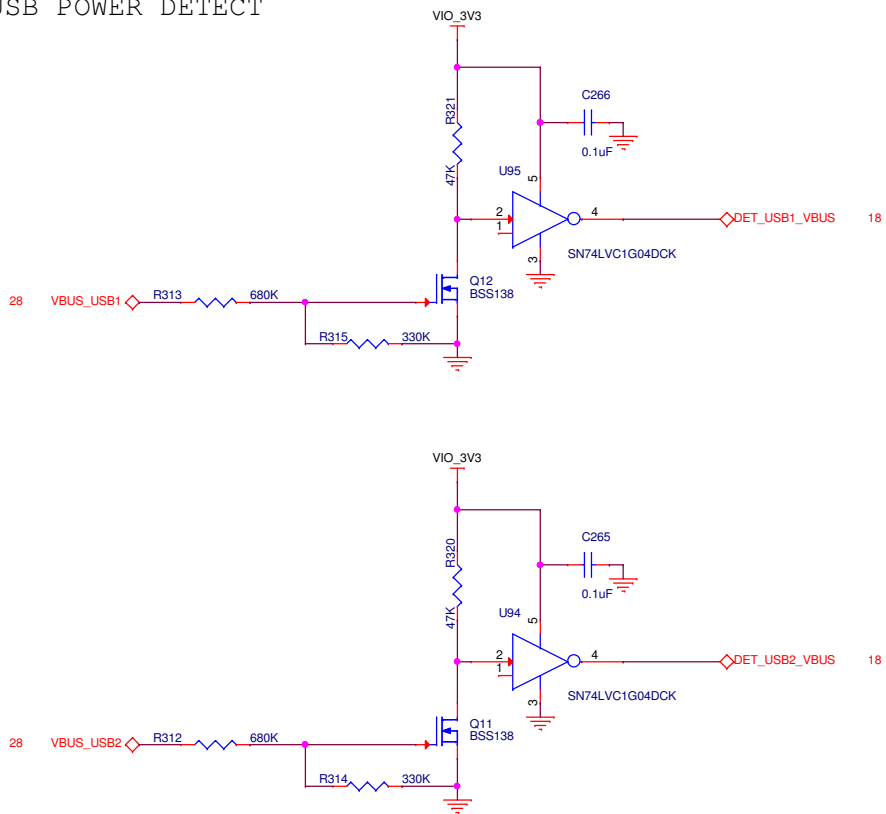
USB HS HOST PORT BEHIND HUB



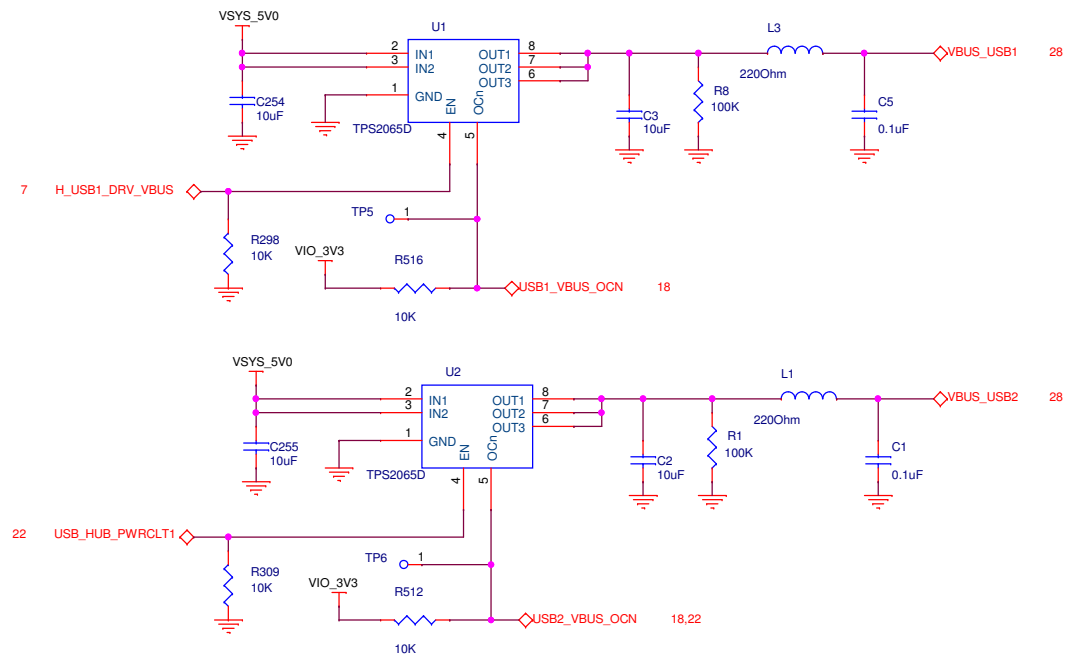
USB HS/SS OTG PORT



USB POWER DETECT



USB POWER SWITCH



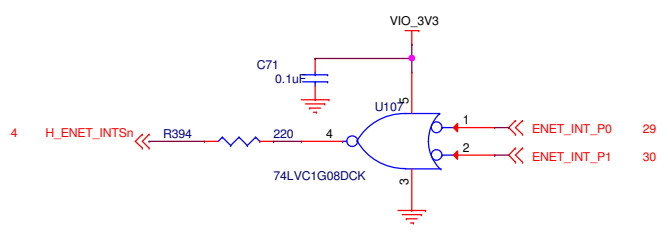
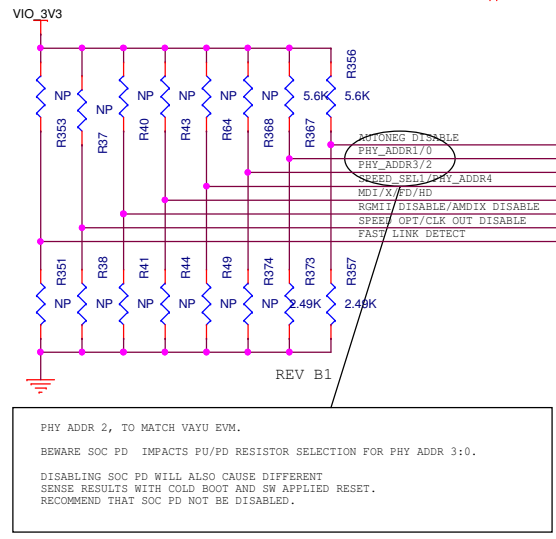
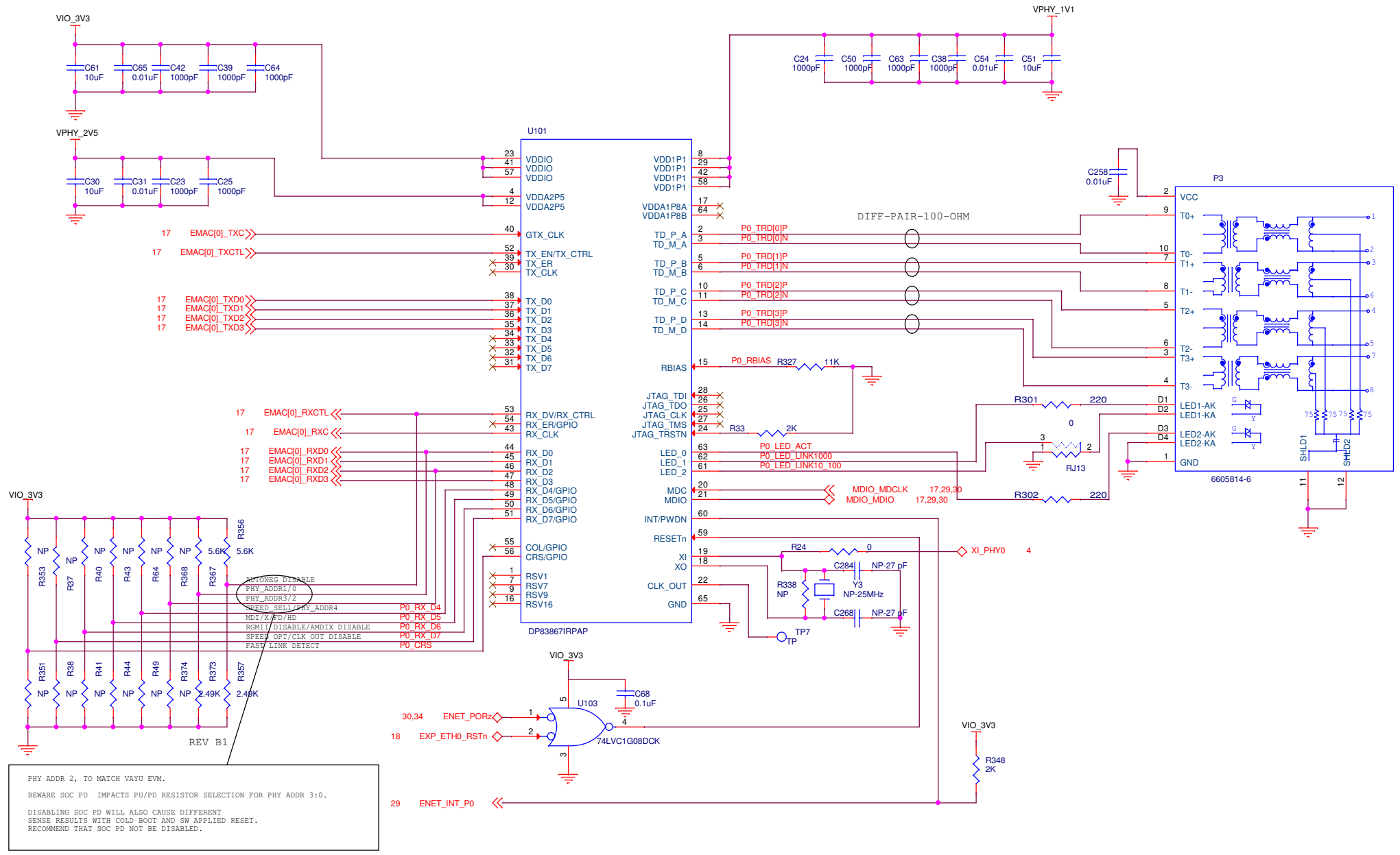
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

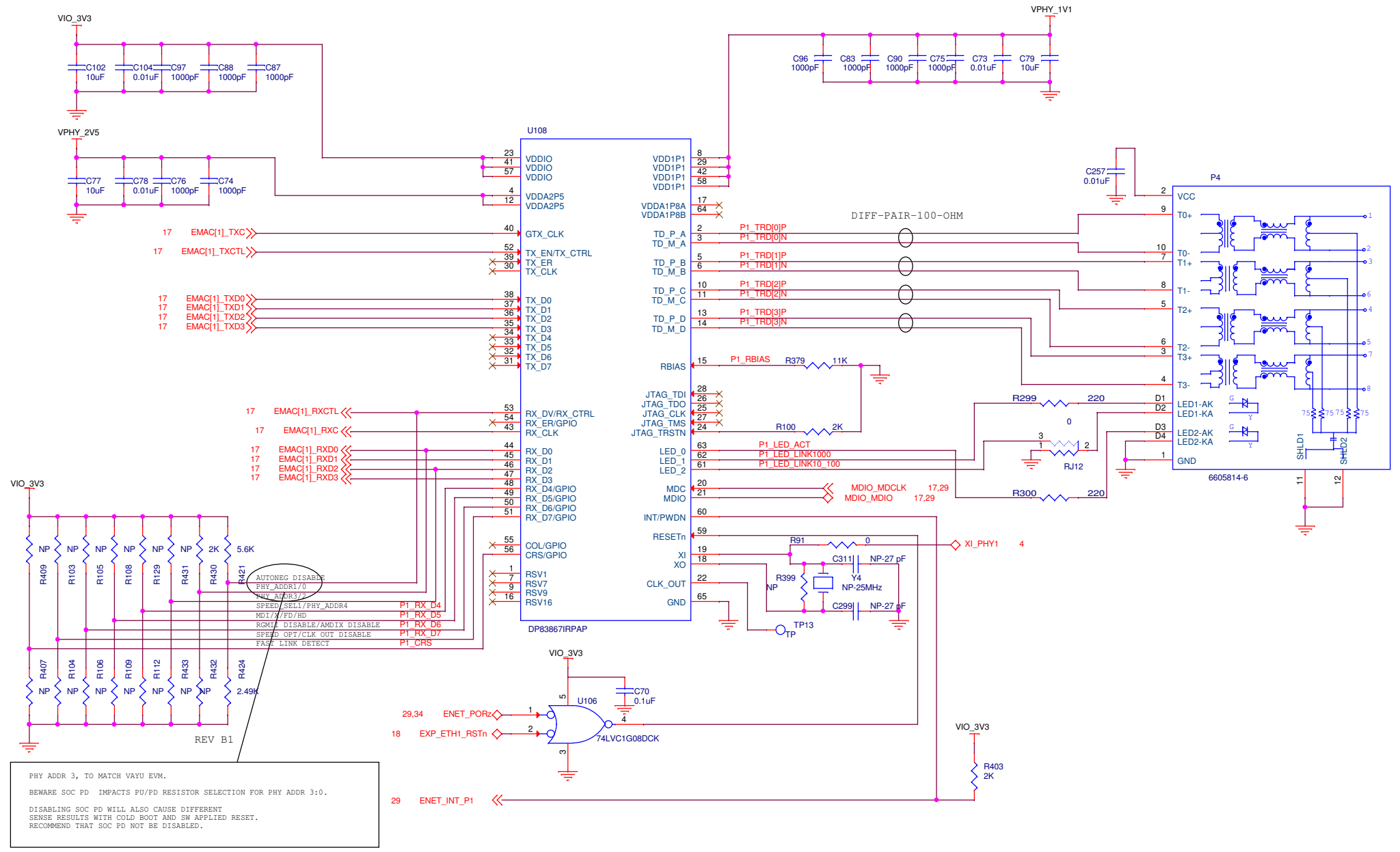
Page Contents: USB

Size: C DOC NO: 518451 REV: B

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TEXAS INSTRUMENTS INCORPORATED		
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: ENET PORT0		
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PHY ADDR 3, TO MATCH VAYU EVM.
 BEWARE SOC PD IMPACTS PU/PD RESISTOR SELECTION FOR PHY ADDR 3:0.
 DISABLING SOC PD WILL ALSO CAUSE DIFFERENT SENSE RESULTS WITH COLD BOOT AND SW APPLIED RESET. RECOMMEND THAT SOC PD NOT BE DISABLED.

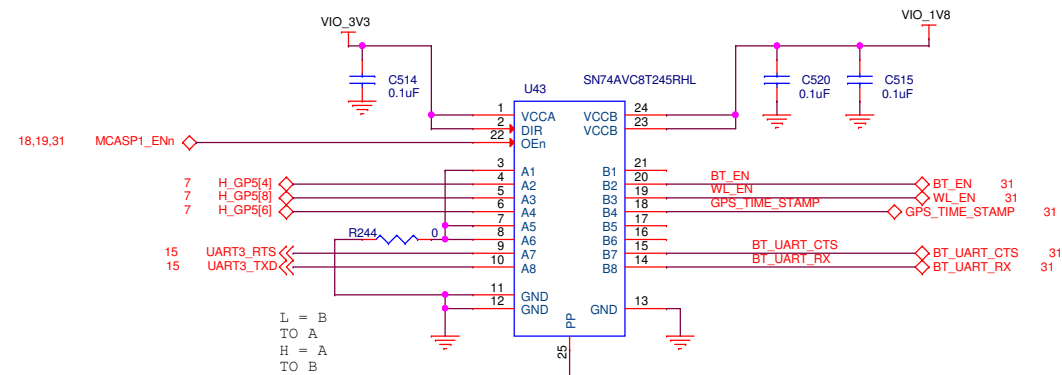
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

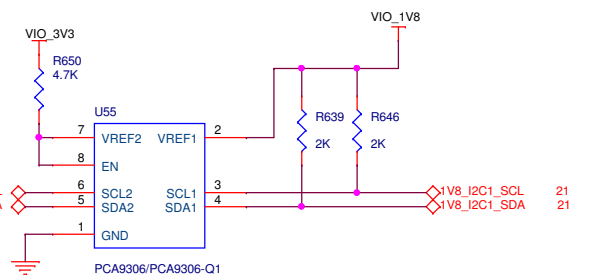
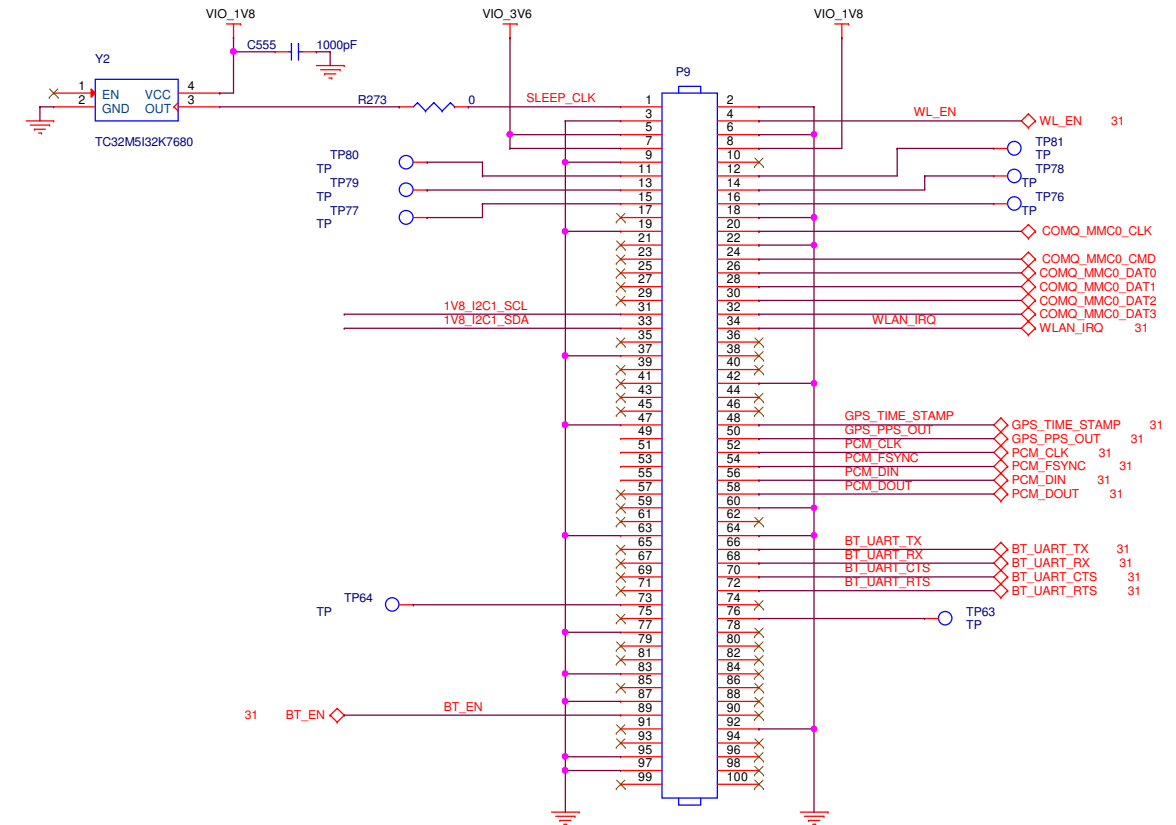
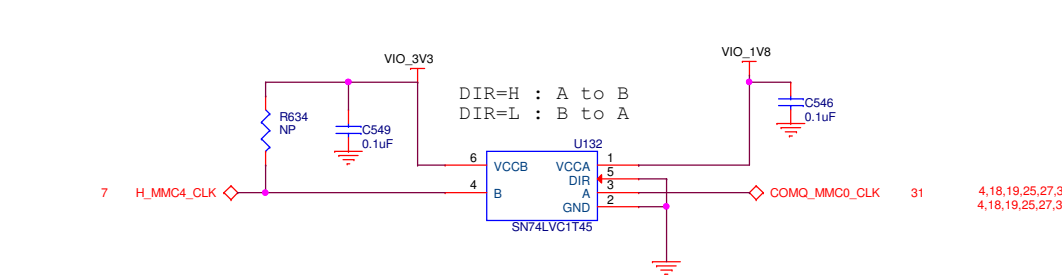
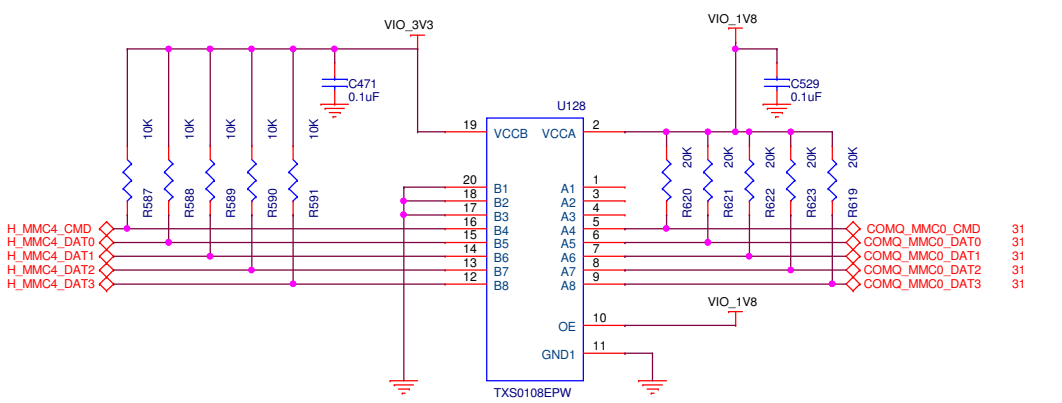
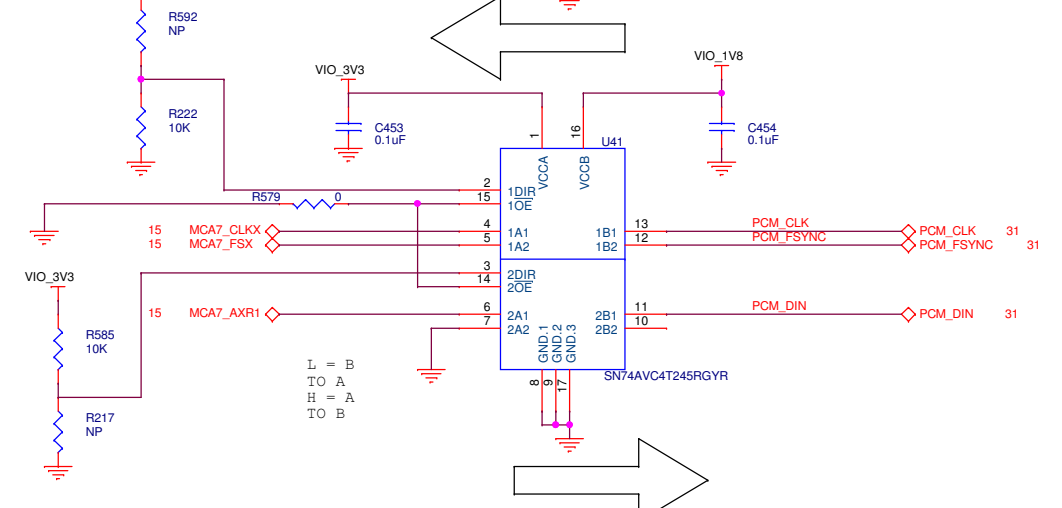
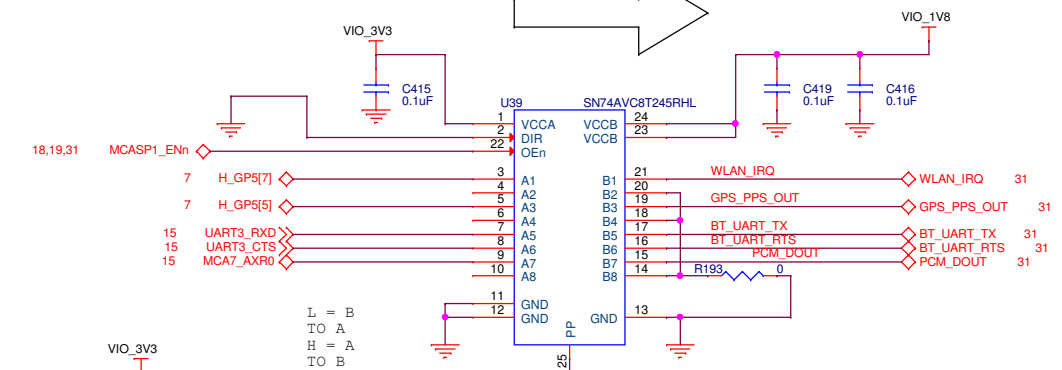
Page Contents: ENET PORT1

Size: C DOC NO: 518451 REV: B1

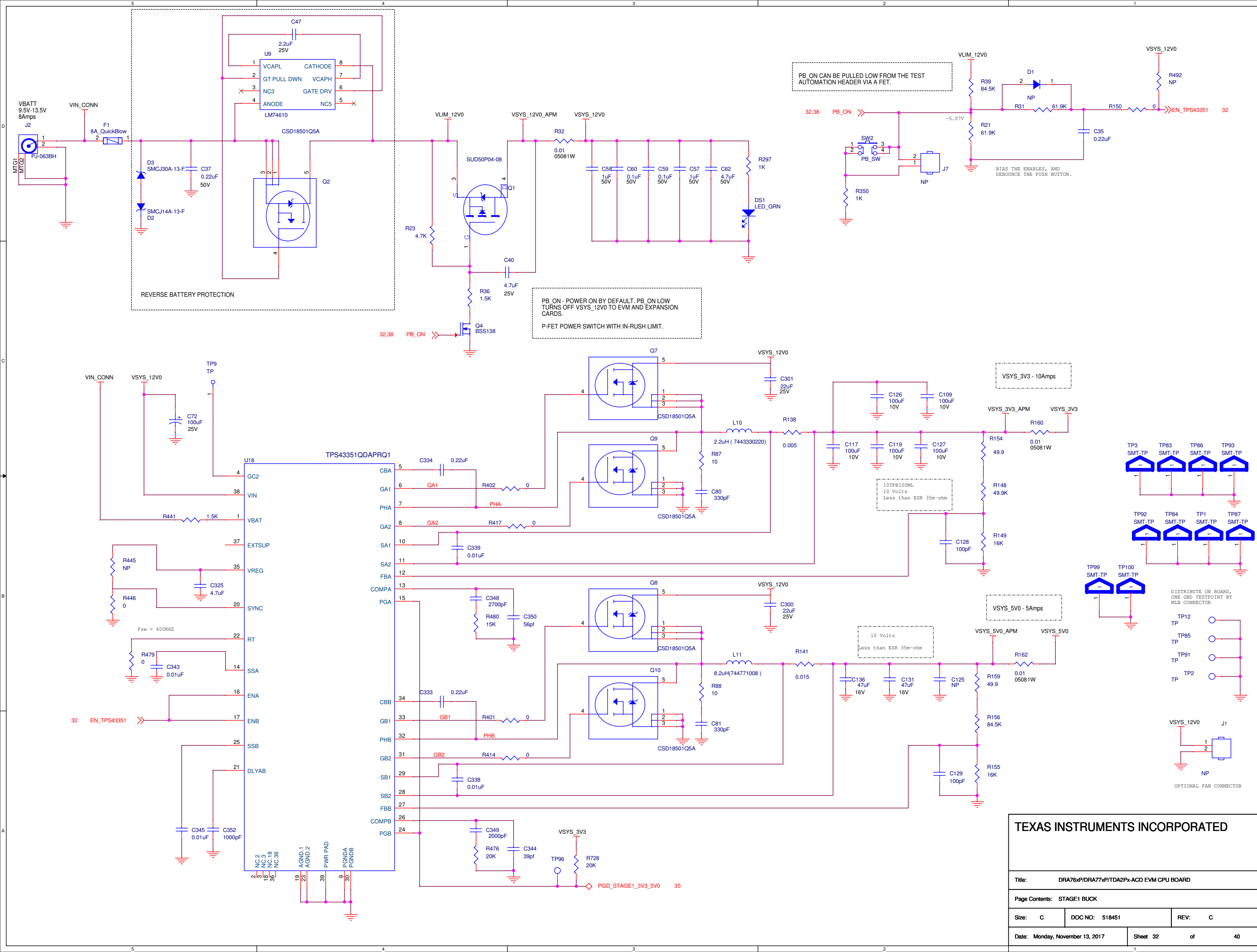
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DELTA VAYU H, VCCB SIDE OF BUFFER TIED DIRECTLY TO VIO_1V8. COM8 INTERFACE IS ALWAYS 1.8V.



TEXAS INSTRUMENTS INCORPORATED			
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD			
Page Contents: COMQ8			
Size: C	DOC NO: 518451	REV: B	
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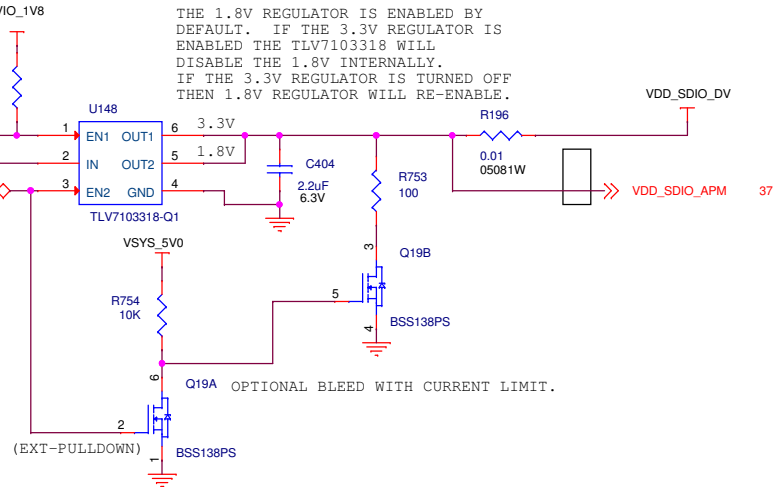
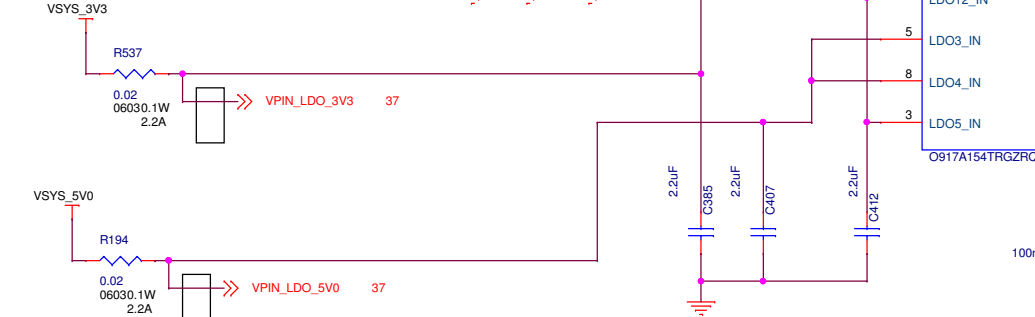
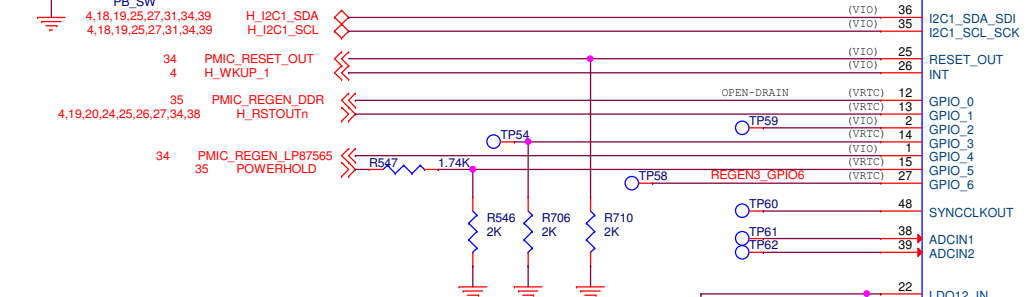
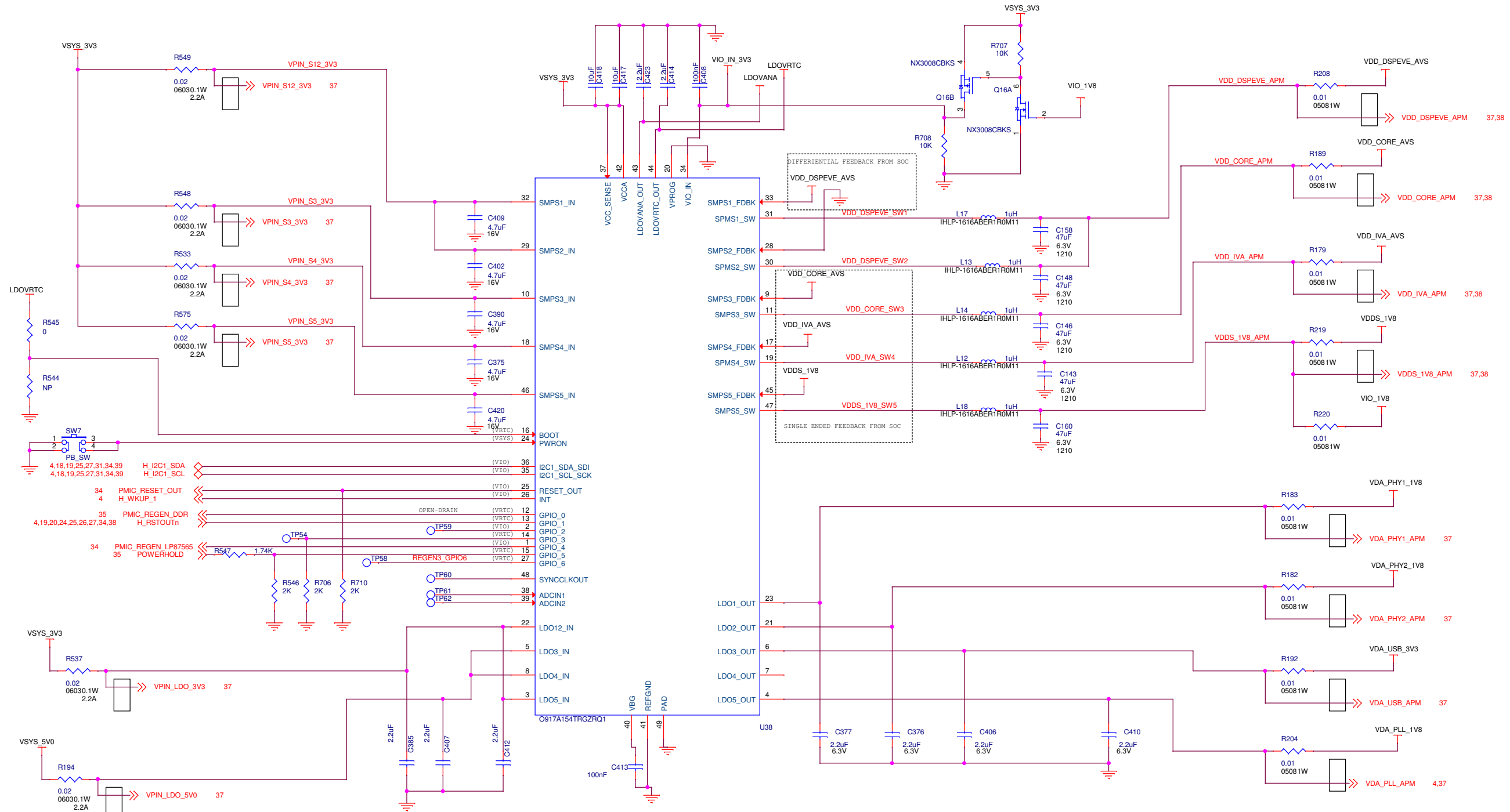
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: STAGE1 BUCK

Size: C DOC NO: 518451 REV: C

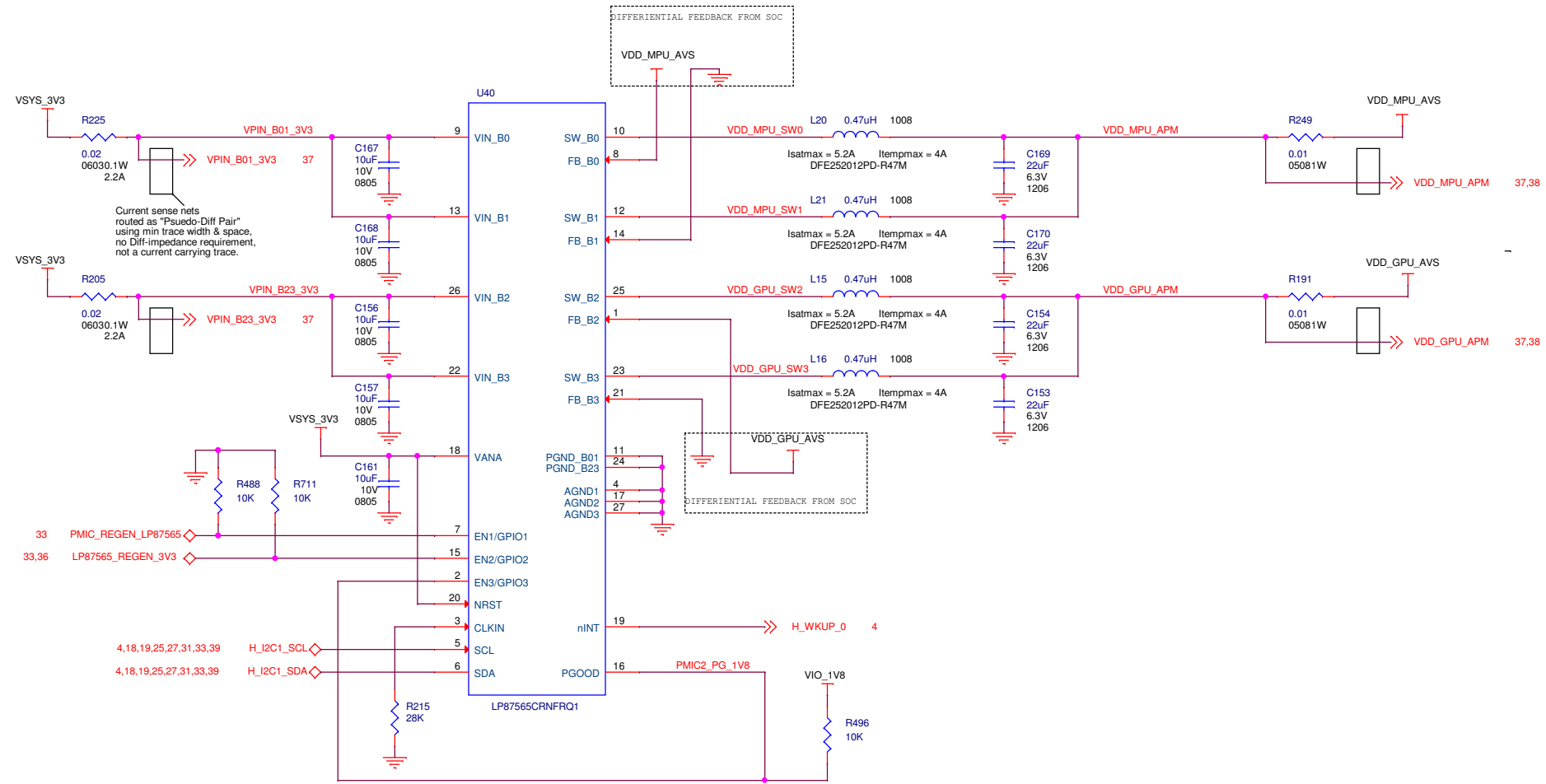
Date: Monday, November 13, 2017 Sheet 32 of 40



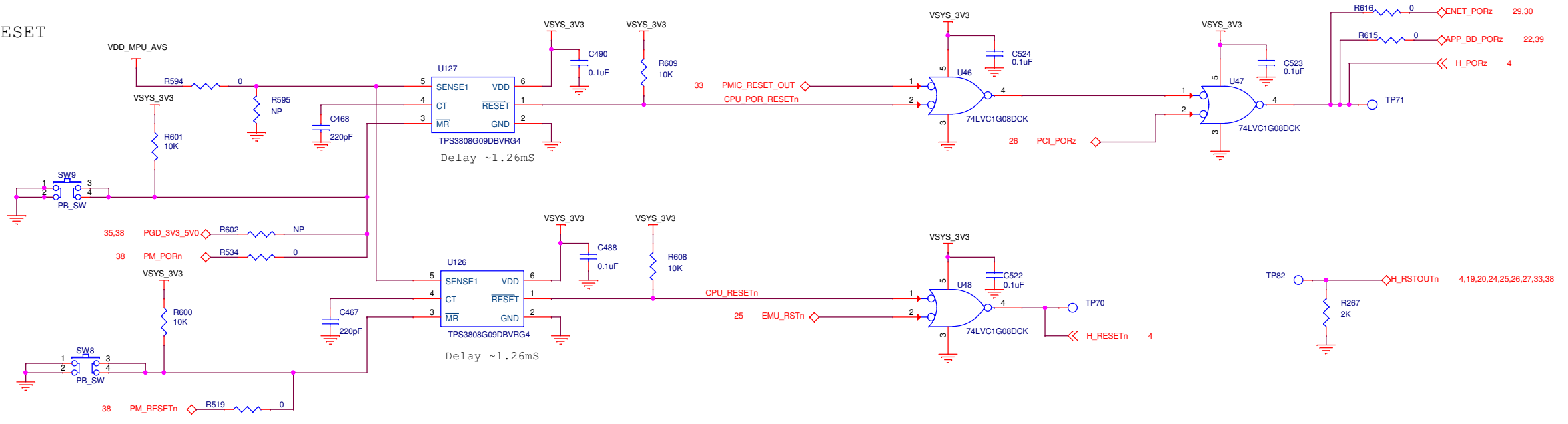
THE 1.8V REGULATOR IS ENABLED BY DEFAULT. IF THE 3.3V REGULATOR IS ENABLED THE TLV7103318 WILL DISABLE THE 1.8V INTERNALLY. IF THE 3.3V REGULATOR IS TURNED OFF THEN 1.8V REGULATOR WILL RE-ENABLE.

TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: STAGE2 TPS65917		
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RESET



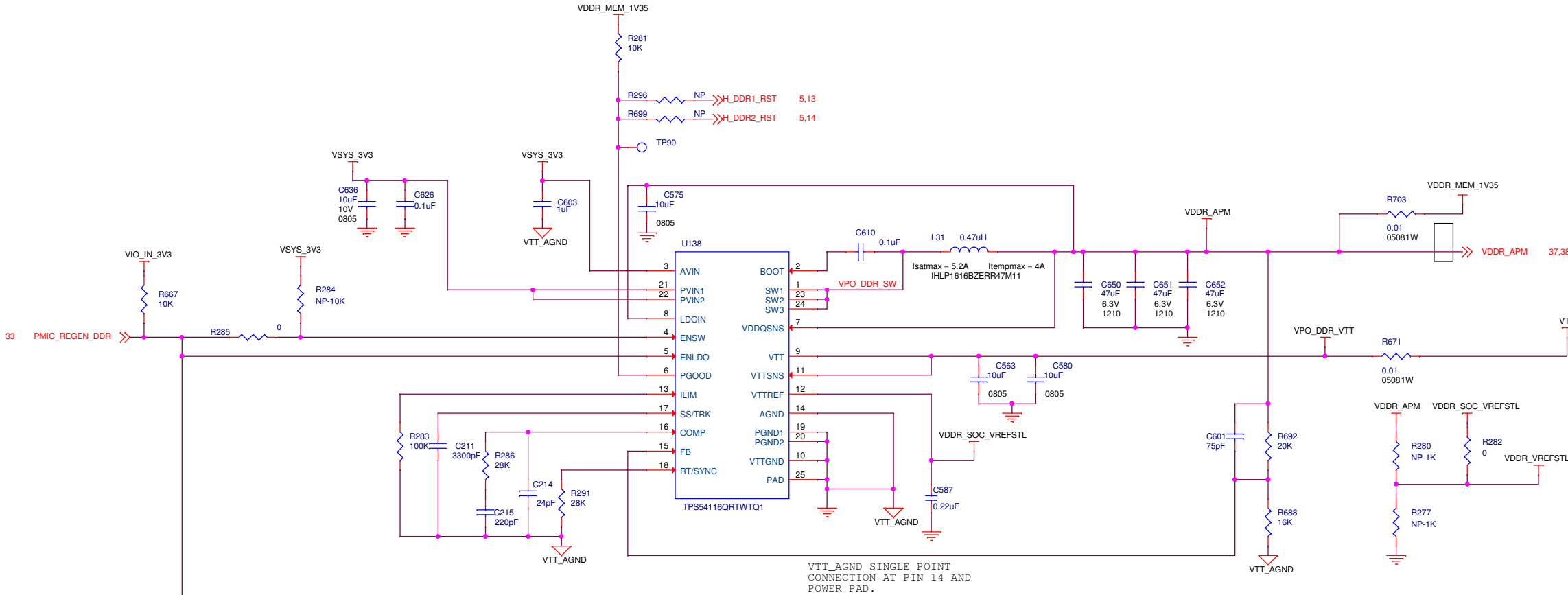
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

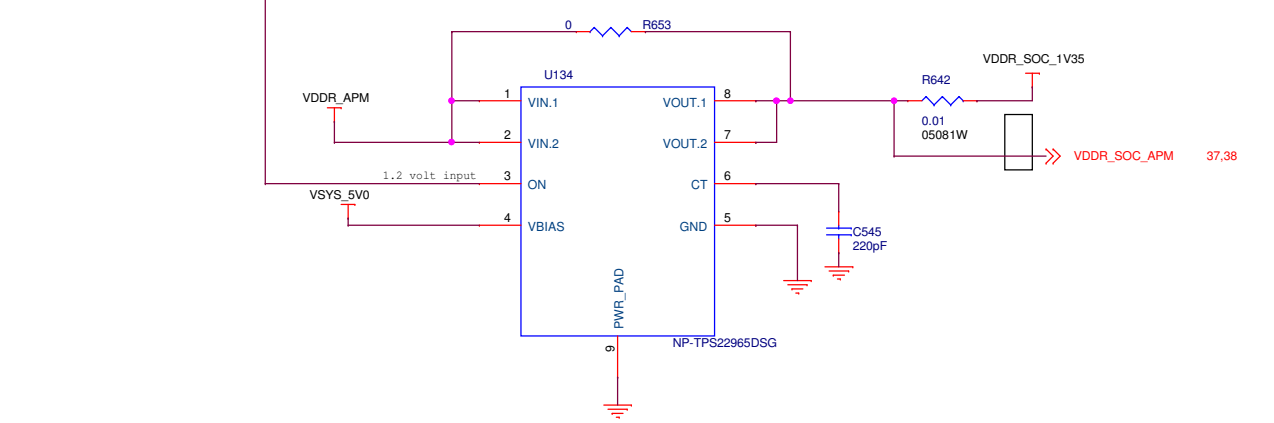
Page Contents: STAGE2 LP87565

Size: C DOC NO: 518451 REV: C

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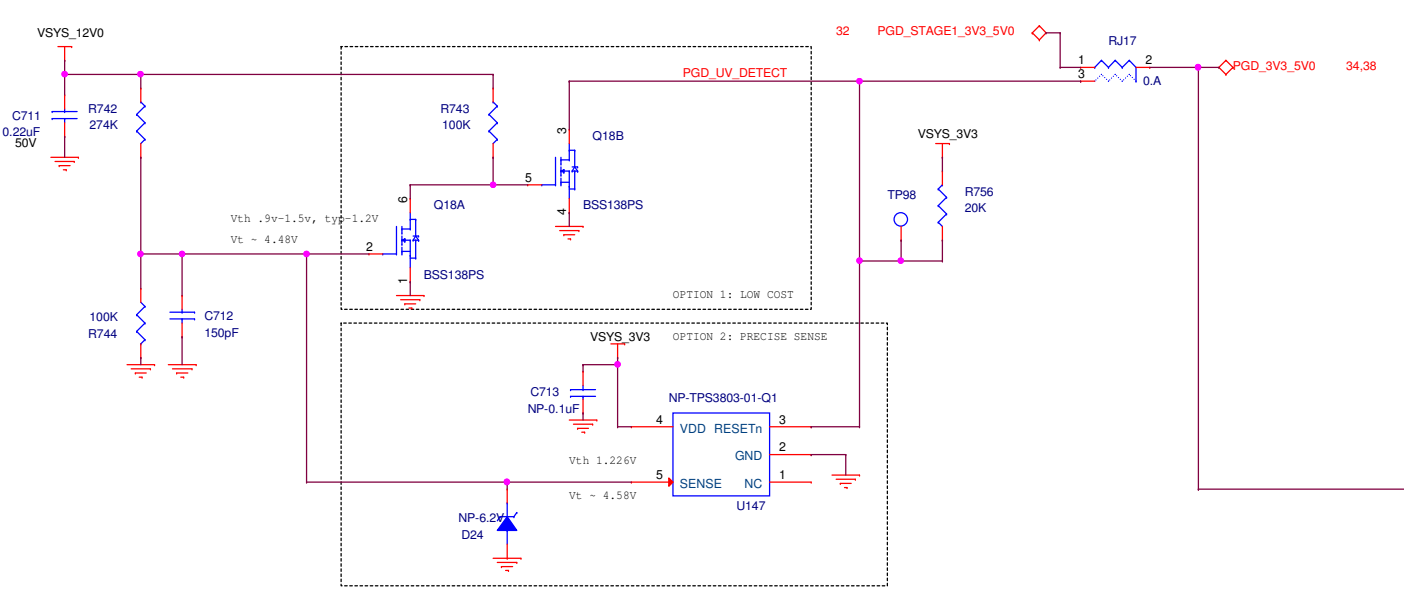
VTT_AGND SINGLE POINT CONNECTION AT PIN 14 AND POWER PAD.



POPULATIONS FOR SUSPEND TO RAM

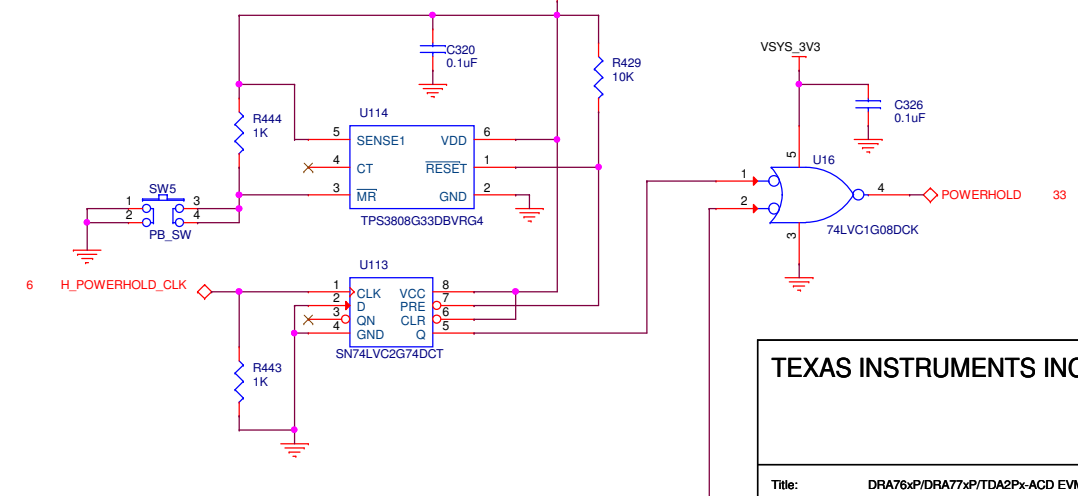
	DEFAULT	SUSPEND TO RAM
R653	POP	NO-POP
U134	NO-POP	POP
R285	POP	NO-POP
R284	NO-POP	POP
R282	POP	NO-POP
R277	NO-POP	POP
R280	NO-POP	POP

UNDERVOLTAGE DETECT - 2 OPTIONS



SELECT STAGE1 BUCK POWER GOOD OR INDEPENDENT UNDER VOLTAGE DETECTION CIRCUIT TO ENABLE STAGE2 BUCKS.

POWER HOLD



TEXAS INSTRUMENTS INCORPORATED

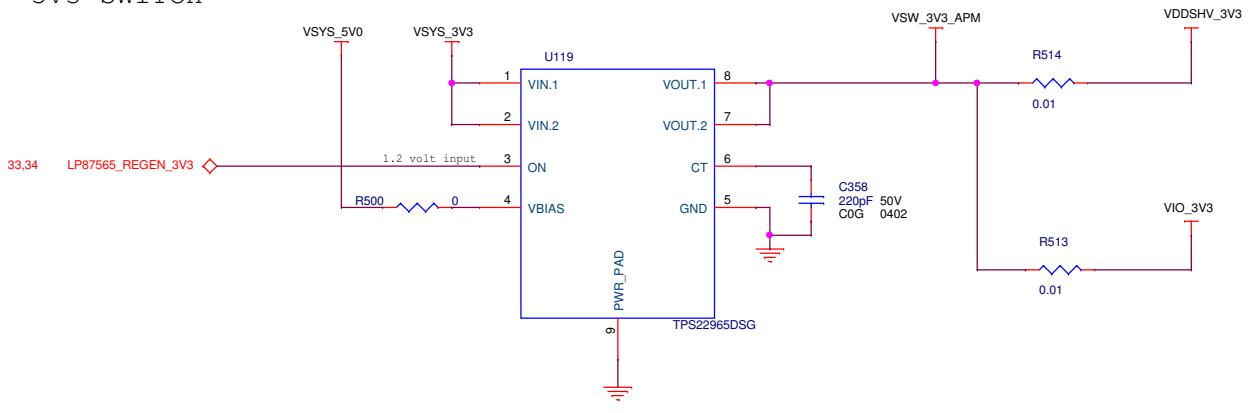
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

Page Contents: STAGE2 TPS54116

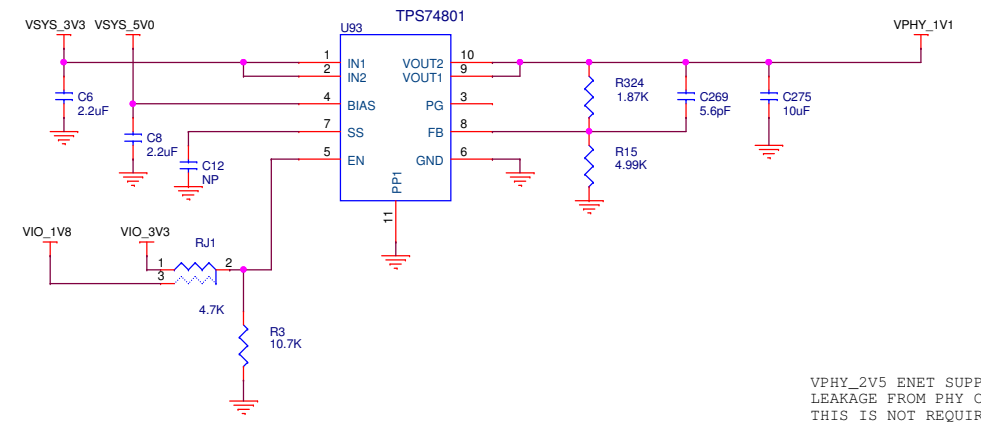
Size: C DOC NO: 518451 REV: C

Date: Monday, November 13, 2017 Sheet 35 of 40

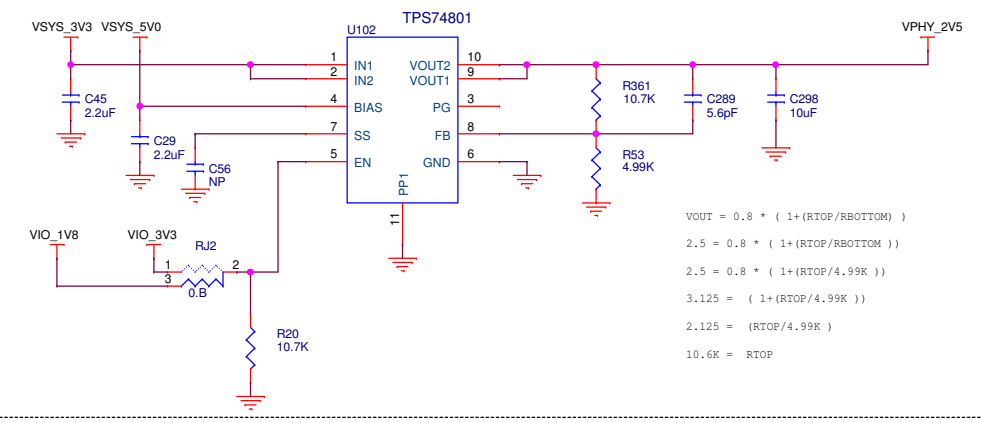
3V3 SWITCH



ETHERNET 2.5V/1.1V



VPHY_2V5 ENET SUPPLY TURNS ON WITH VIO_1V8 TO PREVENT LEAKAGE FROM PHY CLK IN TO VPHY_2V5. RAIL. THIS IS NOT REQUIRED IF USING A CRYSTAL ON THE ENET PHY.



$$V_{OUT} = 0.8 * (1 + (R_{TOP}/R_{BOTTOM}))$$

$$2.5 = 0.8 * (1 + (R_{TOP}/R_{BOTTOM}))$$

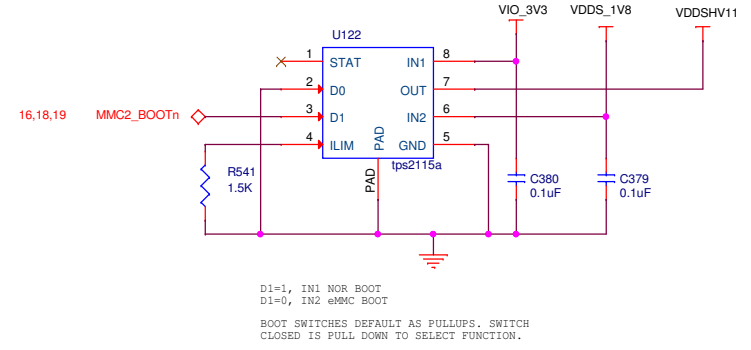
$$2.5 = 0.8 * (1 + (R_{TOP}/4.99K))$$

$$3.125 = (1 + (R_{TOP}/4.99K))$$

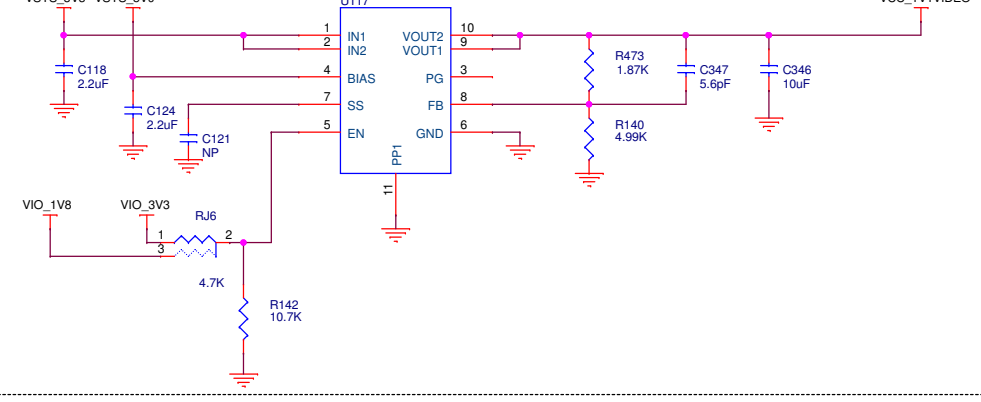
$$2.125 = (R_{TOP}/4.99K)$$

$$10.6K = R_{TOP}$$

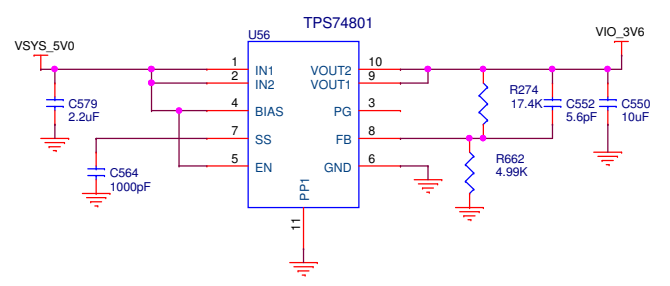
VDDSHV11 3.3V/1.8V MUX

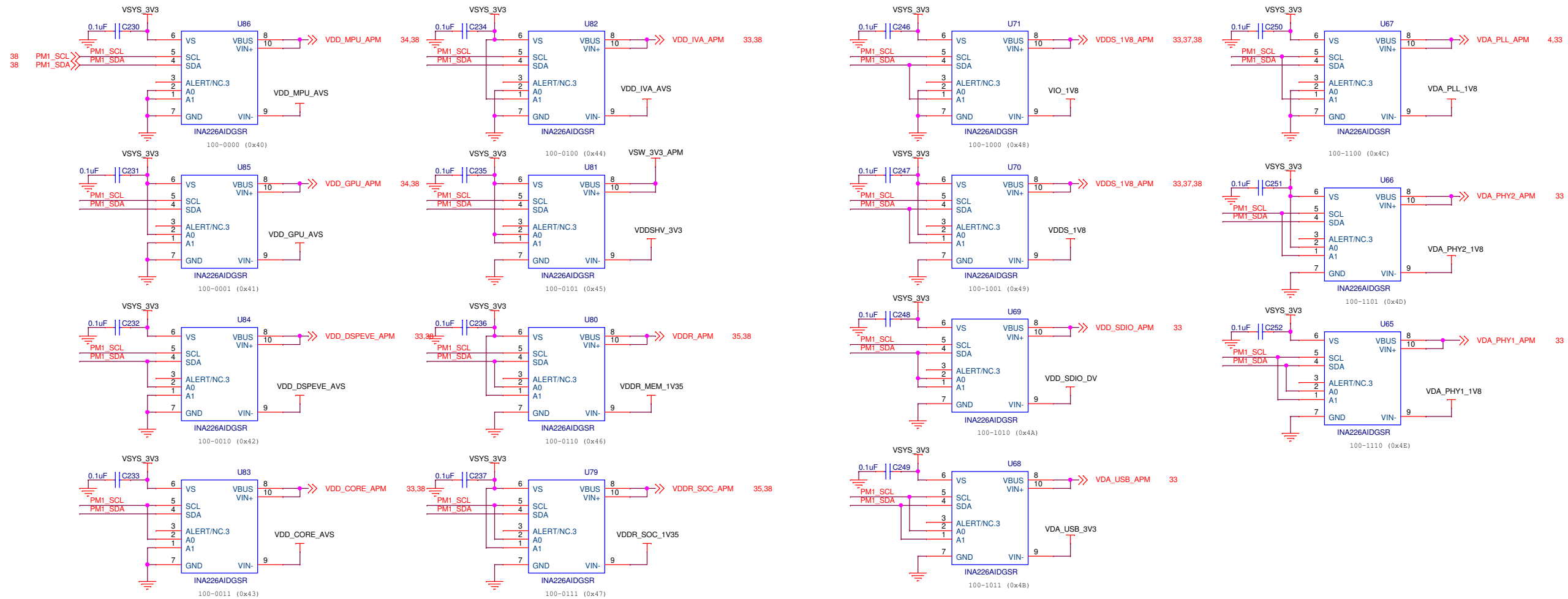


VIDEO/USB HUB 1.1V



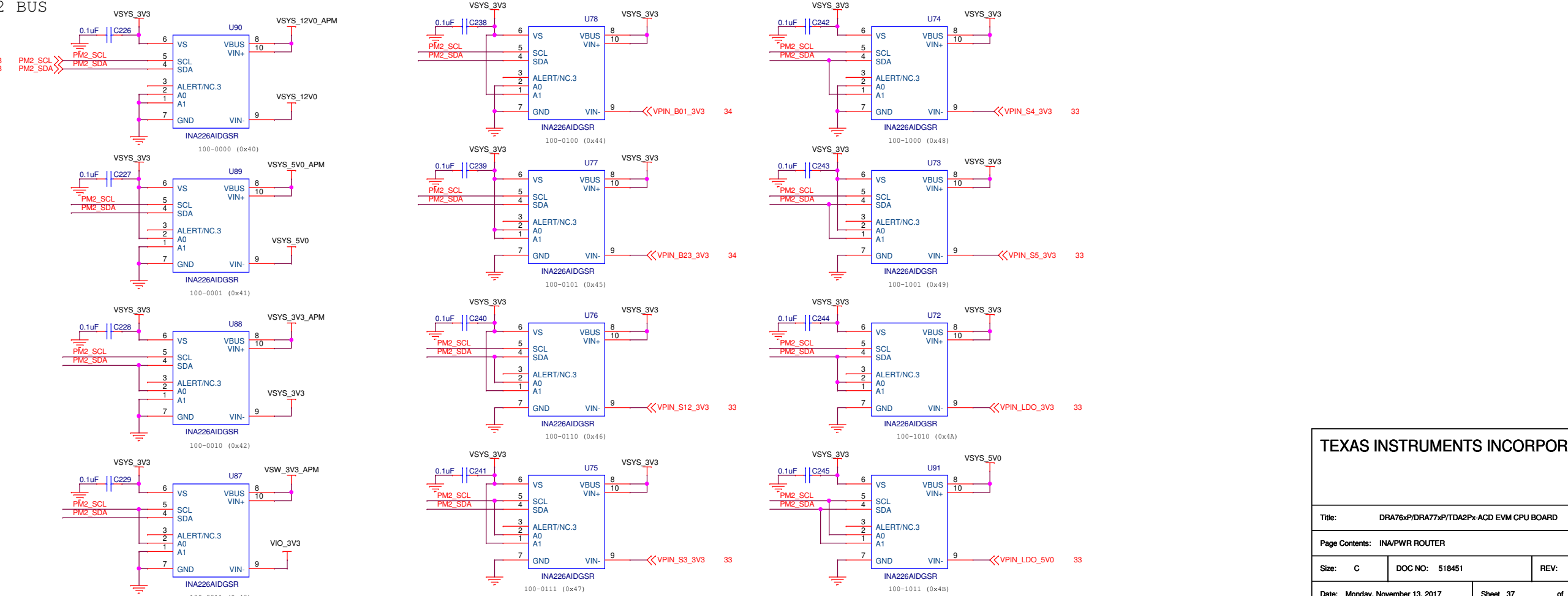
COMQ8 3.6V





PM1 BUS

PM2 BUS



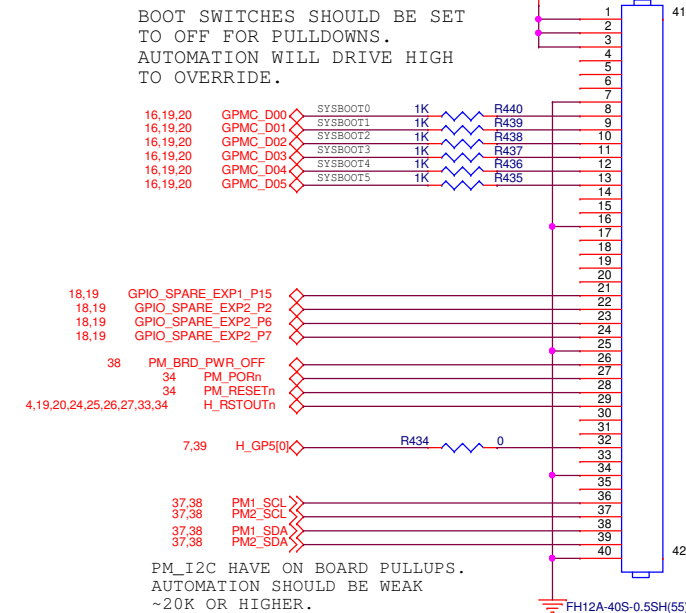
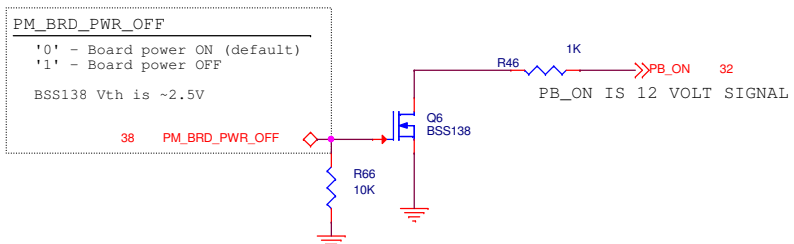
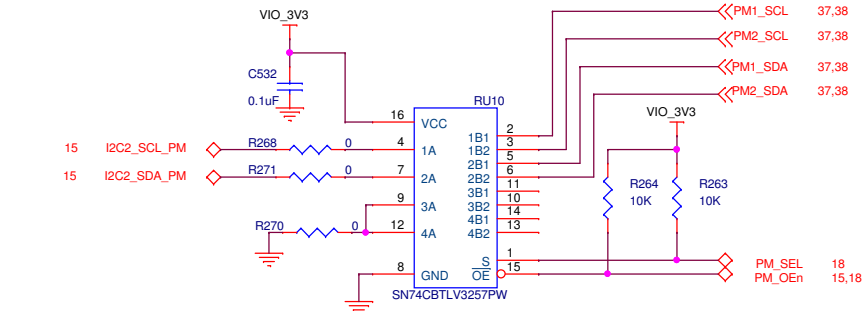
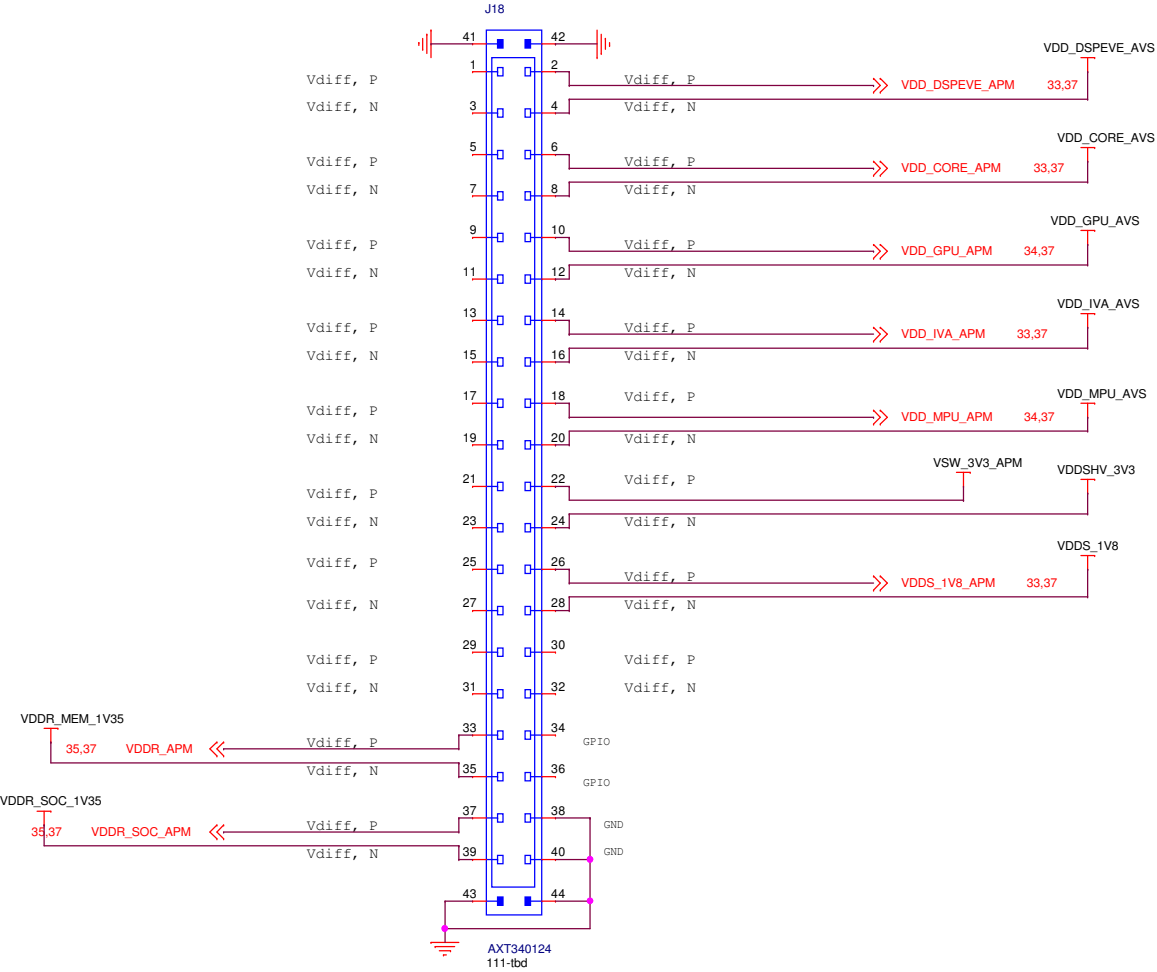
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: INA/PWR ROUTER		
Size: C	DOC NO: 518451	REV: B
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DARA Bd Interface Connector

DARA Bd can be interfaced to conduct more in-depth power measurements.

All Vdiff signal pairs (P & N) shown should be routed as pseudo-Diff Pair segments using min trace widths since these are low voltage sensing nets, not power delivery nets.

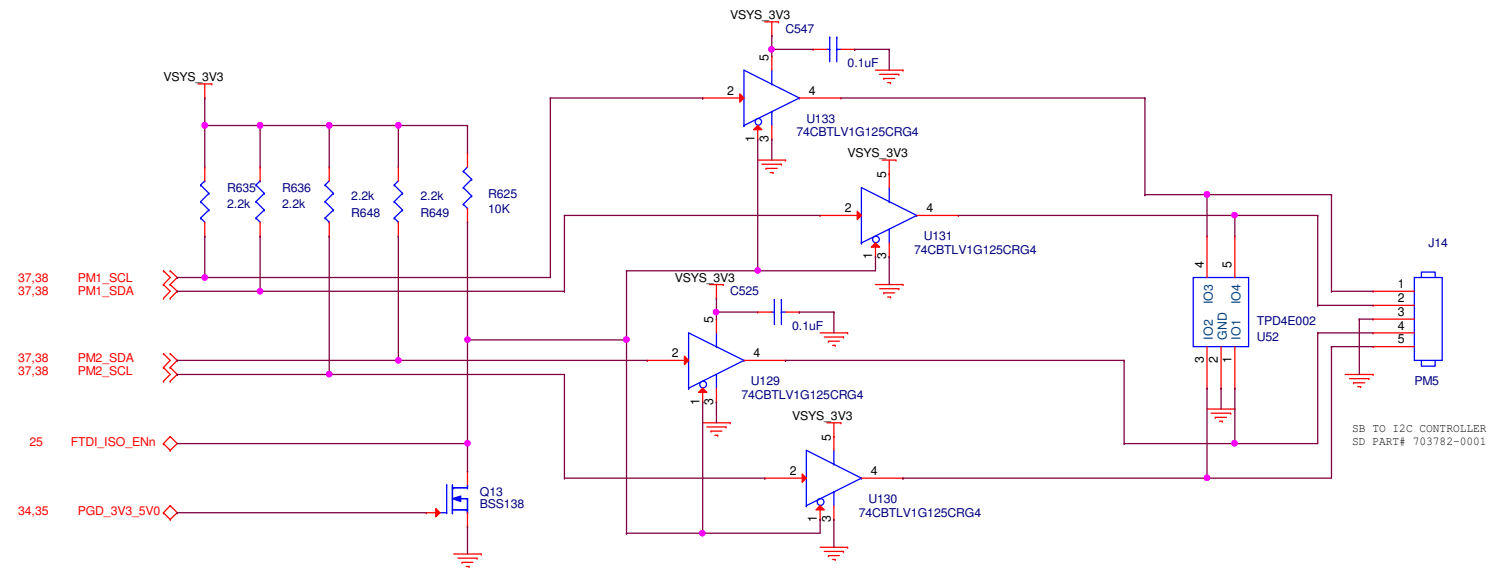


AUTOMATION INTERFACE

ALL SIGNALS SHOULD BE REFERENCED TO EVM_3V3

Cable : Parlex-050R40-76B, .5mm 3"

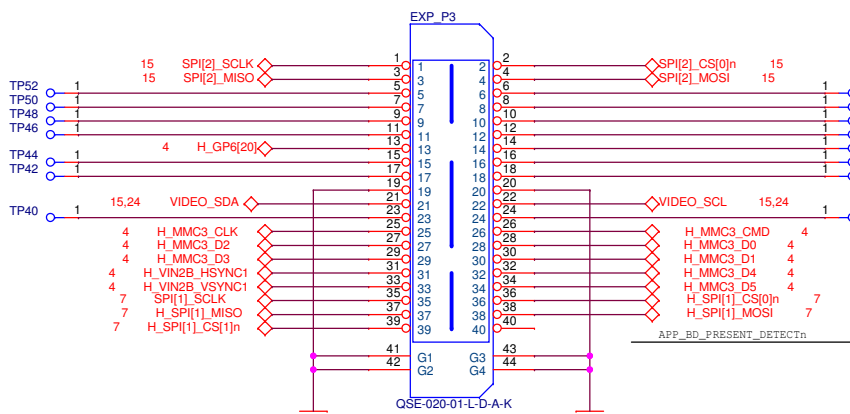
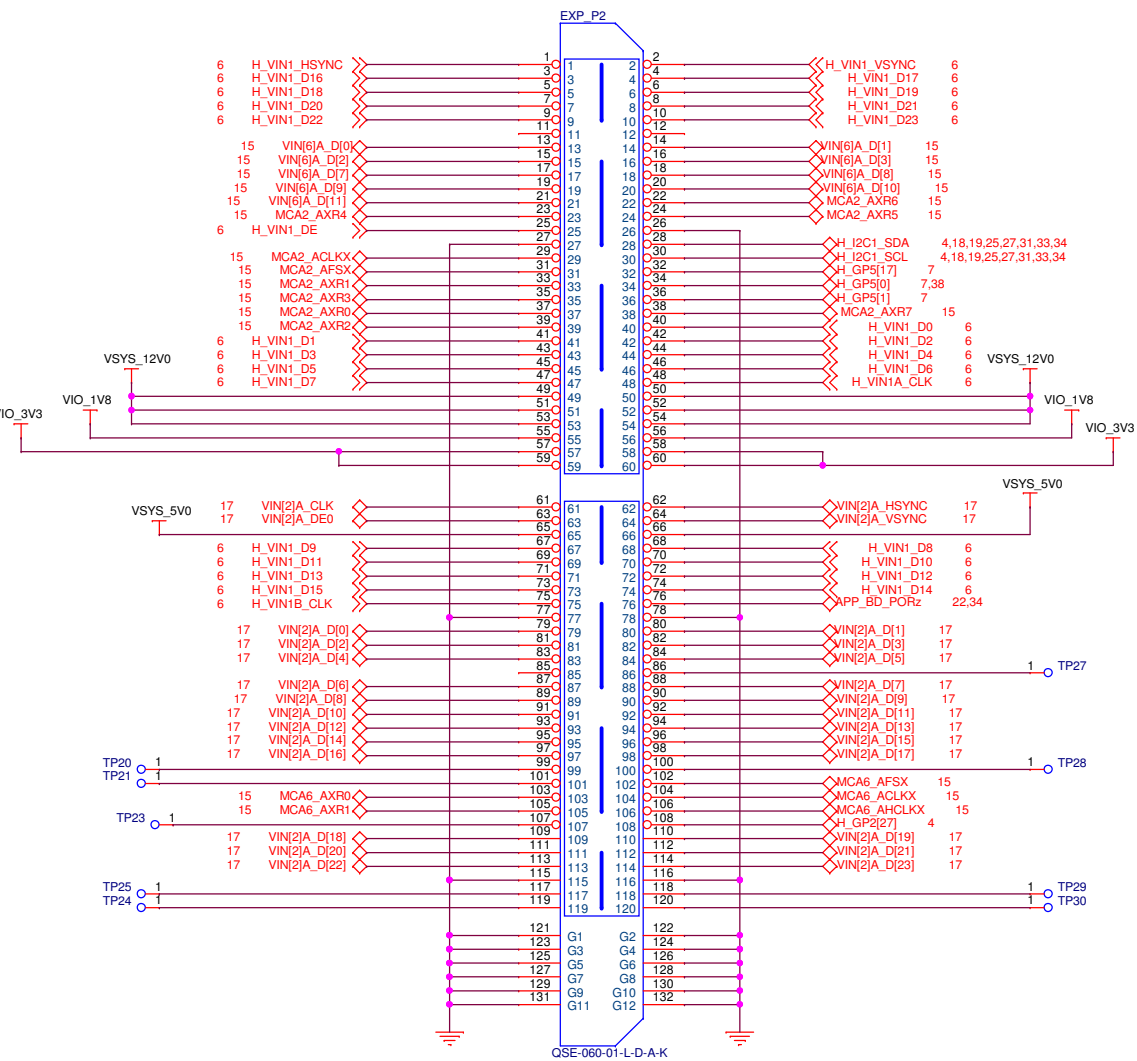
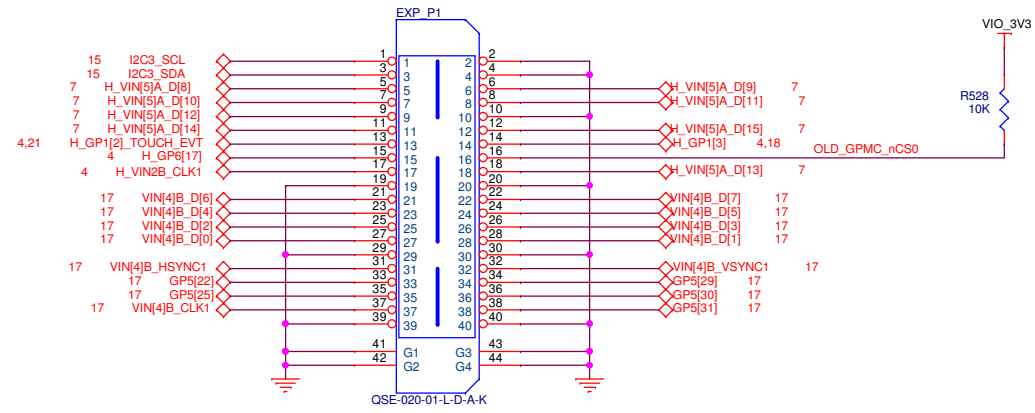
EXTERNAL POWER MEASUREMENT WITH ISOLATION



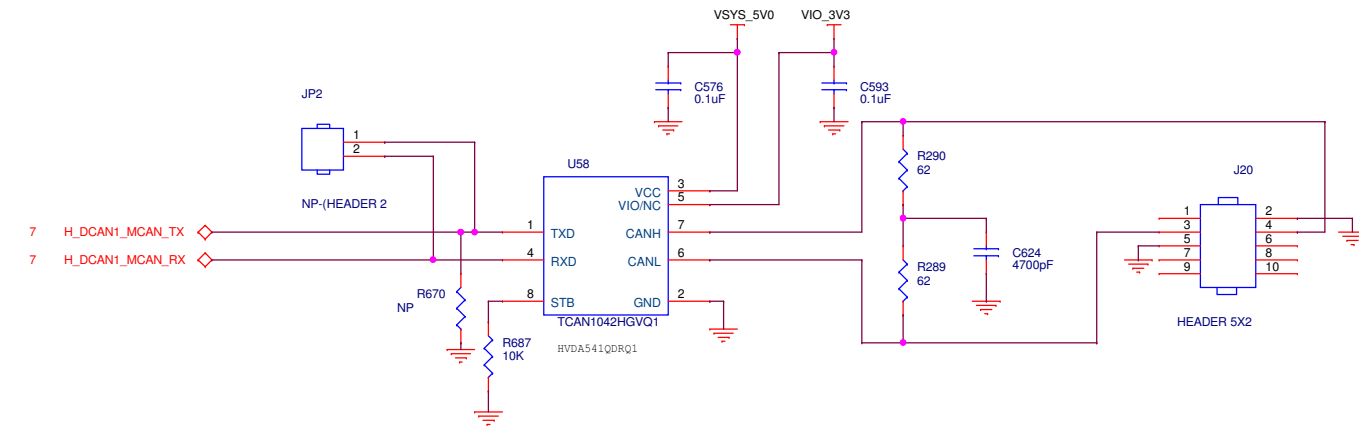
TEXAS INSTRUMENTS INCORPORATED

Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD		
Page Contents: DARA/TEST		
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EXPANSION CARD CONNECTORS

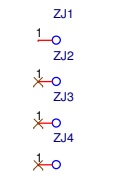
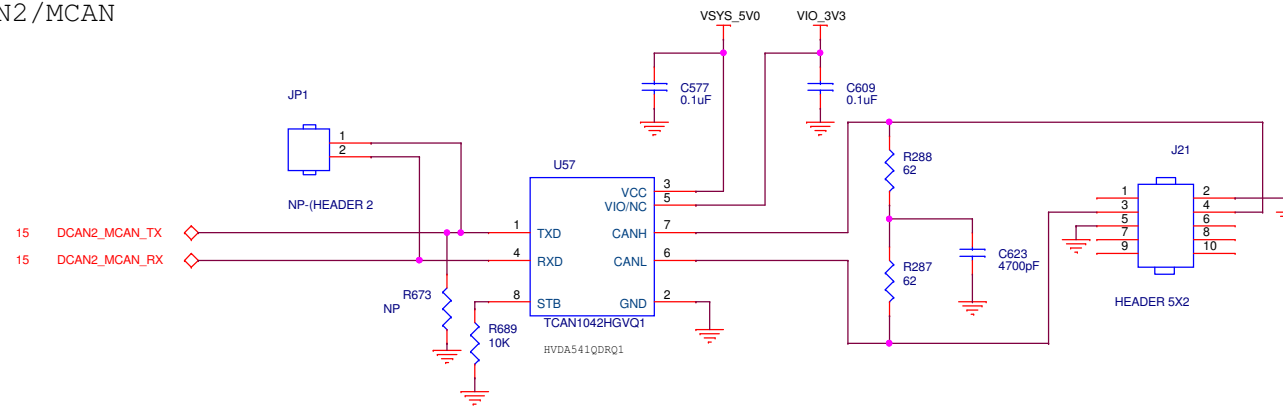


DCAN1/MCAN



DELTA VAYU H, ADD DCAN2/MCAN, DELETE VDDSHV5 WAKEUP SUPPORT.

DCAN2/MCAN



JAMR2 BOARD MOUNTING HOLES

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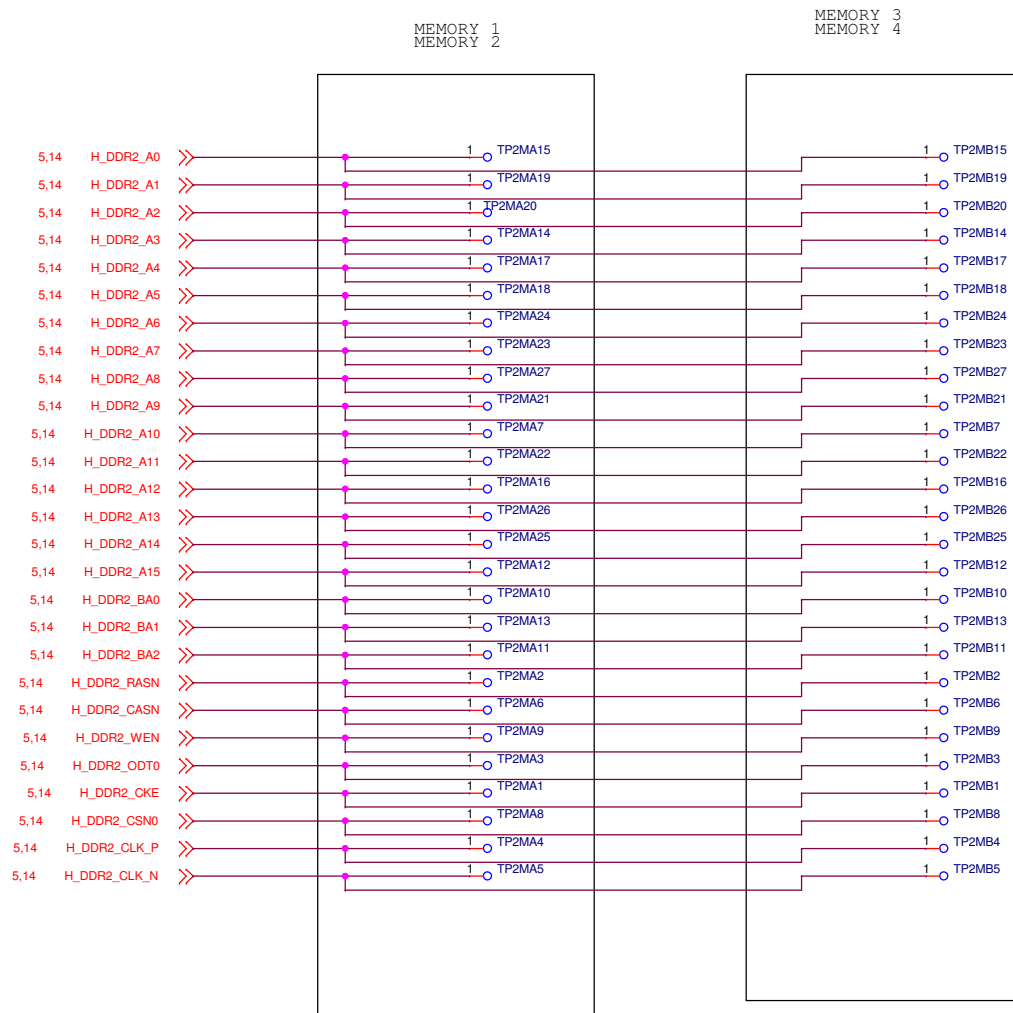
Title: DRA76xP/DRA77xP/TDA2Px-ACD EVM CPU BOARD

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This section is an outline of vias labeled as Testpoints in the schematic. This allows us to determine pcb line lengths for memory to memory and CPU to memory it is purely a visibility tool no actual "component" is used the vias are just replaced with a via that is labeled a test point

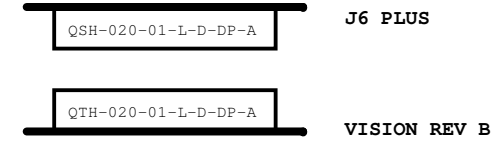


ADAS FUSION MOUNTING AND CABLING

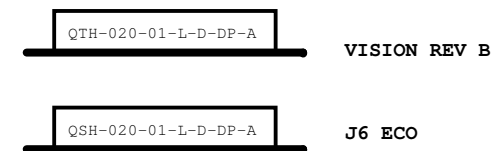
OPTION 1:



OPTION 2:



OPTION 3:



SAMTEC CABLE: HQDP-020-04.00-SBL-TBR-1

NOTE THAT CABLE LENGHT GREATER THE 4 INCHES IS REQUIRED FOR J6 ECO.

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